

Head On

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Table of Contents

1.0 Executive Summary	1
2.0 Project Description	1
2.1 Motivation	1
2.2 Goals and Objectives	2
2.3 Requirements and Specifications	3
3.0 Research	6
3.1 Similar Projects and Products	6
3.1.1 Skully AR-1	7
3.1.2 Helmet Tracking System	7
3.1.3 NUVIZ	7
3.1.4 LiveMap	8
3.1.5 Reevu	8
3.1.6 BikeHUD	8
3.2 Sensor Research	9
3.2.1 HC-SR04 Ultrasonic Sensor	10
3.2.2 LV-MaxSonar-EZ MB10x0 Ultrasonic Sensors	12
3.2.3 Sensor Selection	16
3.3 Screen Research	16
3.3.1 SparkFun Serial Enabled LCD Kit	16
3.3.2 Adafruit 1.8" Color TFT LCD display	17
3.3.3 Beaglebone Black Cape 4.3" LCD	18
3.3.4 Adafruit 2.2" 18-bit color TFT LCD display	19
3.3.5 Screen Selection	20
3.4 Microcontroller Research	21
3.4.1 Texas Instrument's MSP430	23
3.4.1.1 MSP430 Launchpad	23
3.4.1.2 MSP430FG4618	24
3.4.2 Atmel AVR Processors	24
3.4.2.1 ATmega328	25
3.4.2.2 ATmega1280	26
3.4.3 ARM Processors	27
3.4.3.1 ARM STM32F405VG	28
3.4.4 Microcontroller Selection	29
3.5 Communication Technology Research	29
3.5.1 Wireless Communication Protocols	30
3.5.1.1 Bluetooth	30
3.5.1.2 Wi-Fi	33
3.5.1.3 ZigBee	34
3.5.1.4 Wireless Communication Protocol Selection	35
3.5.2 Wireless Communication Modules	36
3.5.2.1 RN42	37
3.5.2.2 HC-05	37
3.5.2.3 SaBLE-X	39

3.5.2.4 Wireless Communication Module Selection	40
3.6 Battery Research	41
3.6.1 Lithium Ion Batteries	42
3.6.2 Lithium Polymer Batteries	42
3.6.3 Battery Selection	42
3.7 Energy Harvesting System	43
3.7.1 SparkFun Sunny Buddy - MPPT Solar Panel	44
3.7.2 Texas Instruments bq25570 Nano Power Converter	46
3.7.3 Texas Instruments BQ25505 Ultra-Low Power Boost Converter & TPS62737 Buck Converter	47
3.7.4 Energy Harvesting System Selection	49
3.8 Solar Panel Research	49
3.8.1 R7 7 Watt Rollable Solar Panel	50
3.8.2 MPT6-75	51
3.8.3 MPT4.8-150	52
3.8.4 MPT4.8-75	53
3.8.5 Solar Panel Selection	55
3.9 Step-Down (Buck) Converter	55
3.10 Real Time Clock (RTC)	56
3.10.1 DS3231 RTC	56
3.10.2 DP8573A RTC	56
3.10.3 BQ32000 RTC	57
3.10.4 Real Time Clock Selection	57
3.11 Electronic compass	58
3.11.1 FXOS8700CQ 6-Axis Sensor	58
3.11.2 MC6450 6-Axis eCompass	59
3.11.3 LSM303D eCompass Module	59
3.11.4 Electronic Compass Selection	59
3.12 Global Positioning System (GPS)	60
3.12.1 PA6C LadyBird-3 GPS Module	60
3.12.2 LS20032 GPS Smart Antenna Module	61
3.12.3 GP-735 Smart Antenna Module	61
3.12.4 GPS Module Selection	61
4.0 Block Diagrams	62
4.1 Helmet Module Hardware	62
4.2 Motorcycle Module Hardware	63
4.3 Helmet Module Software	63
4.4 Motorcycle Module Software	64
5.0 Related Standards	65
5.1 Department of Transportation Helmet Safety Standards	65
5.2 Snell Memorial Foundation Helmet Safety Standards	66
5.3 AASHTO Standard Road Widths	67
6.0 Design Constraints	67
6.1 Economic Constraints	67
6.2 Time Constraints	67
6.3 Health and Safety Constraints	68

6.4	Manufacturability Constraints	68
6.5	Sustainability Constraints	68
6.6	Environmental Constraints	69
6.7	Social Constraints	69
6.8	Political Constraints	69
6.9	Ethical Constraints	69
6.10	Legality Constraints	69
7.0	Project Designs	69
7.1	Hardware Design	70
7.1.1	Helmet Module	70
7.1.1.1	Power System	70
7.1.1.2	Control System	72
7.1.1.3	LCD Screen	73
7.1.1.4	Electronic Compass	73
7.1.1.5	Bluetooth Transceiver	74
7.1.2	Bike Module	74
7.1.2.1	Power System	75
7.1.2.2	Control System	75
7.1.2.3	Global Positioning System	76
7.1.2.4	Bluetooth Transceiver	77
7.1.2.5	Sensor Array	77
7.1.3	Module Housings	78
7.1.3.1	Helmet Module Housings	78
7.1.3.2	Bike Module Housing	79
7.2	Software Design	79
7.2.1	Helmet System	80
7.2.1.1	UML Diagrams/Flowcharts	80
7.2.1.2	GUI Design	84
7.2.1.3	Sensor Analysis and Processing	86
7.2.1.4	Libraries	86
7.2.1.4.1	Display Libraries	87
7.2.1.4.2	Real Time Clock Libraries	87
7.2.1.4.3	Communication Libraries	88
7.2.1.4.4	Compass Libraries	88
7.2.2	Bike System	88
7.2.2.1	UML Diagrams/Flowcharts	88
7.2.2.2	Algorithms	91
7.2.2.3	Sensor Analysis and Processing	91
7.2.2.4	Libraries	91
7.2.2.4.1	GPS Libraries	92
7.2.3	Overall System	92
7.2.3.1	UML Diagrams/Flowcharts	92
8.0	Prototype Construction and Coding	93
8.1	Master Parts List	94
8.2	Facilities and Equipment	94
8.3	PCB Vendor and Assembly	95

8.4 Final Coding Plan	96
9.0 Project Operation	96
9.1 On Mode and Off Mode	96
9.2 Charging	97
9.3 User Interface	97
9.3.1 Speed Indicators	99
9.3.2 Cardinal Direction Indicator	99
9.3.3 Time Indicator	100
9.3.4 Proximity Sensor Indicator	100
9.4 Adjusting Brightness	100
9.5 Setting the Time	100
10.0 Prototype Testing	101
10.1 Testing Environment	101
10.1.1 Software Testing Environment	101
10.1.2 Hardware Testing Environment	101
10.2 Testing Procedure	102
10.2.1 Unit Testing	103
10.2.1.1 Wireless Communication Testing	103
10.2.1.2 Screen/GUI Testing	104
10.2.1.3 Solar Panel Testing	105
10.2.1.4 Speed Testing	106
10.2.1.5 Clock Testing	106
10.2.1.6 Sensor Testing	107
10.2.1.7 Cardinal Direction Testing	108
11.0 Administrative Content	108
11.1 Milestone Discussion	108
11.2 Sponsors	111
11.3 Budget and Financing	111
11.3.1 Estimated Budget	111
11.3.2 Financing	113
11.3.3 Bill of Materials	114
11.3.4 Financing Issues	117
11.4 Team Organization	117
12.0 Conclusion	118
13.0 Appendices	120
13.1 Appendix A: Permissions to Use	120
13.2 Appendix B: Bibliography	136
13.3 Appendix C: Figure References	137

List of Figures

Figure 1: HC-SR04 Ultrasonic Sensor	10
Figure 2: HC-SR04 Timing Diagram	11
Figure 3: LV-MaxSonar-EZ Series	13
Figure 4: Timing Diagram	14
Figure 5: Detection Pattern	15
Figure 6: Segment Display Layout	17
Figure 7: 1.8" Display Proposed Layout	18
Figure 8: Beaglebone Black Cape Proposed Layout	19
Figure 9: 2.2" Display Proposed Layout	20
Figure 10: MSP430 LaunchPad Pins	24
Figure 11: Pin mapping for ATmega168/328	26
Figure 12: Pin mapping for ATmega640/1280/2560	27
Figure 13: Pin mapping for ARM STM32F405VG	28
Figure 14: Depiction of the master/slave Bluetooth model	31
Figure 15: SaBLE-x module from LSR	39
Figure 16: General Energy Harvesting System	44
Figure 17: LT3652 Typical Design	45
Figure 18: LT3652 Pin Configuration	46
Figure 19: RGR Package 20 Pins Top View	46
Figure 20: Typical Design for Solar Applications	47
Figure 21: Typical Design for Solar Applications	48
Figure 22: RGR Package 20 Pins Top View	49
Figure 23: MPT6-75	52
Figure 24: MPT4.8-150	52
Figure 25: MPT4.8-75	54
Figure 26: DS3231 RTC Internal Schematic	58
Figure 27: Block Diagram of Helmet Module Hardware	62
Figure 28: Block Diagram of Motorcycle Module Hardware	63
Figure 29: Block Diagram of Helmet Module Software	64
Figure 30: Block Diagram of Motorcycle Module Software	65
Figure 31: Motorcycle Helmet Layout	66
Figure 32: Helmet Module Power Supply Schematic	71
Figure 33: Solar Panel Placement Top View	71
Figure 34: Solar Panel Placement Side View	72
Figure 35: Helmet Module Control System Schematic	73
Figure 36: Helmet Module Bluetooth and Compass Schematic	74
Figure 37: Bike Module Power Supply Schematic	75
Figure 38: Helmet Module Control System Schematic	76
Figure 39: Bike Module Bluetooth and GPS System Schematic	77
Figure 40: Sensor Placement Representation	78
Figure 41: Agile Methodology	80
Figure 42: Sensor Analysis Phase	81

Figure 43: Speed Program	82
Figure 44: Update GPS Indicator	83
Figure 45: Update Time Indicator	84
Figure 46: GUI Design	84
Figure 47: Sensor Program	89
Figure 48: Sensor Sequence Diagram	90
Figure 49: GPS Sequence Diagram	91
Figure 50: Head On System Sequence Diagram	93
Figure 51: Welcome Screen	97
Figure 52: User Interface Layout	98
Figure 53: Wireless Communication Testing Layout	103
Figure 54: Budget Percentages	113
Figure 55: Final Budget Percentages	118

List of Tables

Table 1: Module Requirements and Specifications	4
Table 2: Power Requirements and Specifications	6
Table 3: HC-SR04 Specs	11
Table 4: MB10x0 Specs	13
Table 5: Bluetooth Power Consumption and Operating Ranges	31
Table 6: Comparison of Wireless Data Transmission Protocols	36
Table 7: Battery Specifications	43
Table 8: R7 Rollable Solar Panel Specs	51
Table 9: MPT6-75 Specs	51
Table 10: MPT 4.8-150 Specs	53
Table 11: MPT 4.8-75 Specs	54
Table 12: Master Parts List	94
Table 13: Cardinal Direction Values	99
Table 14: Senior Design I Milestones	109
Table 15: Senior Design II Milestones	110
Table 16: Budget	112
Table 17: Bill of Materials	114

List of Equations

Equation 1: Compass Heading	82
Equation 2: Sensor Data to Centimeters	91
Equation 3: Sensor Data to Inches	91

1.0 Executive Summary

It is an undeniable fact electrical and computer engineers have made the greatest contribution to the current technology sector. Their impact has been revolutionary and has paved the way for products that have transformed the quality of life for many. As the members of this team near the beginning of their electrical and computer engineering careers, this group wanted to create a senior design project that focuses on taking existing technology and improving its current use for the users.

In particular, we are focusing our design on the motorcycle community. The main objective for this project is to increase the riding experience of a rider by increasing his or her situational awareness and, consequently, safety. The design of this system consists of two parts. The first part incorporates a typical full face motorcycle helmet, which is then modified to contain a display. This screen will display relevant information to the user about his or her surroundings, motorcycle, and other general information. The second unit of Head On will be fitted on the motorcycle itself. This unit will contain several modules that will be used to take in data; once all of the data is gathered, it will then be transmitted to the helmet system so that it can be analyzed and displayed to the user. The combination of these two units will provide the rider with features that increase his or her enjoyment, safety, and secureness in the motorcycle.

This document describes design decisions made and the factors that lead to these decisions. First the goals, requirements, and specifications for this project will be explained. Next, a detailed description of each component of this project will be discussed. Afterwards the standards and constraints that impact the design of Head On will be analyzed and followed by an explanation of the design of the system as well as how the hardware and software of the prototype will interact. Finally, the testing procedure of the prototype will be discussed.

2.0 Project Description

One of the first steps taken when creating Head On was defining what the project would be. First a motivation for the project was determined. This helped to define what the problem was that the group wanted to solve. Based off of this motivation, goals and objectives were created. The purpose of these goals and objectives was to create a more specific list of features for the project that would help solve the problem. Finally, requirements and specifications were determined based off of these objectives. Doing this allowed the group to have concrete values to build the project off of.

2.1 Motivation

In recent years, vehicles have incorporated sophisticated electronic systems in order to improve the safety, comfort, and overall enjoyment of the ride. Notable

features seen in newer vehicles include built in navigation, projected speed, directions displayed on the windshield, omnidirectional cameras for a 360 view of the vehicle, and proximity sensors to detect nearby obstacles. However, there is a noticeable absence of this kind of technology for motorcycles. While there are a few products currently on the market that aim to fill this void, they are often expensive and many do not focus on increasing the rider's awareness of his or her surroundings. Consequently, this group decided to create the Head On system as a means to fill this void. Ideally, using this motorcycle and helmet system will to give riders easy access to data such as the proximity of potentially hazardous objects in his or her blind spots, details of the bike (e.g. cardinal direction, speed), and general details (e.g. time). Therefore, when moving forward with the design process, the primary focus will be on both the rider's experience and safety.

2.2 Goals and Objectives

Once the motivations of the project were determined, the next step was to discuss the goals and objectives. At this stage in the design process, these statements are fairly vague descriptions of what the project should include. They will be modified in later stages of this project as the design of the system changes. Eventually, the final list of features for Head On will be developed from these goals and objectives.

One objective of this project is to allow easy charging. In order to do this, Head On will have dual charging methods so that the user can charge the system both at home and on the go. The first of these methods is a built in battery. This battery will be easy to remove and charge. This method will allow the system to be charged when at home. The second charging method will utilize solar power. Solar panels will be mounted onto the helmet in order to allow the system to charge while the rider is using it. By having two charging methods, the user will be able to use the system for a longer period of time.

Another integral goal for this project is to make sure the helmet enhances, rather than hinders the user's driving experience. In order to do this, several factors need to be considered in the design. First, the system itself should be small so that it can fit easily on the back of the helmet. This size is imperative because it must not break any safety standards for motorcycle helmets. Next, the size and location of the screen must be chosen specifically so that they are not obstructive to the user. The user's field of view must not be seriously impacted because this would make the system counterproductive. Furthermore, the GUI that is displayed on the screen must be designed so that it is easy to read and simple to understand. The screen should not be too cluttered, and the symbols should be easy to understand. Finally, the sensors on the bike must also be placed in locations that will not be obtrusive.

Finally, the most important goal of this project is to increase the rider's safety. This will be done in two ways. The first is the system will strengthen the rider's awareness of his or her surroundings. Sensors are used to detect objects in the rider's blind spot. When an object is detected, a notification will appear on the screen indicating if the hazard is in the left, right, or rear of the rider. The second part of this goal is that the Head On system will make the rider safer by eliminating the need for the rider to look down at his or dashboard. In addition, to the notifications when there are hazards nearby, other useful information will also be displayed on the screen such as time, cardinal direction, and speed.

2.3 Requirements and Specifications

Once the goals of the project were defined, the requirements and specifications also had to be determined. These requirements and specifications add numerical values to the goals and objectives created in the previous step of the design process. Similar to the goals and objective, these values will be changed throughout the design process based on research, test results, and design modifications. In order for this project to be considered a success, these values, summarized in Table 1, must be met by the prototype. These requirements and specifications impact the hardware, software, and overall performance of the system. These requirements and specifications have been split into two categories: module specifications and power specifications.

First it is important to focus on the requirements of the modules in the system. This system should include three sensors in order to detect objects to the left, right, and rear of the user. These three values are the main blind spots of the user. The detection distance was chosen in order to ensure that the sensors can adequately reach into adjacent lanes to detect objects. This decision was based off of standard road widths in the United States. For the display, the main concerns are the size and the quality of the screen. A size of 2.2" was chosen because after some sample sketches for the layout, it was determined that all of the indicators can fit without cluttering the screen. The next component of the system that was analyzed was the microcontroller. The primary specification for this is the number of pins available. After considering the modules necessary for the system, it was determined that 20 pins would be sufficient. This amount would also leave some pins for future improvements to the design without being considered excessive. Next the wireless communication must be considered. The helmet and motorcycle units should be able to communicate with each other when the rider is near his motorcycle. Ten meters should be enough for this. It will allow the user to turn on the helmet system and have the modules connect to each other as he or she approaches the system. Next, the real time clock module should be very accurate in order to ensure that the time displayed for the user is correct. A strict accuracy of +/- 2 minutes has been chosen. Similarly, the electronic compass should be precise. Finally, the GPS should be able to start fairly quickly in order to ensure that the system can start using it immediately.

Table 1: Module Requirements and Specifications

Attribute	Value
Number of sensors	3
Sensor detection distance	2-400cm (1in - 13 ft)
Sensor measuring angle	30 degrees
Sensor frequency	40kHz
Sensor Resolution	0.3 cm
Display size	2.2"
Display resolution	320 x 240 resolution, 18 bit color
Microcontroller pin count	20 (14 digital + 6 analog)
Microcontroller current consumption	0.1uA-0.2mA
Wireless communication module frequency	2.4 GHz
Wireless communication module operating range	10 meters
Wireless communication module data throughput	0.7-2.1 Mbps
Real time clock accuracy	+/- 2 minutes/year
Electronic compass magnetic field range	+/-12 gauss
Electronic compass magnetic sensitivity	0.08 mgauss
Electronic compass acceleration range	+/-16 g
Electronic compass acceleration sensitivity	0.061 mg
GPS Time to first acquisition (cold start)	35 seconds
GPS Time to first acquisition (hot start)	1 second
GPS position accuracy	2.5 m
GPS velocity accuracy	0.05 m/s

Next, the power requirements for this system must be considered. This motorcycle unit will be powered by the battery on the motorcycle, so sufficient power will always be available. Consequently, the power consumption of the GPS module, Bluetooth module, and the three proximity sensors are not as much of a concern because they will all be placed on the motorcycle unit. Therefore, the power specifications in Table 2 below focus only on the power needs of the

helmet system. Some factors taken into consideration include the power needs of the modules as well as the power available from the battery and solar panels. The necessary battery voltage and capacity were decided after many calculations on what the power requirements for all of the modules will be. These values impact the battery and solar panel specifications. It must be noted that for the solar power charging, the values given in Table 2 are assuming ideal conditions in which sufficient sun is available.

Another factor taken into consideration when determining the power specifications is the battery life and time to charge the battery. The time to charge the battery varies depending on the method of charging. Specifically, charging the battery with the DCV charger should be much faster than the solar panel method. For this project it was determined that the battery life needs to be sufficient so that the rider can use the system for hours without having to worry about charging it. Consequently, a ten hour battery life was chosen so that the user will have more than enough power to use the system. Additionally, this battery life will also allow the rider to go on several shorter rides without having to charge the system in between. If sufficient sun is available for the solar panels, the system will be able to charge even while in use. Therefore, the battery life of the system will be even greater.

Additional factors that must be considered include the dimensions and measurements of the components. For example, because of the limited space for the solar panels and their location on the helmet, the size and weight must be limited. The dimensions of the panels must allow them to fit securely to the helmet in order to meet certain helmet standards. After testing various sizes on the helmet it was determined that 73mm x 94mm would be small enough to mold closely to the helmet. Based on the number of solar panels necessary, this size is also sufficient to allow all of the solar panels to fit on the top of the helmet, where they will be exposed to the most sun. The weight should not be noticeable since they will be placed on top of the user's helmet. Therefore, it was determined that the weight of the solar panels should be 1.9g.

Table 2: Power Requirements and Specifications

Attribute	Value
Solar panel power	0.225 W
Solar panel output	55mA at 4.8V
Solar panel dimensions	73mm x 94mm
Solar panel weight	1.9 g
Battery capacity	2000 mAh
Battery voltage	3.7 V
Battery life	10 hours
Battery recharge time (solar)	8 hours
Battery recharge time (DCV charger)	4 hours
Sensor power consumption	75 mW
Display current consumption	100mA
Display voltage	3.3-5V
Real time clock operating voltage	3.3 V
Real time clock current consumption	110 uA (standby); 200uA (active)
Electronic compass operating voltage	2.5 V
Electronic compass current consumption	1uA (standby); 300uA (active)

3.0 Research

Before designing the software and hardware components for Head On, a great of research had to be done into every feature of it. This included doing a market analysis of similar products, researching different approaches that could be taken, and researching specific modules that could be used.

3.1 Similar Projects and Products

Research into similar products was conducted in order to determine what needs have not been met in the market. These similar products were also taken into consideration. By researching these products, it was determined what approaches would be best to avoid, as well as what approaches were more likely to result in success. This included the incorporation of certain features, the choice of components, and the manufacturing of the product.

3.1.1 Skully AR-1

Currently available for preorder is a similar product named “Skully AR--1.” At a cost of \$1499, consumers can purchase a DOT/ECE certified helmet which provides motorcyclists with many useful features for on road use. Specifically, the Skully AR-1 provides riders with a transparent heads up display projected onto the visor, rear view display, full 180 degree field of view, GPS navigation, and Bluetooth connectivity. According to their website, this heads up system will allow the rider to “gain full situational awareness”. The Head On system will have a similar premise by helping increase the situational awareness of the rider through the use of proximity sensors. However, one major difference in the design of Head On is that rather than showing the rider an image of the road behind him or her, this system will simply display a symbol on the screen indicating what direction the potential hazards are coming from.

3.1.2 Helmet Tracking System

Another similar product is a previous senior design project, named “Helmet Tracking System”. This project tracks the rider using GPS and sends out texts if he or she was in an accident. This project focuses more on reacting to accidents rather than preventing the user from having them. Because the system only takes action in the event of an accident, there is no integrated display for the rider to interact with the system. Head On will focus more on the prevention of accidents. It will include a display positioned at the front of the helmet which will allow the rider to be warned visually of the proximity of other vehicles; consequently, the rider will become more aware of his or her surroundings. In a further effort to increase the rider’s safety, the Head On system will also eliminate the need for the rider to look at his or her dashboard by displaying other useful information such as, speed, cardinal direction, and time. Hence, increasing the overall awareness of the bike and surroundings, and increasing the rider’s safety. Incorporating an accident notification system, similar to the Helmet Tracking System, was considered but due to time and budget constraints it has become a stretch goal that may be revisited in the future.

3.1.3 NUVIZ

The NUVIZ heads up display system does not use the typical built in design in. Rather, this system is designed as a removable attachment which can be mounted to the rider’s existing helmet. This system includes a variety of features including access to maps and weather forecasts. It also allows the user to make and receive phone calls more safely by displaying the relevant information on the user’s helmet. Furthermore, this device also seeks to enhance the user’s riding experience by allowing him or her to play music from his or her personal music library. Basic information such as speed, time, and distance traveled are also

displayed for the user. Finally, this system also gives the user the option to take pictures and videos while riding.

However, while this system offers many features that can enhance the riding experience, it fails to include features that will increase the rider's awareness of his or her surroundings. The Head On system plans to satisfy this need by incorporating sensors that detect potential hazards in the rider's blind spots.

3.1.4 LiveMap

LiveMap is another heads up display system that is attempting to enter the market place. The main focus of this system is hands free navigation. This system displays a map onto the visor of the helmet. While providing this assisted navigation certainly can be beneficial to the user, this system does not increase the user's situational awareness. Additionally, the current estimated price for this system is very high, which may be unappealing to many riders. Not only will Head On cost less, it will also include more features which will not only improve the user experience, but also increase his or her awareness.

3.1.5 Reevu

The next motorcycle helmet system being analyzed is the Reevu system. This system allows the rider to view what is behind him or her, essentially acting as a rear view mirror. While this can improve the awareness of the user, there are several flaws to note. First, the system is located above the visor of the helmet, so the user must temporarily take his or her eyes off the road in order to look up at it. This is inconvenient and awkward for the user. The main point of heads up displays is to allow the user to keep his eyes looking forward. Undoubtedly looking up is less dangerous than having to look back to check for other vehicles, however, the placement of the screen is still inconvenient. In addition, the system does not offer any indication of potential hazards on the left and right of the driver. These are major blind spots which are unfortunately ignored in this system. The Head On system attempts to address the aspects left out in this design. First, the screen will be located outside of the helmet in a location that is convenient and easy to see. In addition, it will use three sensors to detect hazards to the left, right, and rear of the user, thus creating a more complete situational awareness and addressing the problem of blind spots. Finally, rather than displaying images of these blind spots, Head On will have simple indicators that are displayed when a hazard is detected. This will minimize distractions.

3.1.6 BikeHUD

Finally, the last product that was researched was BikeHUD. According to their website, this device attaches inside of the helmet. It displays information such as speed and navigation. To manually switch between views of displayed information, the system uses a series of buttons that attaches to the handlebar of

the bike. However, BikeHUD, like many of the other heads up display systems discussed previously, fails to notify the user of potential hazards. In addition, because the display is located inside of the helmet, it may be difficult to read what is displayed on the screen. Once again, the Head On system will not only address the issue of notifying the user of potential hazards, the display will also be placed in a more convenient location outside of the helmet.

3.2 Sensor Research

On the road, obstacles can present themselves at any given time without warning. During the basic rider's course, motorcyclists are taught to pay attention and analyze their current surroundings for pedestrians, pets, debris, and even cars entering their lane unexpectedly. Being able to predict movement of such object can be a lifesaving skill; however, detection of these obstacles mainly applies to front facing objects, thus leaving the rider vulnerable by the limited helmet view. In order to increase the rider's situational awareness and cover his or her blind spots, the Head On system needed to be equipped with a detection system. Primarily, the detection system would need to cover the areas a rider cannot immediately access without turning his or her head: the rear, back-left, and back-right.

Proximity sensors by definition are able to detect objects without any physical contact. These sensors feature variations in terms of maximum detection distance or 'nominal range' and the method used to detect a specific target. Furthermore, appropriate selection of sensor types are needed as different target materials demand different sensors. According to the American Association of State Highway and Transportation Officials, lanes must be a minimum of twelve feet wide. Consequently, when determining the requirements and specifications for this project, it was determined that the sensor should reach at least 13 feet. Assuming an ideal case in which the user is in the exact center of his or her lane, this detection distance would reach far enough into the adjacent lane that it could detect the presence of another vehicle

Several different methods of proximity detection are currently being used by the automotive industry. This includes infrared, radar, and ultrasonic detection. Infrared detection systems are only effective to the low end of the specified detection distance requirement and intense ambient lighting can further reduce the effective range. In addition, false indications can also be triggered by external light sources such as vehicle headlights. On the other hand, radar detection systems have too long of a detection distance. While they would work well for forward or rear facing detection, objects off the side of the roadway could generate false side proximity warnings. In addition, the close proximity of the sensors to one another could result mutual interference between them. Fortunately, the ultrasonic detection systems were found to have an ideal detection range for the system's side proximity detection, as well as an adequate range for the rear proximity detection. The frequency and pulse modulation

scheme ultrasonic sensors is used minimize the possibility of external interference, while the highly directional nature of the sensors prevents mutual interference of properly positioned sensors. Unfortunately, none of the sensors that are designed for use in unprotected environments were available within the budget constraints of this project. Therefore, it was decided that ultrasonic sensors would be the best choice for this project. The two models of ultrasonic sensors that met the preliminary size and cost criteria were researched in-depth in order to determine which would be the most appropriate for the Head On system.

3.2.1 HC-SR04 Ultrasonic Sensor

The HC-SR04 is a very popular ultrasonic sensor that is commonly used for robotic distance sensing. HC-SR04 is a generic part number made by multiple manufacturers. The design, as shown in Figure 1, is consistent regardless of what manufacturer it is made by, but there is a variety of documentation available from third party vendors. Due to the variety of vendors, the cost of this sensor varies. However, all of these prices are fairly low and usually are around \$2.50 per sensor. Taking into consideration the budget constraint of this project and the fact that three sensors are necessary for the system, this price is fairly reasonable and falls in line with the budget.

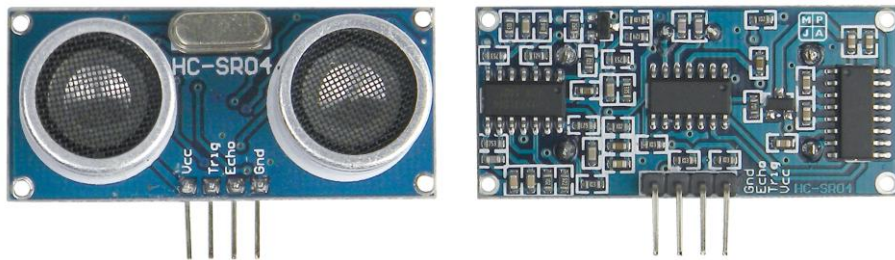


Figure 1: HC-SR04 Ultrasonic Sensor

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Table 3 below summarizes the specifications of the HC-SR04 ultrasonic sensor. It has a small footprint and low power consumption of only 75mW. It has a 13 foot detection range and a 30 degree measuring angle which fits the project specifications perfectly. Although this range is not as great as some of the other ultrasonic sensors available on the market, it is sufficient enough to sense objects that are in adjacent lanes. Additionally, the dimensions of the sensor are fairly small which will make finding somewhere on the motorcycle to place them much easier.

Table 3: HC-SR04 Specs

Operating Voltage	+5 V
Power	75 mW
Current	15 mA
Frequency	40 kHz
Max Scan Rate	20 Hz (estimated)
Detection Distance	2 – 400 cm (1 in – 13 ft)
Resolution	0.3 cm
Measuring Angle	30 degrees
Width	45 mm
Height	20 mm
Depth	15 mm

A 10 us TTL pulse triggers the sensor to transmit a series of eight 40 kHz pulses. The sensor generates a TTL high on the output pin until the rising edge of the reflected pulse train is detected. Figure 2 illustrates this process. The pulse width corresponds to the measured distance. The distance of the object can be calculated by dividing the width of the output pulse in microseconds by 58 for centimeters or by 148 for inches. The maximum time to complete a measurement appears to be approximately 38.5 ms, but due to inconsistencies in the timing diagrams, a maximum cycle rate of 50 ms would be prudent. However, even this maximum cycle time is still acceptable for this project.

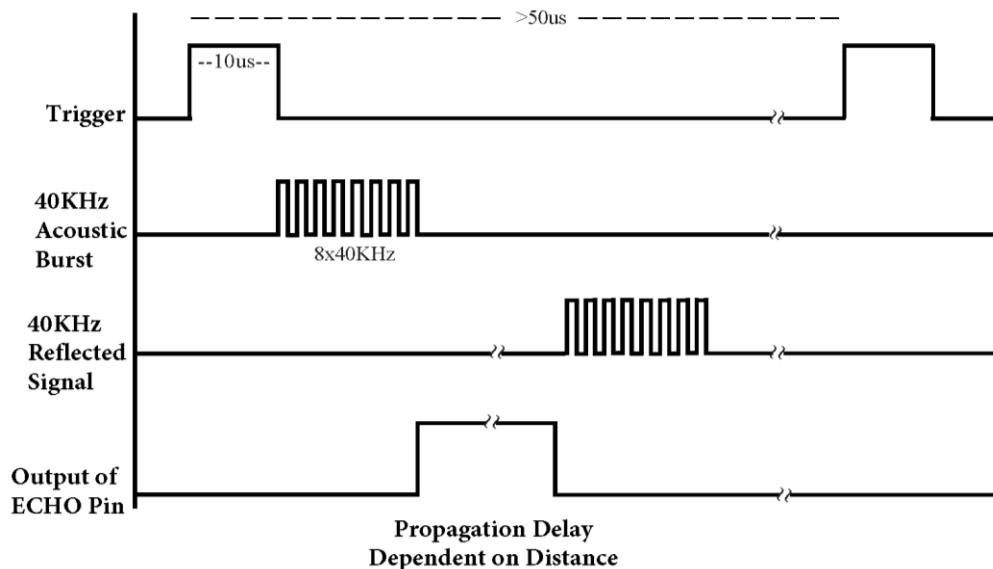


Figure 2: HC-SR04 Timing Diagram

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This sensor requires only four connections to operate. This is a fairly small number of pins and there should be more than enough available on the

microcontroller. Three of these can be shared between multiple sensors resulting in only one dedicated line per sensor required at the controller. Because there will be three sensors used as part of the motorcycle system this is significant; this will reduce the pin count, thereby leaving more pins available for future expansions of the project.

The software aspect of this project must also be considered when choosing a sensor. Some members of this group already have experience programming this type of sensor. Therefore, if this sensor is chosen, it will allow more time to be spent on programming the other modules. Additionally, due to its popularity with Arduino users, there is a large amount of open source code which can be adapted to this project. This will be beneficial for the group members who do not have experience with this sensor. Finally, because of its popularity, there are also a large number of forums on line in which common problems with these sensors are discussed. This will decrease the amount of time that is spent on troubleshooting problems with the hardware and software aspects of the sensor system.

3.2.2 LV-MaxSonar-EZ MB10x0 Ultrasonic Sensors

The LV-MaxSonar-EZ Series is versatile and available in several models, each with a slightly different beam pattern based on the size, range, and sensitivity of the detection application. It is able to function on a range of supply voltages, 2.5 to 5 V, and has a very low power consumption of 5 - 15 mW. While ordinarily the power consumption should be kept as low as possible, it is not as significant for this module because it will be placed on the motorcycle, and therefore will have ample power available.

In addition to having a triggered detection cycle, this sensor can be set to free run, which causes it to continuously provide range data without external signals. The measured range data is provided in three formats: serial, analog, and pulse width, which are all simultaneously available. The serial output is in an asynchronous RS232 format at a baud rate of 9600 bpm with eight data bits, no parity bit and 1 stop bit. The sensor transmits an ASCII "R" three-digit distance and a carriage return for each measurement cycle. The analog output provides a DC voltage level between 0 volts and VCC in 512 increments proportional to the measured distance. The sensitivity is 9.8 mV per inch for a 5 volt VCC and 6.4 mV per inch for a 3.3 volt VCC. The pulse width output produces an output pulse width proportional to the measured distance with a sensitivity of 147 us per inch. Table 4 summarizes these specifications of the MB10x0.

Table 4: MB10x0 Specs

Operating Voltage	+2.5 - 5 V
Power	5 - 15 mW
Current	2 - 3 mA
Frequency	42 kHz
Max Scan Rate	20 Hz
Detection Distance	0 - 6.45 m (0 - 21.2 ft)
Resolution	1 in
Measuring Angle	variable
Width	19.9 mm
Height	22.1 mm
Depth	15.5 mm

One important factor to note is the size of this sensor. While the HC-SR04 was a small sensor, this sensor, as depicted in Figure 3, is even smaller. As previously mentioned, choosing a sensor that is small in size will make the process of placing it much simpler. The sensors will be the bulkiest part of the motorcycle unit. Ideally, the unit should be as small as possible. The simplest way to ensure this is to utilize small sensors.



Figure 3: LV-MaxSonar-EZ Series
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The sensors can be connected, triggered, and read independently, however there are also several options for connecting multiple sensors using fewer connections and requiring less processor interaction. Reducing the number of pins is desirable for two reasons. The first is that the microcontroller only has a limited number of pins available. Insufficient amounts of pins would result in either some modules being excluded from the system or the microcontroller, and consequently the design of the entire system, to be changed. The second benefit for reducing the number of pins is that more expansions could be added to the system in the future. The entire array can be triggered at the same time providing simultaneous range data. This requires only one trigger signal connection, but an individual data connection for each sensor. While it results in faster detection rates, it also increases the potential for interference between the sensors in the array depending on their position.

In the next two configurations, each sensor triggers the next one at the end of its measurement cycle. The difference between these configurations is in the

external trigger signal. One configuration requires an external trigger signal for each cycle through the array. However, in the other configuration the trigger signal from the final sensor is fed back to the first sensor in the array resulting in continuous operation of the array until power is removed from the sensors. These configurations also only require a single trigger connection but could also be connected to a single data port as only one sensor will be transmitting at a time. This eliminates the potential for interference between the sensors, but decreases the detection speed as the array must step through each sensor's measurement cycle in turn before triggering a new series of measurements. Figure 4 shows the timing diagram for the MB10x0 series sensors.

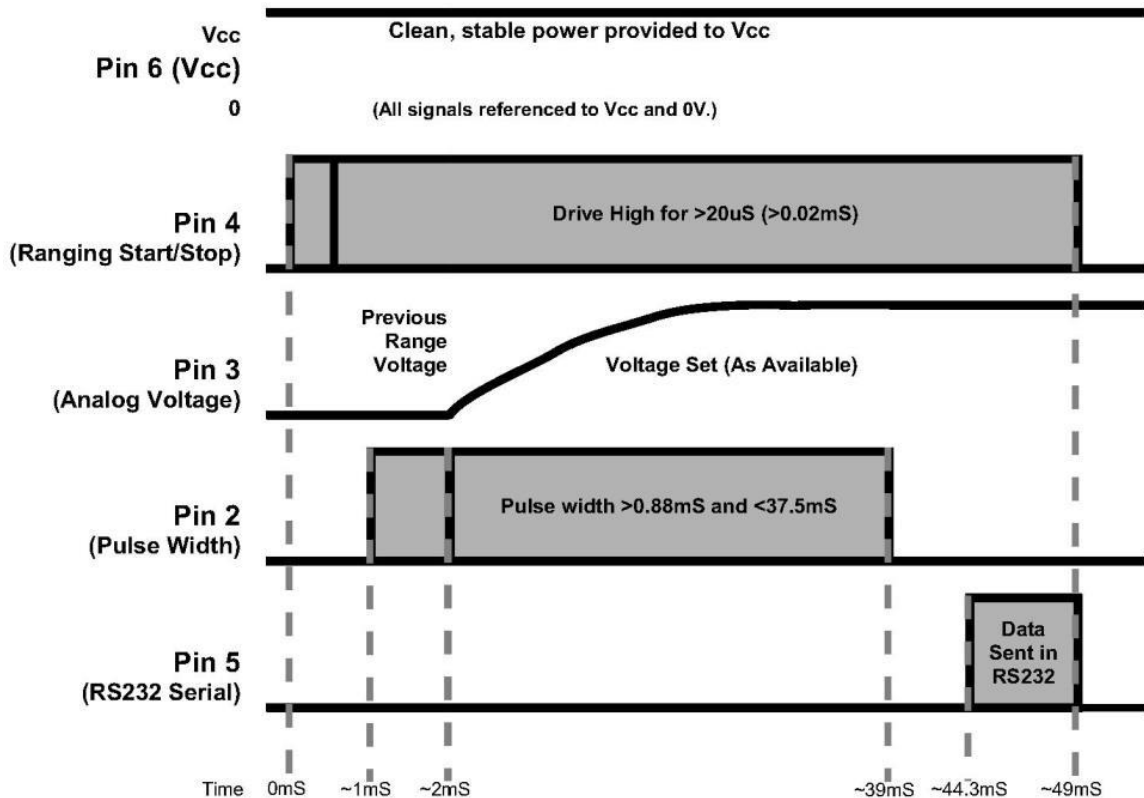


Figure 4: Timing Diagram
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The serial output is not ideal when employing multiple sensors as it would require multiple RS232 connections to the controller or additional timing and multiplexing hardware. There are several accessories available to combat electromagnetic interference and provide temperature compensation if necessary.

The various beam patterns for the MB1000 sensor running at 5.0 and 3.3V is shown below in Figure 5. The accuracy of the sensor was tested using various object sizes ranging from 0.25" to 11". One important thing to note on these results is that when the sensor is running at 5V, the width and distance of the detection range is slightly larger. Therefore, if this sensor is chosen, this is most likely the operating voltage that the sensor would be set to. The selection of the

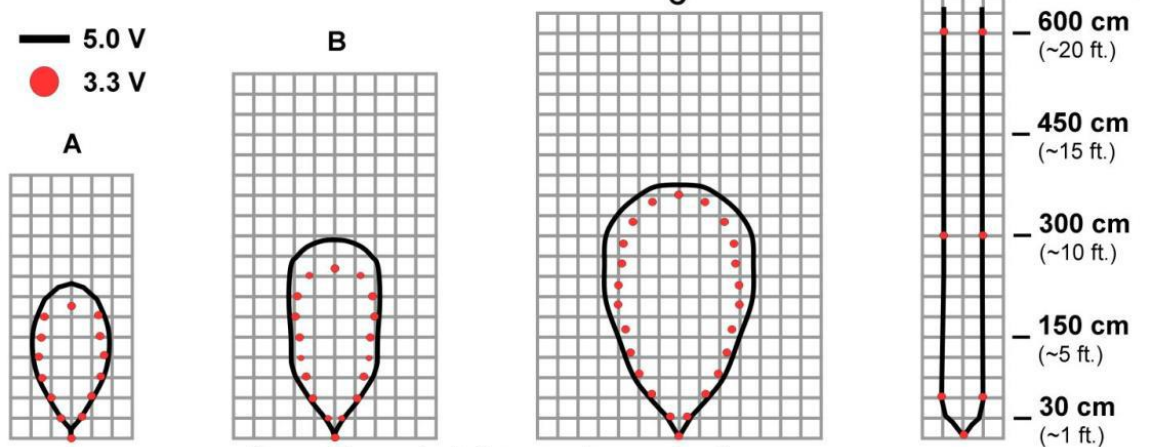
beam footprint and variable gain make it ideal because the detection zone and sensitivity can be tailored to the riding environment. On the highway speeds are higher and areas are open; a longer range and higher sensitivity will increase the safety margin. While on smaller streets, a shorter range and lower sensitivity will reduce false indications. The variety of sensor configurations available will allow for modifications late in the design process should interference between the sensors prove to be a problem with the proposed sensor placement.

MB1000 LV-MaxSonar®-EZ0™ Beam Pattern

Sample results for measured beam pattern are shown on a 30-cm grid. The detection pattern is shown for dowels of varying diameters that are placed in front of the sensor

- A 6.1-mm (0.25-inch) diameter dowel
- B 2.54-cm (1-inch) diameter dowel
- C 8.89-cm (3.5-inch) diameter dowel
- D 11-inch wide board moved left to right with the board parallel to the front sensor face. This shows the sensor's range capability.

Note: For people detection the pattern typically falls between charts A and B.



Beam Characteristics are Approximate

Beam Pattern drawn to a 1:95 scale for easy comparison to our other products.

Figure 5: Detection Pattern

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The final factor considered with this sensor is the cost. Because of the increased range and improved power consumption, it is only logical that this sensor would cost more than its less advanced counterparts. On average, one MB1000 ultrasonic sensor costs approximately \$25. This price is drastically higher than that of the HC-SR04. This project requires three sensors, so at this price, purchasing these sensors would expend a large portion of the funding for this project. This is a major concern because there are many other modules that must be purchased as well as manufacturing costs to consider.

3.2.3 Sensor Selection

Initially for this project, the HC-SR04 sensors were chosen for this application. The large amount of source code available made the sensors more favorable. In addition, since some members of this group already have experience programming this particular sensor, it seemed more intuitive to choose this sensor. However, after testing it was determined that these sensors only had a reliable range of 90cm. This was not sufficient for this project, so the group chose to change the sensor selection to the MaxSonar-EZ 1010 ultrasonic sensors. When tested, it was determined that these sensors were reliable up to 600cm, thus allowing a sufficient detection range for the system. Additionally, these sensors also allowed for several possible connection setups. This would allow the group to determine which setup provided the fastest data acquisition with minimal interference.

3.3 Screen Research

When using Head On, the user will receive all information through the display mounted to the front of the helmet. As a result, it is pivotal that the screen used is chosen carefully. The main factor that had to be considered was the size of the screen. The screen must not be so large that it obstructs the user's view; however, it must also not be too small because all of the indicators must fit on it without being too cluttered. For each of the screens, a piece of paper that size was cut out and the indicator symbols were drawn on it. This paper was then placed in front of a motorcycle helmet, in the same location it will be in the prototype, in order to determine if it was too large. Ideally, a perfect balance must be found.

3.3.1 SparkFun Serial Enabled LCD Kit

The serial enabled LCD kit from SparkFun was one of the first screens taken into consideration when designing this system. One of the features that first made this display appealing is the availability of the built in backlight. This brightness of this backlight can be adjusted. This is important for this project because it will allow various lighting settings to be tested in order to find the optimal setting. This LCD display uses white characters on a black background. This color schematic cannot be changed; however, the high contrast between the black and white would make the text easier to read. At the moment, the design of the user interface is in only black and white. However, if this display is chosen it will completely eliminate the ability to change the color scheme or give the user the ability to customize it. In addition, this screen allows up to two lines of up to 16 characters each to be displayed. These characters can be standard ASCII characters, as well as certain special characters. This format is similar to that of a seven segment display; this is significant because all four members of this group have experience programming seven segment displays. The image in

Figure 6 was used to plan the layout of the user interface with this screen. The image is not created to scale because the main concern was the placement of characters. In order to emphasize that this is a 16x2 display, the location for each character was displayed. This actual display is not designed like this. Luckily the proximity indicators were able to be created using one of the special ASCII characters. Overall, the layout of the display is awkward. Because of the restrictions on the placements of characters, the data is not evenly distributed on the screen. Additionally, there are no image representations for any of the values. Finally, the overall look of the display is somewhat unimpressive. It appears very simplistic and unappealing.

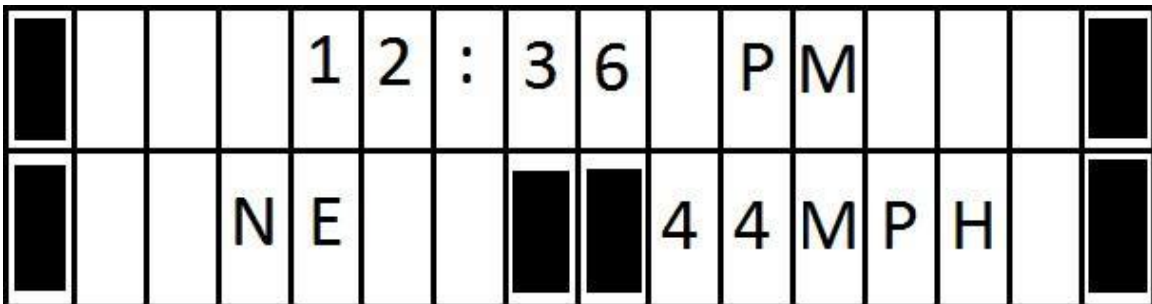


Figure 6: Segment Display Layout

For this project, the screen will display the time, speed, cardinal direction, and proximity indicators. Consequently, by limiting the information displayed on the screen to only two lines of sixteen characters, the display could be potentially cluttered, or a compromise might have to be made regarding what information is shown to the user. Furthermore, because this screen is limited to printing ASCII characters and a few special characters, the use of specially designed symbols to illustrate certain indicators is completely out of the question. Another area of concern with this screen is that it may be too wide. The placement of the screen would be difficult. Either the user would not be able to see all of the screen or the screen would block too much of the user's field of view. However, picking this screen would also have some benefits. Its strict formatting would simplify the coding process. Additionally, the ASCII character codes would make printing the characters simpler. Finally, there is a large amount of source code available for this screen that can be used for reference.

3.3.2 Adafruit 1.8" Color TFT LCD display

The next screen that was taken into consideration was the 1.8" color TFT LCD display by Adafruit. One of the primary reasons this display was taken into consideration was the size of the screen. It is imperative that the screen is small enough that it is not obstructive to the user. As one of the smallest screens taken into consideration, it would definitely follow this constraint. However, it is also a concern that this size may result in the indicators being too crowded on the screen. This screen has a 128x160 resolution and 18 bit color. This would allow immense flexibility when designing the layout of the user interface. In addition,

this screen also gives the option of using colors, which would allow the design of the user interface to be much more visually appealing. Unlike the SparkFun Serial Enabled LCD Kit, this screen does not restrict what characters can be displayed and where on the screen they can be located. Each pixel is drawn individually, which gives the layout and design of the user interface complete freedom.

Another benefit of this display is that it uses 4-wire SPI and it has its own pixel-addressable frame buffer. As a result, the display will be compatible with any microcontroller selection in the helmet unit. This will allow the microcontroller and display choices to remain independent of each other which will make the design process easier. Furthermore, there is a lot of example code that can be used as a reference when programming this display. Because none of the group members have programmed an LCD display this complicated before, this code will be a great stepping stone for determining how to program the user interface. Unfortunately, the complexity and the number of options available to customize the display mean that there will be a very steep learning curve for programming it. However, because there are so many possibilities with how the interface can be displayed, the code controlling the display will be much more complex. Additionally, while the small size of the screen is beneficial because it is nonobtrusive, it also has a drawback. The amount of information displayed on the screen may have to be limited, or else the screen may become too cluttered. This would make the display difficult to comprehend. Figure 7 below was created to illustrate this. This image was created with the same dimensions as the screen. Because the screen was so small, an extremely small font size had to be used. The large font is size 18, which for some perspective is the same size as the headings in this report, and the small font was size 10, which is even smaller than the text in this paragraph. After creating this figure, it became even more apparent that size would be a serious issue if this screen was used. Not only would the information be cramped in the screen, it would also be written extremely small, and there would be no room for future additions.

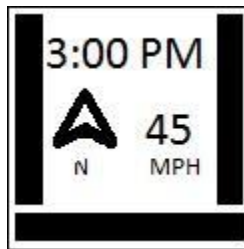


Figure 7: 1.8" Display Proposed Layout

3.3.3 Beaglebone Black Cape 4.3" LCD

The Beaglebone Black Cape LCD screen is 120.4 x 80.0 x 32.0mm. Without a doubt, the size of this display would allow for all of the information to be displayed on the screen without becoming cluttered. However, this size is also concerning because, as one of the largest screens considered, it may be too

large for this project. Even with careful placement, it may block too much of the user's field of view which would decrease rather than increase the safety of the system; thus making the entire system redundant. In order to better visualize the dimensions of the display, the following diagram, in Figure 8, was created. This diagram was created to scale in order to match the 95mm wide by 53.9mm high dimensions of the screen. Clearly there is a significant amount of space available. To put this into perspective, the larger font is size 30 and the smaller font is size 16. In comparison the previous 1.8" screen considered, this screen is excessively large. Even with such large fonts used and the proximity indicators on the edges made very wide, there is still superfluous whitespace, thus making the layout seem somewhat awkward.

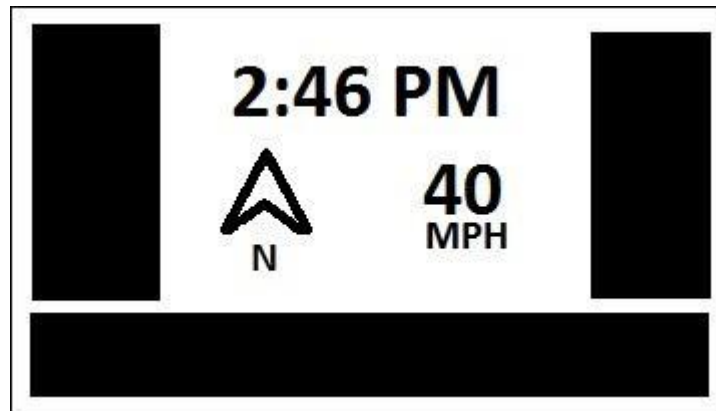


Figure 8: Beaglebone Black Cape Proposed Layout

However, this screen includes some features that could improve the design of the project. For example, this screen offers additional methods to interacting with it compared to the other screens. There are two separate methods of interaction. First, this display can be used as a touch screen. While there are no current features of the project that would require a touch screen, this option would open up many possibilities for future improvements especially if user customization is incorporated. Additionally, there are 7 buttons next to the screen that allow the user to navigate and interact with the user interface. Similar to the touch screen, there is not current need for this feature, but it does expand the number of possibilities for the design.

3.3.4 Adafruit 2.2" 18-bit color TFT LCD display

The final screen taken into consideration was the 2.2" 18-bit color TFT LCD display by Adafruit. The Adafruit 2.2" display measures at 55.23 x 40 x 2.46 mm. This screen falls in between the measurements of the Beaglebone Black Cape and the Adafruit 1.8" LCD display. Again, the project's goal is to utilize a display that is non-obtrusive to the user, yet clear and large enough for quick interpretation of the information displayed. Within these measurements, the LCD is packed with a 320 x 240 resolution and up to 18 bit color. These specs are not high resolution, but it does feature true TFT colors and improved refresh rates

over commonly used screens like the Nokia 6110. By no means is the screen high resolution but it spacious and detailed enough for the various details the Head On system seeks to display. Similar to the 1.8" display, this display also has an abundance of source code available. Again, a mock layout, shown in Figure 9, was created in order to gain perspective on issues that might occur. This screen seems to be a happy medium between the 1.8" and 4.3" screens above. With size 24 and size 14 fonts, the display is not too cluttered. Additionally, there is room for additional indicators in case additional modules are added. sparkFun

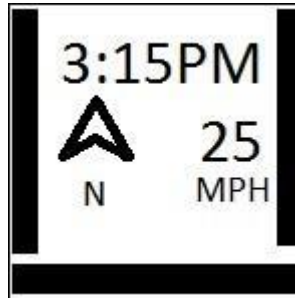


Figure 9: 2.2" Display Proposed Layout

3.3.5 Screen Selection

The major component taken into consideration when choosing the screen is the size. Because the screen is going to be mounted outside of the helmet, it must not be too large or else it will block the rider's view. However, the screen also cannot be too small or else it will be difficult to read. For the purpose of this project, the SparkFun Serial Enabled LCD Kit may be too wide. Either too much of the screen would not be visible to the rider, or it would cover too much of the user's field of vision. Similarly, the Beaglebone Black Cape 4.3" LCD also would be much too large. On the other hand, the Adafruit 2.2" and 1.8" 18-bit color TFT LCD displays are small enough that they would not affect the rider's ability to see.

The second major component taken into consideration is how the user interface will be designed. Because the SparkFun Serial Enabled LCD Kit uses the 16x2 character format, the placement of characters would be limited; this would result in either an overcrowded screen or certain features having to be removed due to lack of space. In addition, this screen would limit what could be drawn on it; only certain letters and special characters could be drawn rather than symbols or images. While the programming and design of the user interface would certainly be simpler if using this system, the color, character, and placement constraints are just too restricting for this project. On the other hand, Beaglebone Black Cape 4.3" LCD and Adafruit 2.2" and 1.8" 18-bit color TFT LCD displays would allow a much greater range of customization. Not only could the characters and symbols be placed anywhere on the screen, custom symbols could be designed

and displayed to represent data such as speed, cardinal direction, and proximity indication.

After comparing the screens, it was decided that Adafruit's 2.2" 18-bit color TFT LCD display would be the best choice for this project. This screen is small enough that it will not be obstructive for the rider, but still large enough that if more features were added to the project additional information could be added to the display. In addition, it will allow for more freedom in the design of the layout of the user interface by giving total freedom in the placement and design of the symbols used.

3.4 Microcontroller research

A part of developing the embedded systems that comprise the Head On project was to select central control unit that would handle data and connect to the various peripherals needed. In terms of embedded applications, four different types are available: microcontroller (MCU), digital signal processor (DSP), field programmable gate array (FPGA) and application-specific integrated circuit (ASIC). For the Head On project, only microcontrollers, digital signal processors, and field programmable gate arrays were considered.

The first embedded technology considered was microcontroller technology or MCU. As a part of the UCF curriculum, all Computer and Electrical Engineering students take part in courses that focus on microcontroller programming, thus each member of the group had prior experience with this technology. As with anything, pros and cons existed for implementing microcontrollers in the motorcycle and helmet units. The advantages for using microcontrollers consisted of the group's previous development knowledge, simple interfaces availability such as Texas Instrument's Code Composer Studio, and efficiency when processing asynchronous tasks. In contrast, use of microcontrollers was disadvantageous due to the large effect of code on the efficiency of the system. In specific, clock cycle optimization is dependent on the code optimization, which affects performance and power consumption. In addition, the code footprint influences the count of transistors needed, which further affects power consumption. Furthermore, the microprocessors architecture design makes it unsuitable for significant streams of data processing such as video or graphic processing.

The next embedded technology considered was digital signal processor technology or DSP. This technology is commonplace in applications requiring rapid processing and feedback such as airplane landing gears and collision avoidance systems. In other words, DSP is the optimal choice for real time response systems because its architecture is designed to perform simple calculations incredibly fast. When it comes to digital signal processors, the advantages consist of simpler code than the code required for MCUs, hardware implementations of basic function, which results in optimized use of transistors

and clock cycles for better performance and power consumption, and rapid processing of digital signals streams. On the other hand, DSP suffers from certain disadvantages such as reduced flexibility due to the hard wired basic functions and it falls on the higher end of the spectrum in difficulty when coding for a control portion of a control application. In addition to its use in real time response systems, DSP are suitable for audio and video oriented applications, as opposed to MCUs.

The last embedded technology considered was field programmable gate arrays or FPGAs. Field programmable gate arrays are unlike either of the other two technologies considered. Specifically, FPGAs are not processors at all, but instead these are a bulk of reprogrammable logic used to implement logic functions. There are two areas where FPGAs excel in: flexibility and speed. The former is achieved by its ability to be reprogrammed and do not have a fixed hardware resources such as those seen on PCB designs. The latter is achieved by its hardwired logic that is significantly higher than software based logic. While FPGAs impress in their ability to fit a user's design needs and provide speed, they suffer from a lack of clock cycle optimizations and high level of transistor redundancy which leads to far from optimal power consumption.

To summarize, each embedded technology considered provides the ability to process the data gathered from peripherals with its own set of advantages and disadvantages. The choice for which one to utilize came down to preference for this application as any selection was an engineering compromise. In this case, microcontroller was selected as the best suited processor for this application. It was chosen over its counterparts for its ability to handle asynchronous tasks, familiar interface, excellent performance in control applications (many real time control application perform multiple asynchronous tasks), low power consumption, and ability to do simple signal processing without the need for a dedicated DSP. To expand on this, DSP offers the benefits of fast signal processing useful for the heavy streams of data from peripherals such as the proximity sensors and GPS module; however, the data streams from these were estimated to remain on the lower end of the capabilities of DSPs ability. FPGAs offer flexibility and very fast speeds due to its hardware nature, yet suffered from high power consumption which goes against the low power consumption nature of Head On. Given this, it is important to note that either DSP or FPGA could have been used but preference, familiarity, and control application performance led to the selection of microcontrollers.

After selecting microcontrollers as the best suited technology for this application, the focus was shifted to selecting the best microcontroller for the job. The microcontroller will be the centralized unit that controls how the system handles data from peripherals, enables the helmet and motorcycle systems to operate together, and provides real time updates in the system using data. Hence, the decision of the microcontroller is vital to the design and making all planned components for the unit on the helmet motorcycle work properly together.

3.4.1 Texas Instrument's MSP430

A requirement for electrical and computer engineers at the University of Central Florida is the course 'Embedded Systems' which involves a lab portion focused on programming the MSP430. As a result, one of the first considerations for a microcontroller was the Texas Instrument's MSP430. Taking into account the group's working knowledge with the microcontroller, inexpensive pricing for the unit, and versatility of the controller, this was a top choice.

3.4.1.1 MSP430 LaunchPad

To begin, the MSP430 LaunchPad kit is available online for as low as \$9.99 directly from Texas Instrument's and includes:

- MSP430G2553IN20 MPU
- MSP430G2452IN20 MPU
- 10-pin PCB Connector (2 male/2 female)
- 32kHz crystal
- LaunchPad Development board (MSP-EXP430G2)
- LaunchPad sticker
- Mini USB cable
- Quick Start Guide

It is apparent Texas Instrument's wants their LaunchPad product used in many projects as this kit is probably sold at a loss to them with all the items included. The availability of the development board for the MSP430 is convenient for testing purposes while the PCB design is finalized. While the MSP430 may not have a high pin count as seen in Figure 10, it has become a recognized MCU by many hobbyists for its ultra-low power consumption. Specifically, data sheets for the MCU featured on the MSP430 LaunchPad state that at 1 MHz and 2.2 V, the MCU consumes 230 microamps, 0.5 microamps, and 0.1 microamps for active, standby, and off modes, respectively.

Consequently, it is clear the LaunchPad is suitable to remain within the power constraints of the Head On design whether it is used for the motorcycle mounted system, helmet mounted system, or both. However, even with the low power consumption, inexpensive cost, and powerful processing abilities, the pin count remains low; therefore it is difficult to consider this MCU to be implemented into the motorcycle's portion of the Head On system.

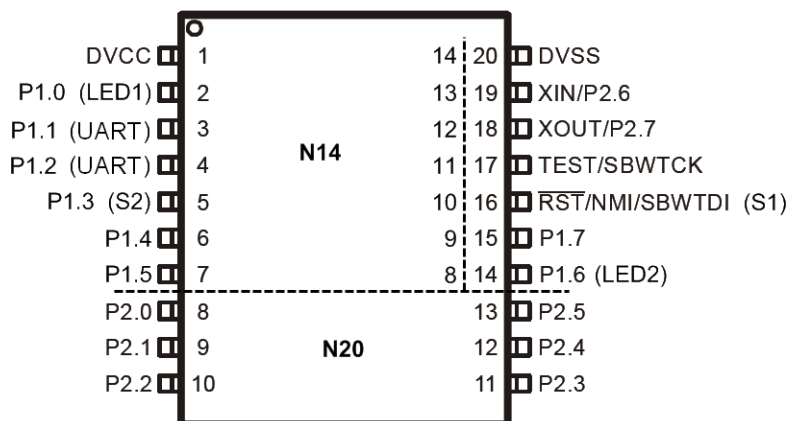


Figure 10: MSP430 LaunchPad Pins
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3.4.1.2 MSP430FG4618

Although, the MSP430 is inexpensive, it is by no means a cheap microcontroller. The MSP430FG4618 variant features a respectable amount of flash memory at 116kB, 8kB of RAM. It provides multiple system clock options from its internal oscillator to high accuracy external crystals. All of which can be used to supply the on board real time clock. Furthermore, the controller offers 80 I/O pins, as, that allow versatility in communication with the Head On system's awareness components. The two multifunction serial port interfaces with multiple protocols such as UART, I²C, and SPI. In addition to serial communication it includes a 12 bit analog to digital converter, two 12 bit digital to analog converters, and three programmable operational amplifiers. It also offers display options with a built in 160 segment LCD driver and regulated charge pump. All these features are powered by a 1.8V to 3.6V supply with a typical current draw of 400uA. Five power saving modes reduce the current draw down to 1.3uA in standby mode and require less than 6us to return to full operation. The MSP430FG4618 clearly has the power and pin count to perform all the functions of either of the Head On modules. Its small footprint and low power consumption also fit well within the space and power constraints of the project.

3.4.2 Atmel AVR Processors

Atmel offers a diverse line of AVR controllers that offer a wide range of memory and processing power to develop a suitable prototype. Furthermore, a variety of the chips that are available from Atmel provide the low power consumptions within the range required for this project design. The main draw to the Atmel AVR processors is their inclusion in the increasingly popular Arduino boards, which have with a fast growing community of support and projects. Two notable microcontrollers considered from Atmel were the ATmega328 and the ATmega2560. These two processors were favorable because they are both used in development boards. The ATmega328 is used in the Arduino UNO and the

ATmega2560 is used in the Arduino Mega. There are a lot of resources available for these development boards due to their popularity. Additionally, the use of these development boards in the initial design stages of this project would greatly ease the software development process. The software could be loaded into one of these development boards and all of the appropriate modules attached, and any issues could be discovered early on.

3.4.2.1 ATmega328

To begin, the ATmega328 is a very popular microcontroller that appears in the Arduino Uno development board which can be attained at lost cost similar to Texas Instrument's Launchpad. The controller is priced at \$3.99 from SparkFun with the Arduino bootloader already installed. This is a very low cost for a controller that is known to be powerful, reliable, and simple to work with the Arduino software. Specifically, if an Atmel processor is chosen, the project would require it to use an Arduino bootloader as the Arduino IDE since the availability of coding resources for the ATmega328 with this bootloader is substantial.

Furthermore, upon researching the ATmega328, it was discovered that it contains support for the Philips I2C protocol in addition to the Rx and Tx serial ports. This is highly beneficial because it allows flexibility to add any peripherals that may require an I2C port. There is a limitation of one I2C port on the ATmega328; however, the controller provides a 7 bit address space to allow up to 121 peripherals, assuming the addresses are all unique. Additionally, the controller features 14 digital pins (6 of which can be used for pulse width modulated output) and 6 analog pins as seen in Figure 11. Similar to the MSP430, this is a low number of pins especially since pins will be needed for the ultrasonic sensors, GPS module, and Bluetooth.

Next, the ATmega328 needs sufficiently low power in order to be implemented into the helmet unit. As mentioned earlier, the importance in power consumption comes into play in the helmet unit as the motorcycle will be used to power the system equipped onto it. According to the controller's data sheet, with the conditions of 1 MHz, 1.8 V, and 25 degrees Celsius, the ATmega328 consumes 0.2 milliamps, 0.1 microamps, and 0.75 microamps, in active, power down, and power save modes, respectively. The current prototype design plan consists of a rechargeable battery equipped to the helmet unit in conjunction with flexible solar panels to provide charge during daytime for the rider. Factoring in the power consumption values and the charging system, powering the microcontroller would not be an issue for the helmet unit.

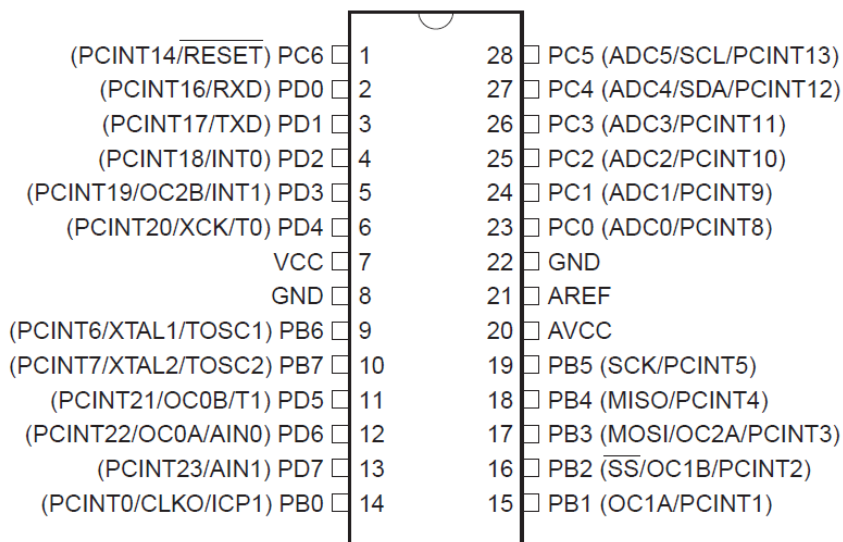


Figure 11: Pin mapping for ATmega168/328
Reprinted with permission from Atmel

3.4.2.2 ATmega1280

The next microcontroller taken into consideration in the Atmel AVR family was the ATmega1280. The ATmega1280 is all around beefier selection in comparison to the ATmega328; it provides superior memory capacity, performance, and pin count. Just as the ATmega328 is implemented into the Arduino, the ATmega1280 is featured on the Arduino Mega development board.

First, the ATmega1280 possesses a significantly higher pin count than the ATmega328. As seen in Figure 12, the ATmega1280 has 54 digital pins (14 of which can be used for pulse width modulated output) and 16 analog pins. Furthermore, the ATmega1280 also supports the Philips I2C protocol and contains multiple I2C ports. As mentioned previously, one port can support up to 128 unique addressed peripherals, yet multiple ones surely do not hurt and provide further flexibility for the design. If the ATmega1280 were used, communication with other modules, such as the ultrasonic sensors, GPS, and Bluetooth modules, would not be a concern since the pin count is more than sufficient for what has been estimated.

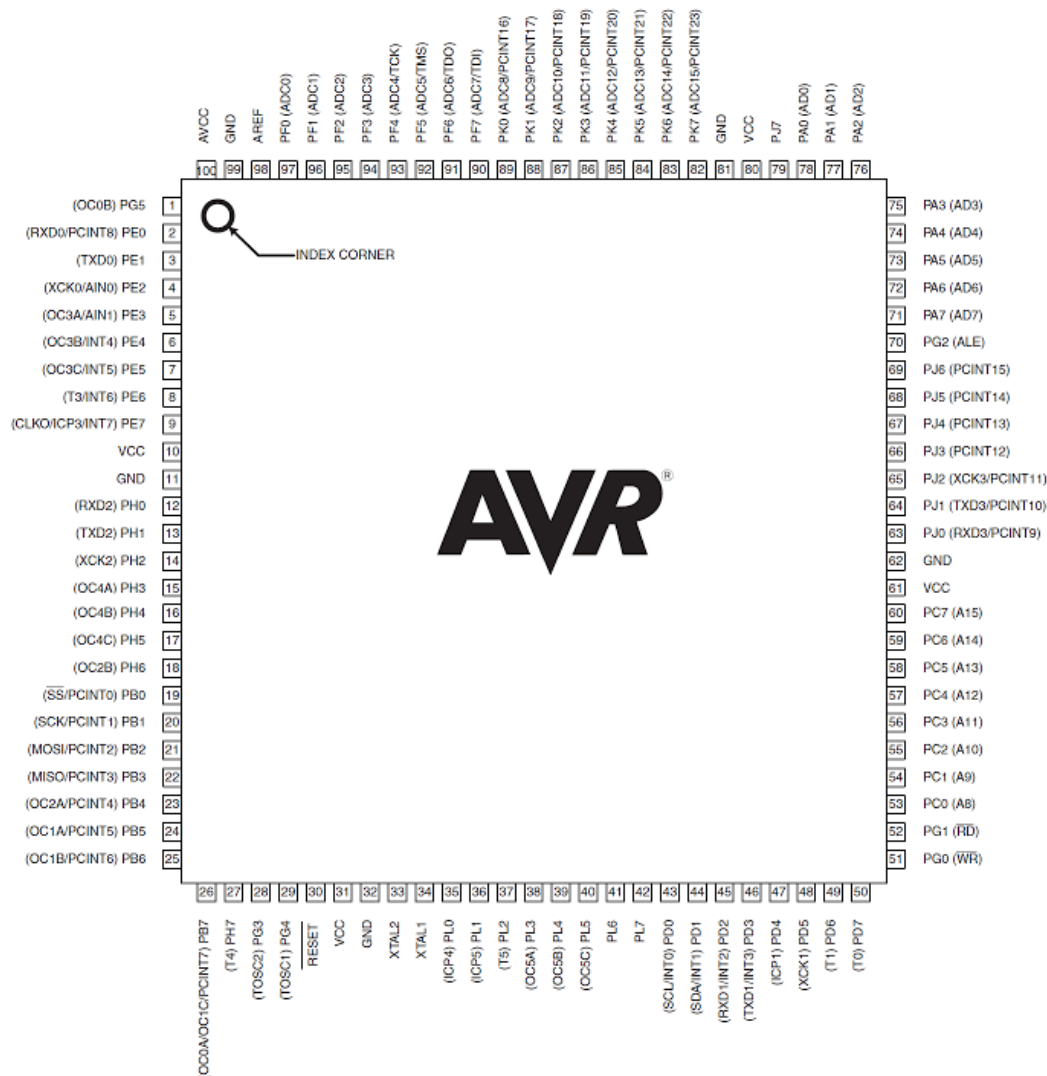


Figure 12: Pin mapping for ATmega640/1280/2560
Reprinted with permission from Atmel

As with the other microcontrollers considered, minimal power consumption was a key characteristic in considering use of the ATMEGA1280. As it is one of the larger and more powerful MCU's considered, it was expected to draw a large amount of current, yet the technical specifications were surprising. Specifically, at 1 MHz and 1.8 V the ATMEGA1280 consumes an ultra-low 500 microamps. In power down mode, it consumes an even lower current of 0.1 microamps at 1.8 V. Taking into account the ATMEGA 1280's 0 - 16 MHz speed grade, abundant pins count, large memory size, and ultra-low power consumption, it appears to be a robust chip packed with features beneficial to this implementation.

3.4.3 ARM Processors

ARM processors have increased in development and popularity over the recent years. Key features such as reduced cost, heat, and power use make it no

surprise these reduced instruction set computing, RISC, based processors appear in many smartphones and tablets in today's market. Similar to Texas Instruments and Atmel, ARM Holdings' product line is copious with various chips being capable of meeting the needs of the Head On system. Further analysis of the ARM processor product line resulted in eyeing one specific MCU: the ARM STM32F405VG.

3.4.3.1 ARM STM32F405VG

First, the STM32F405VG features a healthy amount of flash memory and SRAM at 1 MB and 192+4 KB, respectively. This is enough memory to drive either unit in Head On, and still leaves a sufficient amount available for future additions to the system. To complement the large memory size, this ARM MCU features 100 pins as seen in Figure 13, 3 of which are intended for Philips I2C protocol connectivity. Furthermore, of the 100 pins on the MCU, 82 pins are available for general use which far exceeds the pin requirements of this project, thus giving further flexibility for future development and room to add more peripherals.

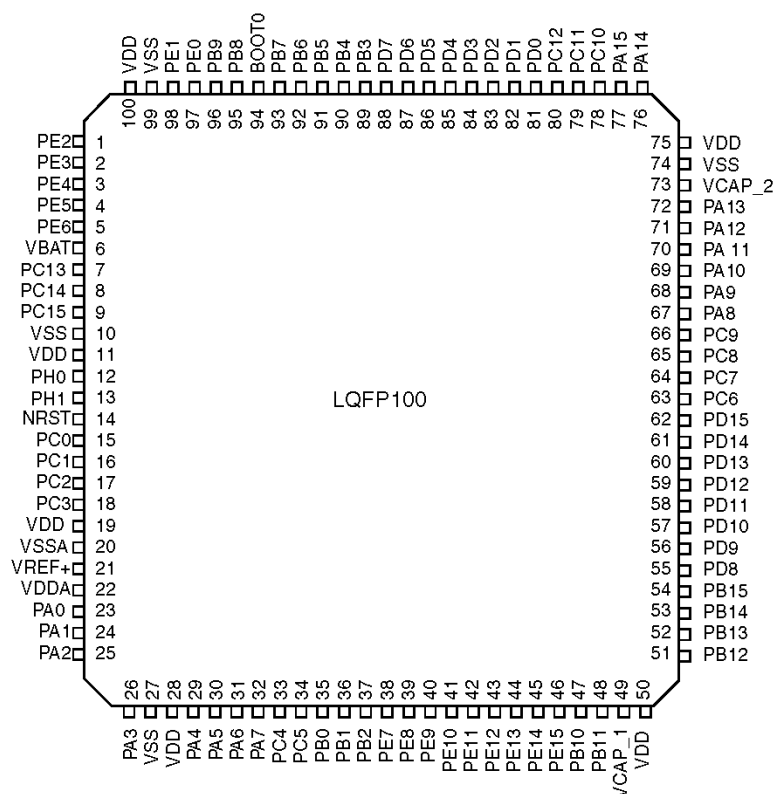


Figure 13: Pin mapping for ARM STM32F405VG
Reprinted with permission from STMicroelectronics

In addition to the flexibility it offers with the number of connections provided, the STM32F405VG must also fall below the project's power consumption requirements in order to remain a considerable option. Operating at a minimum of 1.7 V and maximum of 3.6 V, this ARM MCU draws a current of 40 milliamps,

280 microamps, and 2.2 microamps for dynamic run, stop, and standby modes, respectively. These levels appear higher than any of the other product lines previously mentioned in this document; regardless of this, these levels are reasonable and still within the threshold due to the processing performance of the ARM MCU.

3.4.4 Microcontroller Selection

Side by side, each microcontroller features its own set of advantages and disadvantages for this project. First, the MSP430 LaunchPad from Texas Instruments proved to be a potential final candidate because it featured low power consumption, small footprint, and inexpensive unit cost. In the same token, it was seen the ATMEGA328 from Atmel also featured the attractive points from the MSP430 along with I2C port connectivity and a higher pin count to successfully implement all the sensors and peripheral devices needed. The ATMEGA328 and MSP430 LaunchPad could be considered the smaller microcontrollers next to the ATMEGA1280, MSP430FG4618, and ARM STM32F405VG which featured a significant pin count increase and computation power. By implementing either one of these MCUs, we were given flexibility for current and future development of the project; however, these three microcontrollers' specs far exceed the needs of the project which led to choosing between the smaller, less powerful microcontrollers, the MSP430 LaunchPad and ATMEGA 328.

The decision between the MSP430 LaunchPad and ATMEGA328 was difficult as both microcontrollers are very much alike. The choice came down to preference. The ATMEGA328 was preferred because its popularity amongst hobbyist provides a rich community filled with relevant projects and applications that will be useful for getting all the modules and systems working and communicating properly.

3.5 Communication Technology Research

Wireless communication is defined as the transmission of information over a distance without help of wires, cables, or other electrical conductors. In modern days, one will find mobile devices that features one or more of the wireless technologies such as Bluetooth, ZigBee, and Wi-Fi. It is a crucial area of interest in the always connected modern age. Similarly, inclusion of one of these wireless communication technologies is crucial to the successful implementation of this Head On system since the helmet and motorcycle units will need to be in constant communication with one another without any interference to the rider. For the Head On system, three types of wireless communication were considered: Bluetooth, Wi-Fi, and ZigBee. In order for a decision to be made, each form of wireless communication was compared with certain project needs in mind, such as data rate, range and power consumption.

3.5.1 Wireless Communication Protocols

Before exploring what modules would allow wireless communication between the two units that comprise Head On, further research was necessary into these protocols. As mentioned previously, the three protocols considered were Bluetooth, Wi-Fi, and ZigBee. Each protocol, though similar in communicating wirelessly, has its own individual set of advantages and disadvantages in terms of security, network complexity, and operating range.

3.5.1.1 Bluetooth

One of the most recognized protocols among mobile devices and one of the first methods under consideration for wireless communication in Head On is Bluetooth. Bluetooth's popularity for connectivity is evident in today's market as it appears in headset, video game controllers, tablets, smartphones, smart watches, laptops, and even vehicles. The use of Bluetooth is featured in several close proximity environments similar to the one between the rider and motorcycle units in Head On. Specifically, Bluetooth is seen in applications such as hands-free handset use during phone calls, transfer between two nearby computers or phones, or listening to music through Bluetooth equipped earbuds.

Previously, Bluetooth was standardized by IEEE as 802.15.1; however, maintenance of the standard was ceased and "picked up" by the Bluetooth Special Interests Group. The group, consisting of over 25,000 member companies, is responsible for development of the specification, managing the qualification program, and handling trademarks. Any manufacturer that wishes to market any product as a Bluetooth device must meet the Bluetooth Special Interests Group standards first. This maintenance of the protocol offers peace of mind if Bluetooth is chosen to connect the motorcycle and helmet units of Head On together because there should not be any compatibility issues due to varying protocol standards when connecting Bluetooth certified modules.

In choosing an appropriate protocol, one of the first characteristics analyzed was range of coverage. The intention of the Head On system is to keep the rider connected during their ride, as well as allow him or her to roam around near his or her motorcycle freely, while still remaining connected to the motorcycle unit. This can be brought into fruition because Bluetooth connectivity protocol provides a range of approximately 10 meters for class 2 Bluetooth, which is the standard found in most mobile phones. In Table 5, the distance variations for all three radio classes of Bluetooth are shown as well as the maximum power consumption that they require. A closer look at the table reveals that class 2 is the halfway point in comparison to the other classes. Class 2's balance between the power consumption and operating range makes it the most suitable for the application of this Senior Design project, while still remaining within the project requirements.

Table 5: Bluetooth Power Consumption and Operating Ranges

Class	Max Power	Operating Range
Class 1	100 mW	100 m
Class 2	2.5 mW	10 m
Class 3	1 mW	1 m

Furthermore, Bluetooth networks use master/slave model to for data handling. Figure 14 illustrates this concept. These piconets, as they are commonly referred to, will have one master that can send or retrieve data from any of the slaves. Meanwhile, the slaves in the piconet can only send or retrieve data from the master and cannot “see” any other slaves in the network. The piconet on the left side of this figure represents the view of the piconet from the slave’s perspective. On the other hand, the right side of the figure represents the master’s view of the piconet. In the case of the Head On system, either the helmet or the motorcycle unit would be designated the master, and the other unit would be the slave. Because of the master’s ability to have multiple slaves, this wireless communication method would allow for easier integration of components to the Head On design in the future. Only unit that is assigned as the master would have to interact with this new slave; as a result, the original slave unit would be able to function as usual and would require no alterations to its code.

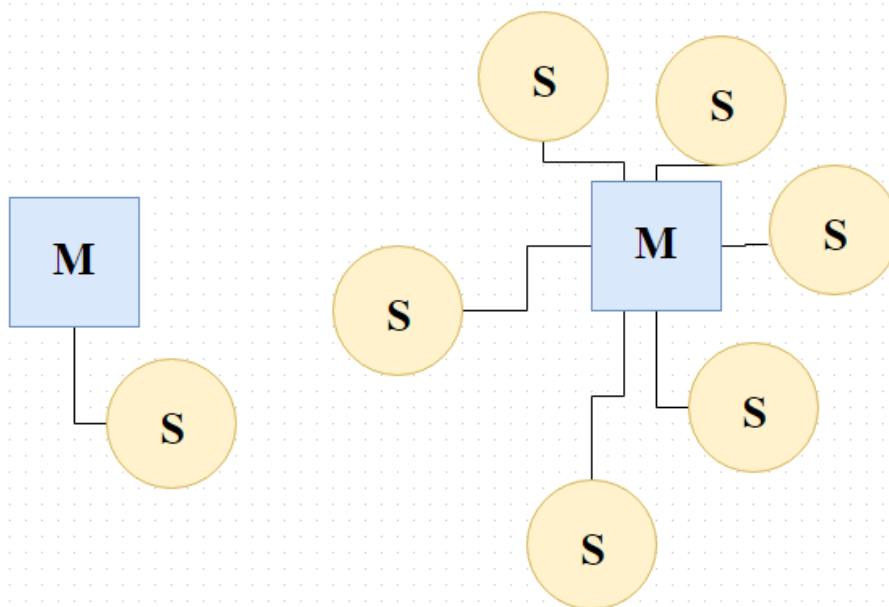


Figure 14: Depiction of the master/slave Bluetooth model

Similar to other wireless communication protocols, Bluetooth operates on the 2.4 GHz radio frequency; however, interference in this range becomes less of a concern due to the implementation of adaptive frequency hopping (AFH) which enables the connected devices to remain off frequencies used by other nearby devices. This would be beneficial to the Head On system because it would reduce the concern of possible interferences.

Another primary concern when considering which of the wireless protocol to use was power consumption. Bluetooth was built with a low power consumption design; this is evident in class 2 Bluetooth, which uses an impressively low amount of 2.5 mW at max power. This power consumption drops even further for devices that are equipped with Bluetooth low power technology, which is designed for maximum battery life instead of data transfer rates. This technology use only $\frac{1}{2}$ to $\frac{1}{100}$ of the power consumption of classic Bluetooth.

Gathering all details of the Bluetooth protocol's operation and characteristics, a list of key advantages and disadvantages for the protocol consist of:

Advantages:

- Low power consumption for class 1 and 2 radios
- Low connection complexity for easy pairing and connections
- Reduction of clutter on frequencies through adaptive frequency hopping
- Various operating ranges to meet any project needs up to 100 meters
- Direct line of sight not required for paired devices

Disadvantages:

- Utilizes cluttered 2.4 GHz frequency band
- Low data transfer speeds compared to other protocols (25 Mbps for Bluetooth 4.0 vs 250 Mbps for Wi-Fi)
- Lower security compared other protocols such as Wi-Fi and ZigBee

Among the various protocols considered for communication between the helmet mounted microcontroller and motorcycle mounted microcontrollers, Bluetooth was one of the easiest to configure a connection. Bluetooth makes pairing quick and hassle free by allowing devices to "remember" previous bonds, thereby allow future re-connecting without going through the pairing process again. However, with a low connection complexity comes one hindrance as the Bluetooth protocol contains a less secure network platform limited to key matching. Despite this, the lower security of the protocol is shadowed by its performance in power consumption and operating. Specifically, class 2 Bluetooth devices which possess low power consumption levels at 2.5 mW for a maximum operating range of 10 meters. All things considered, Bluetooth is an excellent fit for this project due to its balanced features.

3.5.1.2 Wi-Fi

Another familiar and popular protocol taken into consideration is wireless fidelity, otherwise known as Wi-Fi. The protocol is controlled by the Wi-Fi Alliance which defines it as any wide area local network product based on the IEEE 802.11 standards. It is common for Wi-Fi to operate on 2.4 GHz radio bands and more recently 5 GHz radio bands. The development of Wi-Fi is mature, thus it can be trusted for establishing a reliable connection between the two units that comprise Head On.

When it came to considering the Wi-Fi protocol, two key features made it shine among all the other wireless communication technologies: data rate and connection distance. To begin, the range for an access point using a stock antenna under either the 802.11b or 802.11g standards can reach up to 100 m considering very little interference. This is a highly impressive range, yet it significantly exceeds the project requirements as the hope is that the rider is never separated that far from the motorcycle. Next, the data transfer rates for Wi-Fi eclipsed other mentioned protocols as it can provide speeds similarly high to a wired connection. For one of the IEEE standards, 802.11ac, data rates can go up to 433.3 Mbit/s per spatial stream. In the case of this system, data transfer rates must be sufficient enough to allow a consistent transfer of data from the ultrasonic sensors and GPS to the helmet system with minimal to no data loss.

While Wi-Fi excelled in the data rate transfer rates and connection, it is also important to determine if this protocol has a low enough power consumption. Unfortunately, in the case of Wi-Fi, it is the largest power consumer among all the protocols that have the same data transfer rates due to the range of the signal it emits.

Taking into account all details of how Wi-Fi operates and the characteristics of the protocol, a list of key advantages and disadvantages was constructed:

Advantages:

- Signal is able to reach long distances of up to 100 m
- Can operate on 2.4 GHz or 5 GHz radio frequency
- High data transfer rates that were comparable to wired connections
- Variability in security provided by various security schemes

Disadvantages:

- Complexity in connectivity compared to other protocols such as Bluetooth
- Highest power consumption among considered protocols
- Potential interference issues due to radio wave propagation

This list detailed several key points for and against the Wi-Fi protocol. The range provided and data rates excel among all the protocols, however this comes at high cost in regard to energy consumption. While there is no denying that the data rates and connectivity range are impressive, the project currently does not

require such features since no video streaming is currently planned and the system is designed to be used in close proximity on rides. As it stands, it is not sensible to use Wi-Fi given its excessive specs and power use.

3.5.1.3 ZigBee

One other wireless protocol considered is the less familiar, compared to Bluetooth and Wi-Fi, ZigBee protocol. ZigBee is a fairly recent technology, yet it is maturing as development has remained strong since its conception in 1998. Following creation, it has been standardized under IEEE 802.15.4 in 2003 and recently received a revision in 2006. Similar to Wi-Fi and Bluetooth, the ZigBee protocol development, research, and certification is handled by an association of members consisting of business, university, and government agencies known as ZigBee Alliance.

ZigBee combines features that can be found in both Bluetooth and Wi-Fi. To be specific, ZigBee connections are secured by a standard AES-128 security scheme, as seen in Wi-Fi, while providing low power consumption levels. The protocol also transmits on the 2.4 GHz radio band globally with access to sixteen 5 MHz channels. Unlike other protocols, which implement special techniques to ensure transmission is successful and free of interference, ZigBee does not utilize frequency hopping technology. Rather it depends on automatic retransmission to deliver data packets. Due to this, special care is required in ZigBee implementations in order to ensure that no complications arise as a result of interference.

Various characteristics were essential in choosing the appropriate wireless communication protocol. First and foremost the protocol used needed to maintain low power consumption. In the case of ZigBee, it excels in low power consumption thus it is implemented into many low data rate applications requiring maximum battery life and security. Additionally, the ZigBee PRO product line uses a Green Power feature that allows communication using only 100-500 microjoules of energy. This makes ZigBee the best choice for low power consumption; however, other specifications such as data rates and operating range remain. As previously mentioned, ZigBee is featured in low data rate applications as the protocol has a defined rate of 250 kilobits per second with a range of 10 - 100 meters. Complications arise with the data rate as it is only a fraction in comparison to Bluetooth and Wi-Fi's data rates. However, the wireless communication is only needed to transmit data gathered from the sensors and GPS module thus 250 kilobits per second would still be sufficient in this application. One caveat with the range is devices connected through ZigBee must maintain line of sight in order for a successful connection to be achieved. When one takes into consideration the movement of the rider and any gear, it is seen that the line of sight between both units cannot be guaranteed at all times, thus jeopardizing both the connection and the system's effectiveness in assisting the rider.

In summary, the advantages and disadvantages of the ZigBee protocol are listed as:

Advantages:

- Operating range up to 100 meters depending on conditions
- Simple, non complex connection setup
- Secure network provided by AES-128 security scheme
- Lowest power consumption among protocols considered
- Low network acquisition delay at 30 ms
- Able to connect to multiple nodes

Disadvantages:

- Operates on cluttered 2.4 GHz radio band
- Susceptible to interference due to lack of frequency hopping technology
- Requires clear line of sight for connection

Overall, ZigBee is a well-rounded wireless communication useful for handling sensor data transmission. Featuring 128 bit symmetric encryption, simple connection setup, and a quick network acquisition, it provides peace of mind for the user in terms of no other nearby persons intruding into the Head On system and a simple, reliable connection. ZigBee continues proving itself as effective by providing the secure connection while drawing ultra-low current levels compared to the other protocols discussed in this document. However, with this in mind, ZigBee also has downsides in the form of low data rates which limits the flexibility of expansion later on for the project for high bit rate features such as video feed. Additionally, the protocol requires a clear line of sight between the modules that cannot be guaranteed especially in the motorcycle-rider application. Unless the unit placement can be designed free from any obstructions, use of ZigBee can prove disastrous towards the goal of aiding the rider.

3.5.1.4 Wireless Communication Protocol Selection

In selecting the best suited wireless communication protocol for the Head On system, certain factors were vital to ensure a reliable connection and guarantee that all data was processed between the microcontrollers in real time. These heavily weighted factors included: power consumption, data transfer rates, and operating range. Other factors that were also considered in the decision but were not emphasized as much include the network complexity, security levels, and interferences of the protocols. To illustrate, Table 6 below displays the differences between the Wi-Fi, ZigBee, and Bluetooth protocols considered based on various factors. These differences were analyzed in order to determine which protocol would be best suited for this project.

Table 6: Comparison of Wireless Data Transmission Protocols

Attribute	Wi-Fi	ZigBee	Bluetooth (Class 2)
Standard	802.11 (a,b,g,n)	802.15.4	802.15.1
Frequency	2.4 and 5 GHz	2.4 GHz	2.4 GHz
Operating Range	100 meters	10 - 100 meters	10 meters
Data Throughput	25 Mbps (g)	250 kbps	0.7 - 2.1 Mbps
Network Acquisition	3-5 s	30 ms	< 10 s
Security	High	High	Low
Relevant Power Consumption	High	Very Low	Medium
Example Battery Life	Hours	Months to years	Months to years

At a glance, Bluetooth stands out as the mid-range among the three protocols considered. Specifically, Bluetooth offers mid-levels of power consumption at 2.5 mW and an operating range of 10 meters for class 2. Furthermore, Bluetooth also offers flexibility with a data transfer rate of 25 Mbps, which ZigBee lacks at a limit of 250 kbps. One caveat of the Bluetooth protocol though is the low security scheme limited to key matching. However, this is a small compromise as the Head On system is designed as a situational awareness assistant rather than a means to transfer sensitive data or act as a security system for the motorcycle. Considering all the attributes of Bluetooth in relation to Wi-Fi and ZigBee, it was determined that Bluetooth is the best suited protocol for this project in order to keep the reliable, real time data displayed while still maintaining a low power system.

3.5.2 Wireless Communication Modules

After exploring various options for wireless communication technology that could be implemented, Bluetooth was chosen as the best fit for this application. Now, further research is required in order to select the best suited modules that will allow Bluetooth connectivity to be incorporated into the microcontrollers. The Bluetooth module selected needed to meet certain criteria. One of the first requirements of the Bluetooth modules is that it possesses a capability for UART serial communication. Other requirements include sufficient operating range, low power consumption, and a minimal design.

3.5.2.1 RN42

One of the first modules considered is the RN42 Bluetooth module. Specifically, the RN42 module considered is manufactured by Microchip, which comes in a small form factor measuring at only 13.4 x 25.8 x 2.4 mm. Microchip directly sells most models of RN42 for an affordable cost of \$15.27. Earlier, it was discussed that Bluetooth technology is classified into one of three various classes. This specific module is classified as a Class 2 Bluetooth module; therefore, it would meet the necessary operating range as Class 2 is capable of operating up to 10 meters apart. Additionally, the RN42 is certified by the FCC and Bluetooth SIG. Being a certified Bluetooth device, it reassured the group this part would bear no compatibility issues with other Bluetooth connections and functionality would meet the standard requirements.

In terms of connection, the RN42 module offers several favorable features. In particular, the RN42 supports various Bluetooth stack profiles which include SPP, HID, and DUN. Additionally, interfacing is made simple with this module with the ability to utilize ASCII commands over UART or use a USB connection interface.

As with all of the other modules in this project, power consumption is a major concern. The RN42 only uses 26 microamps, 3 milliamps, and 30 milliamps when it is in sleep mode, connected, and transmitting respectively. The module will mainly be in transmitting mode since the microcontroller on the motorcycle and helmet units will be continuously communicating data when the system is used. While this does cost the greatest amount of power among the three power modes, this value is still quite small; therefore, the power consumption of this module will be minimal.

In summary, the key features that made the RN42 favorable for this application include:

- Class 2 Bluetooth with a max operating range of 10 meters
- Embedded stack profile support for: GAP, SDP, RFCOMM, L2CAP, SPP, HID, and DUN
- 128 bit encryption
- Low power consumption:
 - Sleep mode: 26 microamps
 - Connected: 3 milliamps
 - Transmitting: 30 milliamps
- Modular certified for the FCC
- Bluetooth SIG qualified
- Sustained data rate of 1.5 Mbps and 3.0 Mbps burst

3.5.2.2 HC-05

Another module Bluetooth communication module considered is the HC-05. The HC-05 is a very popular module among hobbyist because of its low cost. One

can find that the HC-05 is widely available from various distributors, but the specifications remain similar among the various companies. For this project, the HC-05 module under consideration is made by Itead.

To begin, the HC-05 module is available for the low price of \$6.00 making it an inexpensive device for linking the two microcontrollers that will comprise Head On. Use of this chip would minimize the size of the units mentioned as it is also available in a small form factor with the measurements 2.7 x 1.3 x 0.8 cm. This is ideal because one of the goals of this project is to keep the size of the motorcycle and helmet units small so that they will be non-obtrusive.

Next, the HC-05 is a Bluetooth SPP (Serial Port Protocol) module with a Class 2 classification similar to the RN42, so it will allow for an operating range of 10 meters. Another notable feature of this module is that unlike its even numbered counterparts (HC-04 and HC-06), which are set to either master or slave mode from the factory, the HC-05 can be configured to either mode according to the user's need. Connectivity is a breeze with this module as it comes with an auto connect feature that connects to the last known device. In terms of connecting the HC-05 to a microcontroller, it uses 6 pins: VCC, GND, TX, RX, KEY, and LED. Keeping in mind the low pin count on the ATmega328, this chip helps meet the physical constraint as only five of the six pins are needed for proper serial to Bluetooth data communication since LED is not necessary.

As with the RN42 module, power consumption must be taken into account when considering this module. The maximum power consumption of this module is 30-40 mA, and it occurs during pairing. This is not a major concern for this project because pairing will only have to occur when starting up the system. Unlike the RN42, the HC-05 does not have different current consumption for sleep, connected, and transmitting modes. In fact, a sleep mode does not exist. While this would normally be concerning, the current consumption of these modules is only 8 mA (after pairing). Because of this steady value of current consumption, calculating the amount of power needed for these modules will be significantly easier.

Key features that made the HC-05 favorable for this application include:

- Class 2 Bluetooth with max operating range of 10 meters
- Support for both master and slave mode
- UART interface with programmable BAUD rate
- Small footprint and affordable
- Bluetooth Spec v2.0+EDR compliant
- Maximum power consumption of 30-40 mA
- RoHS (Restriction of Hazardous Substances Directive) compliant

3.5.2.3 SaBLE-X

The newest of all the Bluetooth modules considered is the SaBLE-x module from LSR. The SaBLE-x is appropriately named after the most recent version of Bluetooth technology, Bluetooth Low Energy (or Bluetooth v4.0+ or Bluetooth Smart) which it makes use of. Bluetooth Low Energy devices are unlike their predecessors as focus is placed on improving cost, security, interoperability, and most of all power consumption. These BLE devices are designed to run for long periods on battery sources or energy harvesting devices which quickly made it attractive for either the helmet unit which is battery powered or both units.

First, it was important to meet certain constraints when choosing the right Bluetooth module. Specifically, constraints consisted of price, size, and operating range. In comparison to other modules, SaBLE-x was pricier yet affordable at \$16.52 for one module from digikey.com. The module comes in a small form factor, as seen in Figure 15, with measurements 11.6 x 17.9 x 2.4 mm which is useful when trying to maintain minimal design for placement on the helmet or motorcycle. Though small and inexpensive, the SaBLE-x does possess significant operating range. Operating under Class 2 specifications, this module can communicate within a 10 meter range similar to the other two considered modules which is more than satisfactory for keeping the rider and motorcycle connected.



Figure 15: SaBLE-x module from LSR
Reprinted with permission from LSR

Next, the features of the SaBLE-x module were considered to determine whether it fit the Head On application or not. Two features that immediately stood out about this board during research on it were the availability of a development board package from LSR and the implementation of an ARM Cortex M3 microcontroller. The development board is useful for initial prototyping of the Head On unit and most helpful when it comes to testing phase of the project. The availability of a microcontroller on the Bluetooth module is also helpful as it allows flexibility to place the application in its entirety on the MCU or use an external MCU in conjunction with this module. Further features of this module consisted of upgraded Bluetooth support, ultra-low power consumption, and it meets various compliances. Specifically, the SaBLE-x module is compliant with

Bluetooth 4.1 standards and is capable of Bluetooth 4.2 for future use. While supporting the most recent version of Bluetooth technology, this module maintains low power consumption with 8.4 mA in transmit mode, 7.4 mA in receive mode, and 1 μ A in standby mode as it operates on a voltage range of 1.8 V to 3.8 V. In addition to low power and updated Bluetooth technology support, the module meets specific compliances similar to the other two modules analyzed. In specific, the SaBLE-x meets FCC, REACH, and RoHS compliances, which is important as the embedded devices will work in close proximity to users.

Overall, LSR's Bluetooth module is an impressive piece of hardware at a low cost that made a notable impression with features that include:

- Class 2 Bluetooth support for operating range of 10 meters
- System On Chip (SoC)
 - Integrated ARM Cortex M3 and Cortex M0
 - 128 kB Flash / 20 kB SRAM
 - Onboard 32 kHz and 24 MHz crystals
 - Drivers, BLE controller, and bootloader on ROM
- Low power consumption
 - 8.4 mA in transmit mode
 - 7.4 mA in receive mode
 - 1 μ A in standby mode
- Development board available for testing
- Bluetooth 4.1 compliant, Bluetooth 4.2 capable
- FCC, REACH, and RoHS compliant

3.5.2.4 Wireless Communication Module Selection

The final choice for the Bluetooth module was a critical as this piece of hardware is the communication point between the two units of Head On. The modules were compared based on specific criteria such as footprint, Bluetooth version, power consumption, price, and additional features. The operating range of each module was also considered; however, all considered modules carried a Class 2 classification which provides 10 meters of operating range thus all were sufficient in this category.

The first module considered was Microchip's RN42 Bluetooth module. The footprint and price of this chip were low at a size of 13.4 x 25.8 x 2.4 mm and price of \$15.27 per unit. Power consumption was low with draws of 26 microamps, 3 milliamps, and 30 milliamps when it is in sleep mode, connected, and transmitting respectively. The RN42 also carried the benefits of FCC compliance and Bluetooth SIG certification. Additionally, this module featured multiple stack supports which include GAP, SDP, RFCOMM, L2CAP, SPP, HID, and DUN. One drawback about this module though was the Bluetooth version support. Specifically, the RN42 supports 2.1 while the most current Bluetooth technology is version 4.1.

The second module observed was the popular HC-05. There was a lot of flexibility as far as sources with this module since it is a generic design, yet the one compared was supplied by Itead. The footprint of the module itself was a little bit larger than the first coming in a size of 2.7 x 1.3 x 0.8 cm. In contrast, the price was about half the price at around \$8. The draw for the HC-05 was low at a max consumption of 30-40 mA and only 8 mA once paired. Furthermore, pin count was not an issue with the HC-05 as it only contains 6 pins of which only 4 are critical. The low pin count and ability to set the master and slave on these modules provide flexibility to the design of the two units in terms of selection of components that may require more pins and which unit provides control for the pairing. Similar to the RN42, this module lacked in the area of the Bluetooth support as it is limited to the older 2.0 version.

The final module considered is the most powerful of the lineup which is the SaBLE-x from LSR. Coming in a small form factor of 11.6 x 17.9 x 2.4 mm and only \$16.52 per unit, this module packs a powerful punch. Specifically, unlike the other two modules considered, which were dedicated Bluetooth modules, the SaBLE-x expands on this by providing the ability to be used as a dedicated Bluetooth module as well as function as the microcontroller with its ARM Cortex processor, FLASH, SRAM, and onboard crystals. To add to this, the SaBLE-x module featured the newest Bluetooth technology with version 4.1 support and version 4.2 capabilities. Being a Bluetooth Low Energy device, this module was able to carry powerful hardware at no cost to power consumption as exemplified with draws of 8.4 mA in transmit mode, 7.4 mA in receive mode, and 1 μ A in standby mode. Prototype testing of the design is also a breeze with this module with the availability of a development board. An additional benefit of the SaBLE-x was its FCC, REACH, and RoHS compliance.

The decision between all Bluetooth modules was a tough one as all the modules are relatively in the same range in terms of price, operating range, and size. The most significant differences were the features. After gathering the advantages and disadvantages of each module, it was determined the HC-05 was the best fit for this application. The reasons for this being it contained sufficiently low power consumption which is crucial for the helmet unit, was half the price of both its competitors, and pin count remained the lowest of all units at only 6 pins for the HC-05. Its lack of newer Bluetooth technology is disappointing with support for the aged version 2.0; yet, this is overlooked by its advantages and the fact it will only be paired to another HC-05 module in this application rather than a phone or tablet.

3.6 Battery Research

When considering the battery needs for this design, it was immediately obvious that lithium ion technology was to be used. This technology is most common today in powering small electronics due to their small size and the low self-

discharge they have. Since the design is to be placed on a motorcycle helmet it was important to have the battery be small in size and have a good recharge rate, both of which are featured heavily in lithium ion technology. In addition, it was important to make sure that these batteries are appropriate when using solar power to charge. However, before a decision could be reached, a more in depth analysis into lithium ion batteries (Li-ion) and lithium polymer batteries (LiPo) was necessary.

3.6.1 Lithium Ion Batteries

Extremely common in the market right now, Li-ion batteries are good way to power small electronics. They have a high energy density and a low self-discharge rate, which makes them a good choice for the purposes of this design. However, these batteries can become volatile, catch fire, or even explode if the charge exceeds what the battery is rated for. Since the battery is to be mounted on the helmet, it is paramount that it be as safe as possible for the rider using the system.

3.6.2 Lithium Polymer Batteries

Lithium polymer batteries are quite similar to lithium ion batteries. In fact, they are almost exactly the same. However, lithium polymer batteries are considered safer than their more volatile counterparts. Whereas, lithium ion batteries are saturated with electrolytes to aid with the creation of ions, lithium polymer batteries use a dry polymer electrolyte. Hence, the risk of electrolyte leakage and the risk of explosion are significantly reduced. Furthermore, due to the polymer technology they are much easier to manipulate into different shapes and sizes; this is significant since the battery must fit on the helmet system. A couple of drawbacks for this type of battery are that it has a lower energy density than the traditional lithium ion batteries and that they are more expensive.

3.6.3 Battery Selection

After considering the aforementioned attributes, it was decided that the lithium polymer battery would be best suited for the purposes of this design. Its versatile shape and reduced risk of explosion make ideal to be placed on a motorcycle helmet that is to be worn by a rider. The chosen battery is a 3.7V 2000 mAh lithium polymer battery sold by SparkFun. At 0.25 x 2.1 x 2.4 inches, this battery would be easy to place on the helmet and would not take up a lot of the already restricted space. Another point of interest is the weight of the battery. Because the battery will be placed on the helmet module, it should be as light as possible. If the battery is too heavy it will make the system uncomfortable for the user. Based off of calculations made regarding the power consumption of the modules on the helmet system, the necessary voltage for this battery was determined. The battery chosen provides sufficient power for the microcontroller, screen, and

modules that make up the helmet system. The specifications of this battery are summarized in Table 7 below.

Table 7: Battery Specifications

Item	Value
Nominal Capacity	2000 mAh
Nominal Voltage	3.7 V
Weight	37 g
Cell Voltage	3.7-3.9 V
Discharge cutoff Voltage	2.75V
Impedance	< 300 mOhms
Dimensions	0.25" X 2.1" x 2.4"

3.7 Energy Harvesting System

A primary part of the power system for Head On is the use of solar cells. However, in order to safely harvest the solar energy created by the solar cells, an energy harvesting system must be incorporated into the design. The general energy harvesting system, shown in Figure 16, was used as a basis for the harvesting system of Head On. It will be modified as necessary in order to adapt to this system. For instance, while this figure does display the use of a temperature sensor, this is not included in the Head On design. Therefore, this portion of the design will be removed. Furthermore, a lithium polymer battery will be used rather than a lithium polymer battery. Additionally, other modules such as the display, electronic compass, and real time clock will be included. Because the solar panels will only be used to power the helmet system, only the modules on the helmet system must be considered. However, there are some aspects in this general design which will remain the same. For instance, the Head On system will incorporate a wireless communication module so that the MCUs can transmit and receive data.

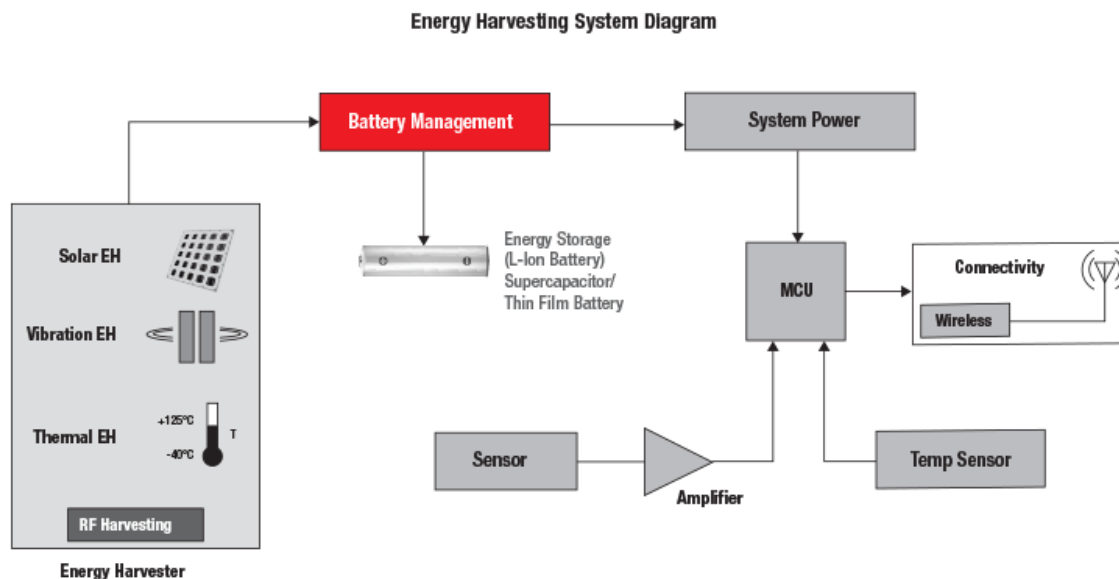


Figure 16: General Energy Harvesting System
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Once energy is extracted from the solar panels, it will be converted into electric power so that it can be used by the system. However, this brings up the concern of overcharging the lithium polymer batteries. In order to ease this concern, a few options for battery management were explored.

3.7.1 SparkFun Sunny Buddy - MPPT Solar Panel

Since the battery chosen for this design is sold by SparkFun, a quick inquiry into whether it is appropriate for charging with power harvested from solar panels was necessary. SparkFun's customer support responded in the affirmative and suggested the use of the Sunny Buddy to aid with the charging of the lithium polymer battery selected. Sunny Buddy is a maximum power point tracking solar charger, specifically designed to charge a single cell lithium polymer battery. Part of the power system for Head On will include a lithium polymer battery, so this module was a definite contender to incorporate in the design. This product, which is sold by SparkFun, is meant to have a maximum charge current of 450 mA, a maximum input voltage of 20V, and a minimum input voltage of 6V. It comes with a pre-installed barrel connector and a 2 pin JST connector. The typical design using the LT3652 for a 2A single cell lithium polymer battery is shown below in Figure 17. Since this design will use a 2A single cell lithium polymer battery, this typical design for the Sunny Buddy would be very close to the actual design. However, a few changes would still need to be made in order to apply the design to this system. For example, since the minimum input voltage for the LT3652 chip the Sunny Buddy uses is higher than the output voltage of the panels being utilized, a boost would need to be given to the output voltage in order for the design to work properly. This can be done in one of two ways. One option is to change the solar panels currently chosen for the design to ones with sufficiently

higher output voltages. The alternative is to modify the typical design of Sunny Buddy's LT3652 charger, shown in Figure 17. By adding a boost converter at the output of the solar panels and before the input of the Sunny Buddy, the appropriate voltage could be reached. At which point the actual components of the Sunny Buddy typical design should work properly, but more testing would be needed to be sure.

Another alternative would be to switch out the chip used by the Sunny Buddy. The LTC3105, which is manufactured by Linear Technology like the LT3652, is similar and has a minimum input voltage of 250 mV. This would fit the design better, but would basically mean getting rid of the Sunny Buddy as a whole.

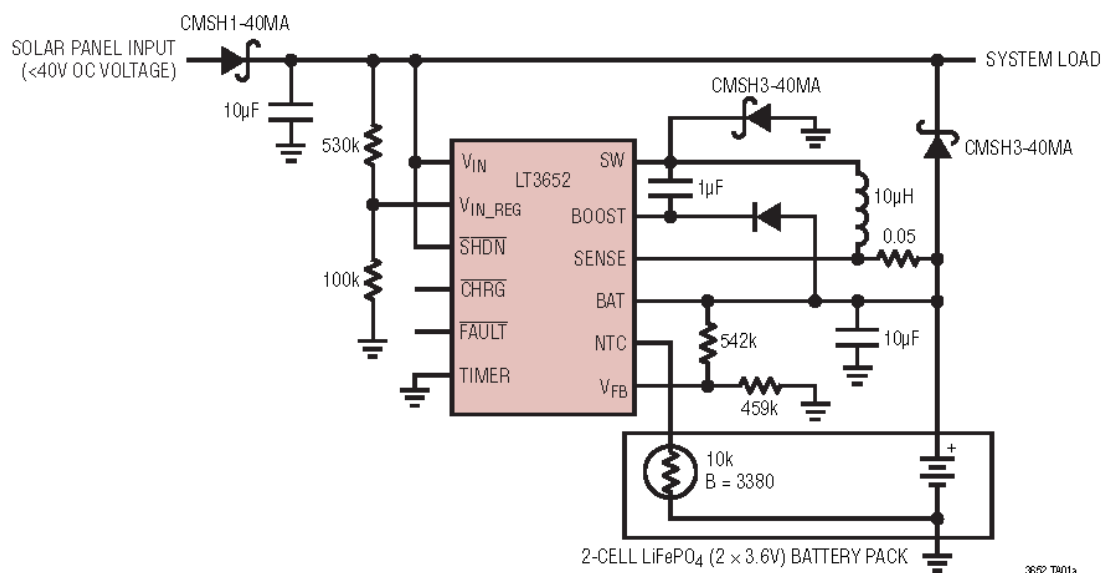


Figure 17: LT3652 Typical Design

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The pin configuration of Sunny Buddy is illustrated in Figure 18. At a measly 3mm x 3mm, the Sunny Buddy chip would fit very easily into the design of Head On. Due to the low pin count, only twelve pins, and the extremely small size of the chip, finding a place on the system for the chip will be relatively easy, thus allowing more focus to be put on placing the other modules of the system.

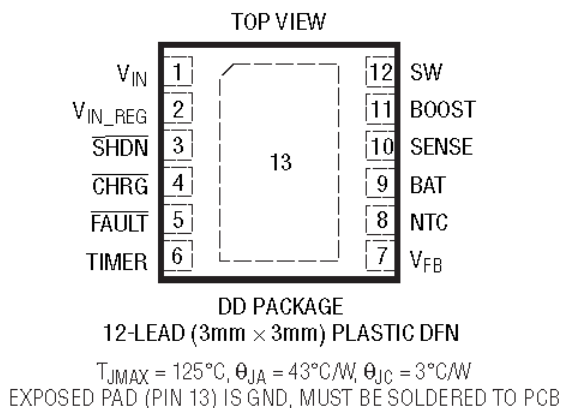


Figure 18: LT3652 Pin Configuration

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3.7.2 Texas Instruments bq25570 Nano Power Converter

This device, which is manufactured by Texas Instruments, is designed to harvest power from sources, such as solar cells, and manage it in order to avoid overcharging a rechargeable battery. It contains a secondary power rail for other networks that might require the harvested power. One of the main factors that led to the consideration of this module is that it boasts a small footprint, which is an important constraint in this design. The BQ25570 is packaged into a 3.5-mm x 3.5-mm package and could readily be placed along with the rest of the system. As shown in Figure 19 the BQ25570 RGR package has only 20 pins. Both the size of the module and the number of pins are greater than Sunny Buddy. Of these pins, the input voltage for the VIN_DC, VOC_SAMP, VREF_SAMP, VBAT_OV, VRDIV, OK_HYST, OK_PROG, VBAT_OK, VBAT, VSTOR, LBOOST, EN, VOUT_EN, VOUT_SET, LBUCK, and VOUT pins ranges from -0.3V to 5.5V. The maximum input power is 510 mW.

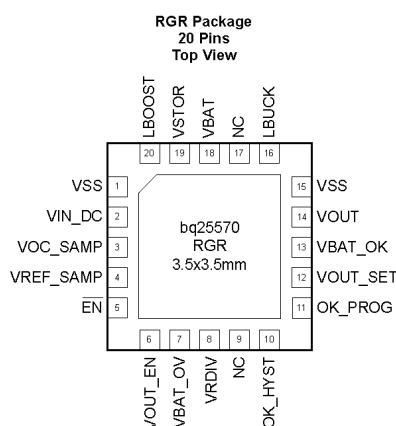


Figure 19: RGR Package 20 Pins Top View
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A typical design application for the BQ25570 can be below in Figure 20. This design will be modified slightly in order to produce the desired output in the Head On system. For example, one of the modifications will be on the host pins. Since this project does not require the BQ25570 or its output to have the ability to turn off, the host control pins can be hardwired in their on state. In addition, another possible modification will involve the input filtering. Since the solar panels' supply voltage is very close to the required output voltage, this input filtering may need to be modified in order to compensate for input voltage fluctuations. The design would be kept almost identical to the layout in Figure 20.

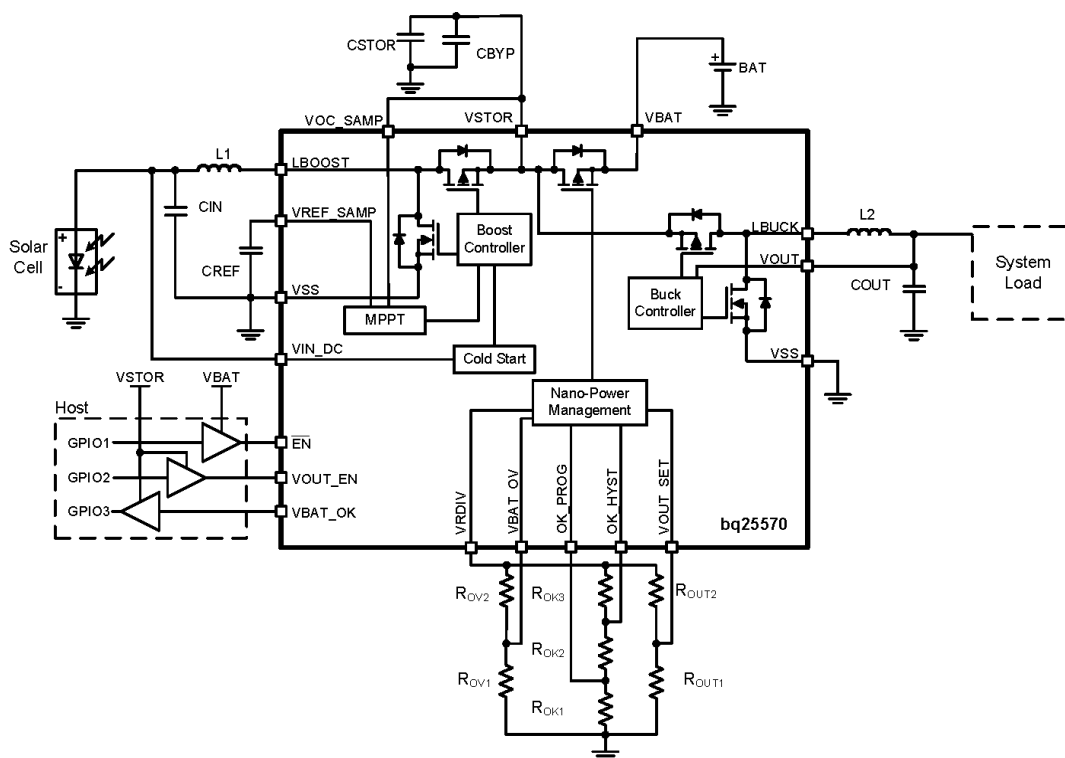


Figure 20: Typical Design for Solar Applications
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3.7.3 Texas Instruments BQ25505 Ultra-Low Power Boost Converter & TPS62737 Buck Converter

The BQ25505, which is manufactured by Texas Instruments, is also designed to harvest power from sources, such as solar cells, and manage it in order to avoid overcharging a rechargeable battery. The TPS62737, which is also manufactured by Texas Instruments, is a simple buck converter. As can be seen in Figure 21 the typical design for the BQ25505 includes the TPS62737 buck converter and this would be the design followed. The boost converter handles both the solar

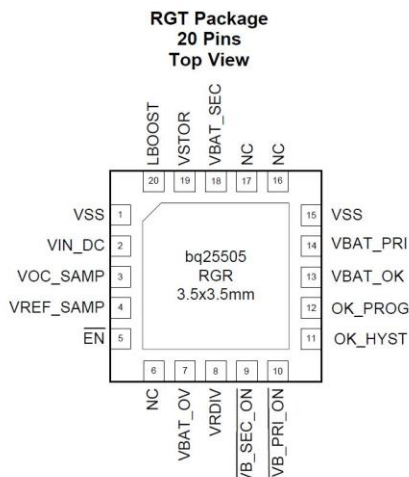


Figure 22: RGT Package 20 Pins Top View
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3.7.4 Energy Harvesting System Selection

After some consideration, the BQ25570 Nano Power Boost Charger and Buck Converter was deemed to be most appropriate for the design. As noted above, the Sunny Buddy has a minimum input voltage of 6V and the chip the Sunny Buddy utilizes, the LT3652, has a minimum operating voltage of 4.95V. The output voltage of the panels that will be used is 4.8V. For this reason the Sunny Buddy was considered unsuitable for this project, unless the components were changed to accommodate the lower input voltage. Furthermore, the BQ25570 allows more control over the design and the handling of the harvested power, whereas the Sunny Buddy only has the input port for the panel output and the barrel connector for the battery to be connected to. Finally, the BQ25570 has the secondary power rail for the components to be connected to and the primary for the battery, thus making it the most suitable choice for this system.

However, after the initial testing it was found out the maximum current output of the BQ25570 is 100mA. Since this design requires 180mA it was clear a different option was needed. The BQ25505 boost converter and TPS62737 buck converter combination was selected because it fit the input voltage and output current requirements. Furthermore, it included the battery protection with the added feature of thermal shutdown protection.

3.8 Solar Panel Research

Due to the size and shape constraints inherent in designing a motorcycle helmet system, the most important aspect when searching for the solar panels was that they be flexible and easily molded in order conform to curves and grooves of an average motorcycle helmet. This is a major concern as there are several motorcycle helmet standards in place which require any additions to helmets to

be no more than a few millimeters above the helmet. Furthermore, the panels must be thin and lightweight since the user will be directly affected by any increase in weight of the helmet. After researching the available products, two companies rose as front runners; both PowerFilm Solar and Solbian specialize in flexible solar panels that can be purchased and integrated by anyone. Geared towards personal use atop cars, recreational vehicles, or boats the flexibility and versatility are a top priority for the products these companies offer. However, after further inspection, it became clear that PowerFilm Solar simply had a greater variety of panels to choose from; thus, increasing the likelihood of finding a panel that would suit the specific needs of this design. In addition, due to the design constraints of this project, mainly the size and shape of the helmet, Solbian was deemed unsuitable. The products offered by Solbian were simply too big to be properly placed on the helmet. Consequently, it was several PowerFilm products which were considered before the final selection was made.

3.8.1 R7 7 Watt Rollable Solar Panel

The first solar panel considered was the 7 watt rollable solar panel. Advertised as a good solution for powering electronics on a boat, it is weather resistant, extremely flexible, and easy to use. These characteristics are particularly important for the Head On system. The curvature of the helmet is fairly large so this would require the panels to have a greater flexibility in order to follow this curvature. Furthermore, the head on system will be used outdoors, and is therefore exposed to various weather conditions. Finally, because the solar panels are only one of many components in the Head On design, they must not be too complex; this project has a very specific deadline which must be met so an exorbitant amount of time cannot be dedicated to just this one feature. Another feature to note for this solar panel is that it comes with a female car charger adapter, so it simply needs to be rolled out and plugged into anything, from a battery to an electronic device.

Table 8 summarizes the specifications of this particular panel as detailed by the PowerFilm website. The operating voltage, current, and power all are sufficient for the Head On system. The surface area, though large, would fit the helmet as long as the panel is significantly flexible. As a result of this larger size, the weight is also a bit of a concern. Although it is only slightly more than half a pound, this solar panel will be placed on the helmet so ideally the weight should be as small as possible.

Table 8: R7 Rollable Solar Panel Specs

Operating Voltage	15.4 V
Power	7 Watts
Current	0.45 Amps
Width	368.3 mm (14.5 in)
Length (unrolled)	584.2 mm (23 in)
Weight	0.269 kg (0.594 lbs)

3.8.2 MPT6-75

The MPT6-75 is part of PowerFilm Solar's OEM series. The OEM series, which is specifically geared towards versatility, has several different panels that could be used for the Head On design. The MPT6-75 is the panel in this series with the highest voltage and current output while still being small enough in size to be accommodated on the motorcycle helmet. However, since each panel is putting out only 50 mA there would need to be several of them connected in order to meet the current requirements of the system as a whole. The size of the MPT6-75 would mean that not all parts of the panel will be receiving full amounts of sunlight since they would begin to curve into the sides of the motorcycle helmet. The specs for the MPT6-75 are summarized in Table 9.

Table 9: MPT6-75 Specs

Operating Voltage	6 V
Wattage	.3 W
Current	50 mA
Typ Voc	8 V
Typ Isc	65 mA
Typ Output at AM 1.5	55 mA at 6 V
Length	114 mm (4.49 in)
Width	73 mm (2.87 in)
Weight	2.3 g (.08 oz)
Total Thickness	0.22 mm

One of the most significant specifications to consider is the size. There is a very limited surface area on the helmet that is exposed to sunlight. Figure 23 illustrates the diminished size of the MPT6-75.

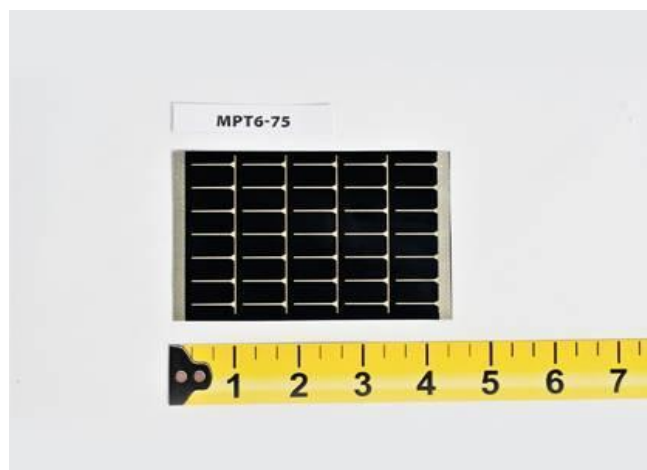


Figure 23: MPT6-75
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3.8.3 MPT4.8-150

This small panel is part of the OEM series of the PowerFilm Solar products. As shown in Figure 24, it is much smaller in size, and therefore increasing its versatility. It can be connected with other products from this series in order to achieve a higher output voltage or output current. The smaller size also would allow for the panels to be placed in different configurations on the helmet in order to more easily achieve the desired output. However, one area of concern for this panel is that it does not have a UV stabilized surface so it would either need to be changed out after a year, or a request would need to be made to the company to manufacture a panel with the same output and size, but with a UV stabilized surface.



Figure 24: MPT4.8-150
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Table 10 below identifies the specs for this particular OEM solar panel. If several panels were used, the operating voltage, wattage, and current would be sufficient for the system. Additionally, because of its smaller size, the flexibility of the panel would not have to be as great, and the panel would most likely fit more closely. Finally, another point of interest for this panel is its thickness. Due to standards in motorcycle helmet designs, all components of the system must be as thin as possible so that they do not protrude too much from the helmet. At only 0.22mm, the MPT 4.8-150 is in accordance with these standards and would hardly protrude from the helmet.

Table 10: MPT 4.8-150 Specs

Operating Voltage	4.8 V
Wattage	0.48 W
Current	100 mA
Typ Voc	6.4 V
Typ Isc	130 mA
Typ Output (at AM 1.5)	110 mA at 4.8V
Width	146 mm (5.75 in)
Length (unrolled)	94 mm (3.7 in)
Weight	3.9 g (1 oz)
Total thickness	0.22 mm

3.8.4 MPT4.8-75

The MPT4.8-75 is another panel from the OEM series of the PowerFilm Solar products. Table 11 summarizes some of the important specifications for this product as shown on the PowerFilm Solar website. It is even smaller than the MPT4.8-150, which makes it even easier to place on the helmet. However, as a result, the current output is half of that of the MPT 4.8-150. This would mean that even more solar panels would be necessary to produce the required current output. This could be a concern because not all areas of the helmet will have enough exposure to the sun, and depending on the amount of solar panels needed, they may not all be able to fit on the top of the helmet.

Table 11: MPT 4.8-75 Specs

Operating Voltage	4.8 V
Wattage	0.225 W
Current	50 mA
Typ Voc	6.4 V
Typ Isc	65 mA
Typ Output (at AM 1.5)	55 mA at 4.8 V
Width	73 mm (2.87 in)
Length (unrolled)	94 mm (3.7 in)
Weight	1.9 g (0.07 oz)
Total thickness	0.22 mm

Once again, with the use of several of these solar panels, the operating voltage, wattage, and current necessary could be achieved. The length, width, and weight of this panel are the smallest of all the panels under consideration. Consequently, allowing for more freedom when placing the panels. This compact length of the panel is demonstrated in Figure 25. Finally, the last specification to consider is the total thickness. Just like the MPT4.8-150, the thickness of this panel is 0.22mm, which follows the standards for external attachments for motorcycle helmets.

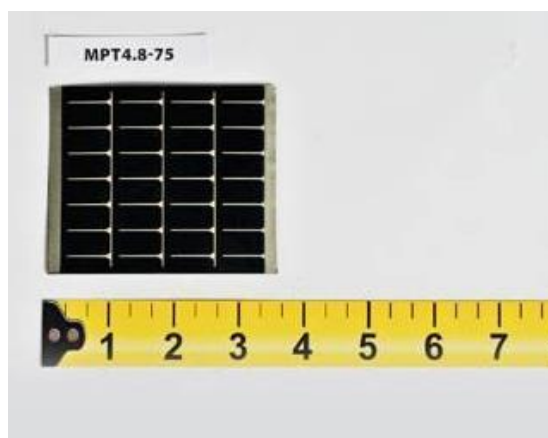


Figure 25: MPT4.8-75
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3.8.5 Solar Panel Selection

After giving consideration to the above stated facts, as well as the low power consumption of the electronics on the helmet, the MPT4.8-75 was chosen for the design. Its small size will make it easier to place on the helmet while providing the necessary power output needed for the design. The MPT6-75 has the same current output as the MPT4.8-75, but has a bigger output voltage. Since the chosen components do not require such a high voltage in order to operate, the MPT4.8-75 is better suited to fit the size constraints. Furthermore, this selection will help keep the overall cost down. The MPT4.8-75 can be found on Amazon.com in a pack of ten for \$30. Hence, the versatility, efficiency, and overall cost effectiveness of the MPT4.8-75 makes it the best choice for this design.

3.9 Step-Down (Buck) Converter

Power for the bike module will be fed from the motorcycle's electrical system. The motorcycle provides a nominal 12V supply which must be stepped down significantly without creating overheating issues. Hence, it was clear from the beginning that some sort of buck converter would be necessary in order to ensure all the components received the appropriate voltage with minimal heat generation. The power available is well beyond the needs of module making the voltage regulator selection much less critical so they were not researched in depth.

The family of buck converters offered by Texas Instruments was looked at first. The TPS5490, TPS5491, and TPS5492 are all buck converters offered by TI with very similar characteristics. In fact, the main difference between the three is the maximum output voltage. The TPS5490 has a maximum output voltage of 16.2V, the TPS5491 has a maximum output voltage of 15.3V, and the TPS5492 has a maximum output voltage of 14V. Since the desired output voltages will be 3.3V and 5V it is unnecessary to have a higher output voltage from the buck converter. Therefore, from the TI family of buck converters the best choice would be the TPS5492.

Similar products to the TI buck converters are the LTC3622 by Linear Technology and the BD93291EFJ by Rohm Semiconductor. The maximum output voltage for the LTC3622 is the input voltage and the maximum output voltage for the BD93291EFJ is 5V. Therefore, it is clear the TI products have a bigger range, which makes them more desirable. Furthermore, the TI products have resources available that aid in design, such as the Eagle Cad files and samples of the chips which can be requested. For these reasons, the TPS5492 was chosen as the buck converter for the bike module.

3.10 Real Time Clock (RTC)

One of the features of the Head On system is to provide the current time on the display. Processors have an internal clock that can be adjusted whenever connected to computer as it has access to the system's clock. This internal time clock resets itself whenever powered off, thus a solution was needed to ensure accurate time was displayed upon every use of the Head On system. A solution was found in the form of a Real Time Clock which will be used to maintain accurate time for the MCU while the system is powered off. This will enable the MCU to display the correct time to the user upon start up. While there is a wide range of RTCs available most have many more features than required for this application. The parameters of interest are an accurate time of day, low power consumption, battery backup capable, small footprint, and ease of interface. These parameters were examined in detail for the DS3231, DP8573A, and the BQ32000 real time clocks.

3.10.1 DS3231 RTC

The DS3231, manufactured by Dallas Semiconductor, is a popular device used in several off the shelf RTC modules designed to plug into common MCU platforms. It utilizes an internal Temperature Controlled Crystal Oscillator (TCXO) to maintain a clock accuracy of +/- 2 minutes per year. An internal register is available to compensate for drift due to the aging of the oscillator. The clock time is selectable in either 24-hour or 12-hour AM/PM format. For the purpose of this project, the 12-hour AM/PM feature would be used, but the 24-hour form could be used in future upgrades where the user chooses the mode of clock he or she would like to use. The device can operate on a supply voltage of 3.3V; drawing 110 uA in standby mode and 200uA in active mode. It is equipped with direct connection for a backup battery. Although several of the connections are not used, it is offered only in a 16 pin surface mount package. The device is capable of connecting to a variety of MCUs using a 400 kHz I²C serial interface.

3.10.2 DP8573A RTC

The DP8573A by National Semiconductor is also designed for microprocessor designs where accurate time and date are required. There is not a time keeping accuracy given for this RTC as it is dependent on the external crystal and loading capacitor used. An accuracy of +/-10 minutes per year is generally achieved by these systems when properly tuned. It requires a 4.5V supply voltage and draws approximately 140 uA when active and 3.3V at 12uA in standby. There is a direct connection for battery power and internal detection and switching is provided in order to prevent power interruptions. It is available in either a dual inline 24 pin package or a 26 pin plastic chip carrier. The larger footprint of this device is to accommodate address and data lines as it does not support the I²C protocol.

3.10.3 BQ32000 RTC

Finally, the last real time clock considered is the BQ32000. The BQ32000 RTC from Texas Instruments is marketed as a replacement for many commonly used RTCs. Similar to the DP8573A, the accuracy of this RTC is also dependent on accuracy of external components. An accuracy of better than +/-10 minutes per year can be achieved with proper component selection. The device uses a 3.3V supply voltage drawing 100uA when in active mode but as little as 2V at 1.2uA in standby. In addition to a direct connection for battery operation it can provide a trickle charge to the backup battery while being powered by the primary supply. This allows for the use of a rechargeable battery or supercapacitor eliminating the need for user battery replacement. The device comes in an 8 pin dual inline package and all connections are required for operation. Communication with the MCU is requires only 3 pins using a 400 kHz I²C Serial Interface.

3.10.4 Real Time Clock Selection

The RTC, while essential to system operation, is not a primary module and should be as simple as possible to implement. I²C serial interface on the DS3231 and BQ32000 is a much more efficient method of transmitting data than the data bus of the DP8573A. It is faster, uses fewer connections, and can be read easily by the Atmega328 MCU. Due to the I²C interface both the DS3231 and BQ32000 have smaller footprints. While the BQ32000 is half the size of the DS3231 it also requires additional external components negating its size advantage. The external crystal and load capacitors are critical to the operation and accuracy of the BQ32000. They must be carefully selected and tuned to achieve a desirable accuracy. The oscillator design is very sensitive to lead length, trace size, and connection quality making implementation more time consuming. In addition the crystal is external to the oscillator making it very sensitive to temperature changes. As the final system will be operated outdoors temperature extremes can be expected. The DS3231 eliminates both the problematic implementation and the temperature sensitivity by utilizing a completely onboard TCXO as shown in Figure 26. Additionally, the DS3231 supports both 24-hour and 12-hour time. This reduces the number of calculations that will have to be made by the software. At the moment, the design for the user interface incorporates the 12-hour clock; however, in the future this dual time format could be made an option for the user to customize the system. The efficient MCU interface, the modest device footprint, and the onboard oscillator of the DS3231 make it the best choice for this application.

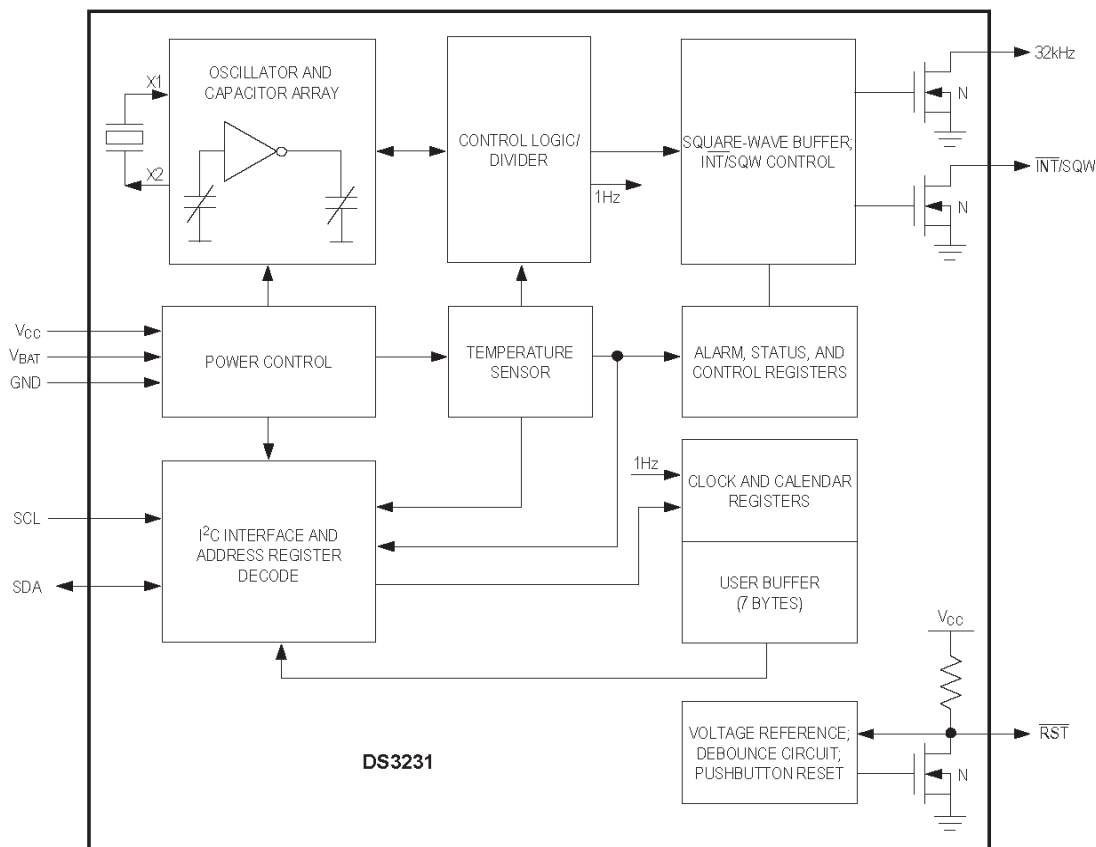


Figure 26: DS3231 RTC Internal Schematic

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3.11 Electronic Compass

Directional information can be provided by the GPS module but that information can become invalid when the rider is stopped or changes direction in a narrow radius. In order to provide the rider with accurate compass heading information and electronic compass module was incorporated into the design. The compass was installed in the helmet module to reduce the data transmitted over the wireless connection and to correlate the compass heading to the rider's line of sight versus the position of the bike. Since the rider's head changes in elevation as well as azimuth during use the system must be able to sense both changes in orientation to provide an accurate heading. In order to achieve this only 3-axis magnetometers which also incorporated a 3-axis accelerometers were reviewed for this application. The sensors that were considered were the FXOS8700CQ, MC6450, and the LSM303D.

3.11.1 FXOS8700CQ 6-Axis Sensor

The FXOS8700CQ 6-Axis Sensor with Integrated Linear Accelerometer and Magnetometer manufactured by Freescale Semiconductor is designed for use in personal navigation devices and unmanned aerial vehicles. It is produced in a 16

pin QFN package and operates over a wide temperature range. The accelerometer measures along three axis and has three selectable ranges from +/-2g to +/-8g. The magnetometer also measure in three axes with a measurement range of +/-1200 uT with a sensitivity of 0.1uT. Both sensors have a selectable output data rate from 1.563Hz 800Hz available for I²C or point to point serial interface The data rate is limited to 400 Hz when interlacing the data from both sensors in hybrid mode. It requires a 2.5V supply but the current consumption varies significantly depending on the measurement mode and output data rate. The maximum current draw of any configuration is 1072uA. However for this application the sensor would most likely be operated in hybrid mode and draw a current of 183uA.

3.11.2 MC6450 6-Axis eCompass

The MC6450 6-axis electronic compass from mCube is also a combined 3-axis accelerometer and 3-axis magnetometer geared toward portable navigation applications. Both sensors and an I²C serial interface are combined in a 16 pin LGA package. The accelerometer has a single measurement range of +/-8g. The magnetometer measures +/- 2400 uT with a sensitivity of 0.15uT. The sample rate of both sensors is programmable from 0.5Hz to 100Hz and the data output is available at up to 400kHz over the I²C serial connection. The sensor uses a nominal 2.8V supply and draws 3uA in standby and between 60uA and 2500 uA depending on the output data rate.

3.11.3 LSM303D eCompass Module

The LSM303D Ultra-compact high-performance eCompass module by STMicroelectronics is another integrated 3-axis accelerometer and 3-axis magnetometer. It is designed for use in tilt-compensated compasses as well as several other position and rotation detection applications. In addition to the accelerometer and magnetometer the LGA-16 package also houses an embedded temperature sensor and a SPI/I²C serial interface with a FIFO data buffer. The accelerometer has five measurement ranges from +/-2g to +/-16g full scale. There four available ranges on the magnetometer from +/-200uT to 1200uT with a sensitivity of 0.008uT to 0.479uT depending on the range selected. The output from all the sensors is accessible via either an I²C or SPI serial interface. The built in FIFO buffer is intended to reduce power consumption. By having the sensor data ready for transmission it eliminates the need for the MCU to constantly poll the sensor for data. The sensor operates on a 2.5V supply drawing 1uA in standby and 300uA during normal operation.

3.11.4 Electronic Compass Selection

All the sensors researched had very similar specifications and operating requirements. The ranges and sensitivities of each were more than adequate to

provide an eight point compass heading. Each also provided an I²C serial interface making programming simpler and to maintain consistent communication protocols across the system. The two main features that make the LSM303D the best choice are the FIFO data buffer and the consistent power draw. The buffer eliminates the need for choosing between output data rate and power consumption. While the power consumption of the LSM303D is not the lowest possible of the three devices it does provide the greatest access to sensor data for the current required.

3.12 Global Positioning System (GPS)

Several options were considered for acquiring speed and heading information for display to the user. The primary methods to measure speed were using the motorcycle speed sensor, a radar based system, or the Global Positioning System. Reading the speed directly from the motorcycle would be complicated and very invasive procedure most likely requiring professional installation. In addition speed measurement devices vary between vehicles requiring different signal processing based on the motorcycle used. While a RADAR system would provide a consistent speed signal it would also require an additional sensor unit on the front of the motorcycle increasing the complexity of the system and make installation more cumbersome. In addition, neither of these options provides heading information. It was found that GPS modules about the size of a quarter were available which provided both accurate speed and heading information. Furthermore they could be incorporated directly into the circuit board design making them an ideal choice for this application. Three devices were reviewed for their suitability; the PA6C, LS20032, and the GP-735.

3.12.1 PA6C LadyBird-3 GPS Module

The PA6C LadyBird-3 manufactured by GlobalTop Technology has a 66 channel receiver. It provides a position accuracy of 2.5 meters and a velocity accuracy of 0.05 meters per second. The module typically takes 33 seconds to acquire data from a cold start and 1 second when a backup battery is used to enable a hot start. The PA6C also has a built in antenna and a 9600 baud rate for serial data transfer. In addition to transmitting data in real time it has an onboard data logging feature that can up to two days of continuous data. The device operates on a 3.0V to 4.3V supply and draws a max current of 25mA during satellite acquisition but only 20mA while tracking. It has an automatic power saving mode that can reduce the current draw to as low as 180 uA by using an algorithm to balance tracking accuracy and power consumption based on motion. The entire device is housed in a 16mm surface mount package.

3.12.2 LS20032 GPS Smart Antenna Module

The LS20032 GPS Smart Antenna Module from LOCOSYS Technology is very similar to the PA6C. It also uses a 66 channel receiver to achieve a 2.5 meter position accuracy. The cold start acquisition time is typically 32 seconds while the hot start time is one second using the built in micro-battery. It has up to a 10 Hz refresh rate and transmits data over a 9600 baud serial connection. The data logger function stores GPS data in internal flash memory however the datasheet does not give any indication of how much storage is available. The module operates on a nominal 5V supply and draws 19mA during normal operation. The package is a bit bulky measuring 30mm x 30mm with components mounted to the underside preventing a flush mounting to the board.

3.12.3 GP-735 Smart Antenna Module

The final GPS unit was the GP-735 GPS Smart Antenna Module produced by ADH Technology. It uses a 56 channel receiver to track its position within 2.5 meters. In addition to tracking positions, it also provides velocity with speed accuracy better than 0.1 meter per second and heading error of less than 0.5 degrees. The rated accuracies are achieved after 29 seconds from a cold start. From a hot start using the onboard battery backup accurate data can be read after only 1 second. The device has a built in patch antenna but has connections for an external antenna if desired. The output data rates of 1Hz and 10Hz using the USB interface and up to 9600 bps over the serial interface. The power consumption during continuous tracking is only 37mA and operates on a 3.1V to 5.5V supply. The size of the device is quite large at 35mm x 8mm x 5.2mm including the connecting jack at one end.

3.12.4 GPS Module Selection

All of the GPS modules reviewed were very similar in accuracy and data transfer rates. The GP-735 had a slightly faster cold start time than the other models but the highest power consumption of the three. Its footprint was also bulky due to its overall size and large connector. The PA6C and the LS20032 were almost identical in all their features and specifications except power consumption and size. The PA6C draws slightly more current during normal operation but also operates at a lower voltage resulting in about 16mW lower power use than the LS20032. The LS20032 is almost twice the size of the PA6C and has components on the bottom side of the module that would make mounting difficult. In contrast the PA6C will surface mount to the main board providing stable physical and electrical connections. For these reasons the PA6C LadyBird-3 is the better choice for this application.

4.0 Block diagrams

In order to demonstrate how the hardware of the helmet and motorcycle modules interacts with each other, block diagrams were created. In addition, block diagrams were also created for the software aspects of the two modules. These diagrams explain how the software communicates with the hardware, analyzes the data received, and outputs the results.

4.1 Helmet module hardware

Figure 27 below summarizes how the hardware components in the helmet module interact. The solar panel and battery both are regulated by the power controller. This power is then used by the microcontroller in this module. The microcontroller will receive data from the motorcycle system using wireless communication, as well as the accelerometer and real time clock modules located on the helmet system. This data will then be sent to the display. Using wireless communication, the microcontroller on the motorcycle system communicates the data gathered from the sensors to the microcontroller on the helmet module. Based on the data the microcontroller receives, the information is then displayed on the screen.

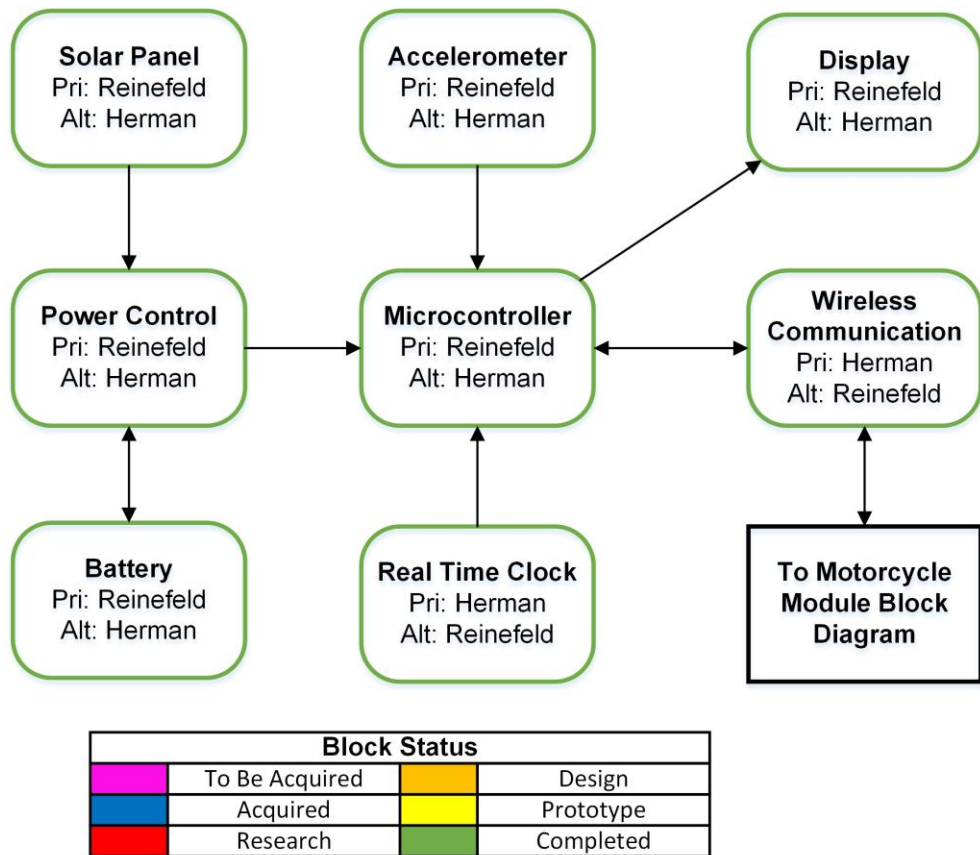


Figure 27: Block Diagram of Helmet Module Hardware

4.2 Motorcycle Module Hardware

Figure 28 below summarizes how the hardware components of the motorcycle module interact with each other. The power regulator will be used to send the appropriate amount of power from the power system to the microcontroller. This microcontroller will communicate with the left, right, and rear sensors in order to detect objects. Additionally, the microcontroller will receive data from the GPS and electronic compass modules. Once all the data is collected, it will be transmitted to the microcontroller on the helmet system using wireless communication.

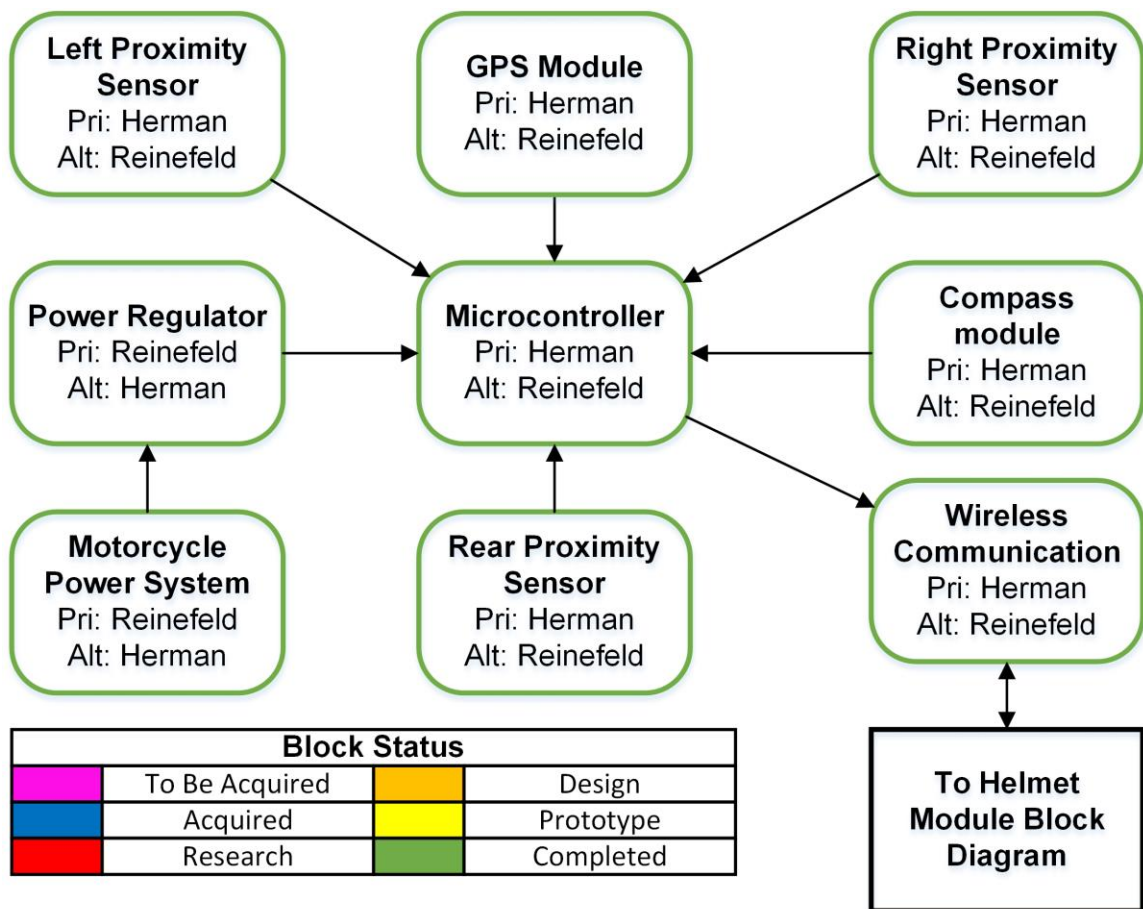


Figure 28: Block Diagram of Motorcycle Module Hardware

4.3 Helmet Module Software

Figure 29 below illustrates the software components of the helmet module. Using wireless communication, the microcontroller on the helmet module will receive the data that was collected by the motorcycle system. In addition, data from the real time clock module and the accelerometer located on the helmet system will also be gathered. Based on this data, the appropriate functions will be called to format the display. Finally, the display will be updated with the new data.

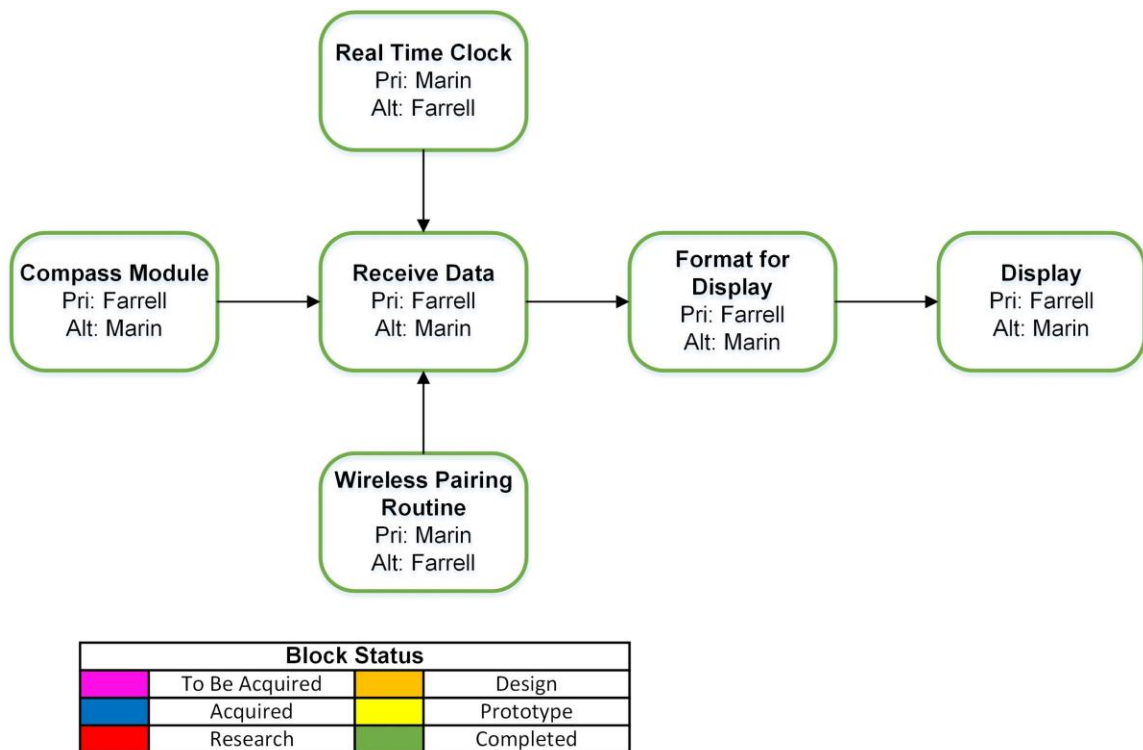


Figure 29: Block Diagram of Helmet Module Software

4.4 Motorcycle Module Software

Figure 30 below illustrates the software components of the motorcycle module. A cycle will be created in order to prioritize the signals and timing for the gathering of data from the modules. The GPS module will be used to gather the speed and cardinal direction of the rider. Next, the sensor inputs will be gathered one at a time. Once this is complete, the system will determine if it needs to use the compass module to find the cardinal direction. If the rider was not moving when the GPS module was analyzed, then a valid cardinal direction would not have been received. In this case, the compass module would be used to find this value. After receiving all the data, the values will be compared to the threshold values in order to determine if there was a change and if so what that change was. Appropriate indicator signal values were then calculated. Finally, the data will be transmitted, using wireless communication, to the helmet system.

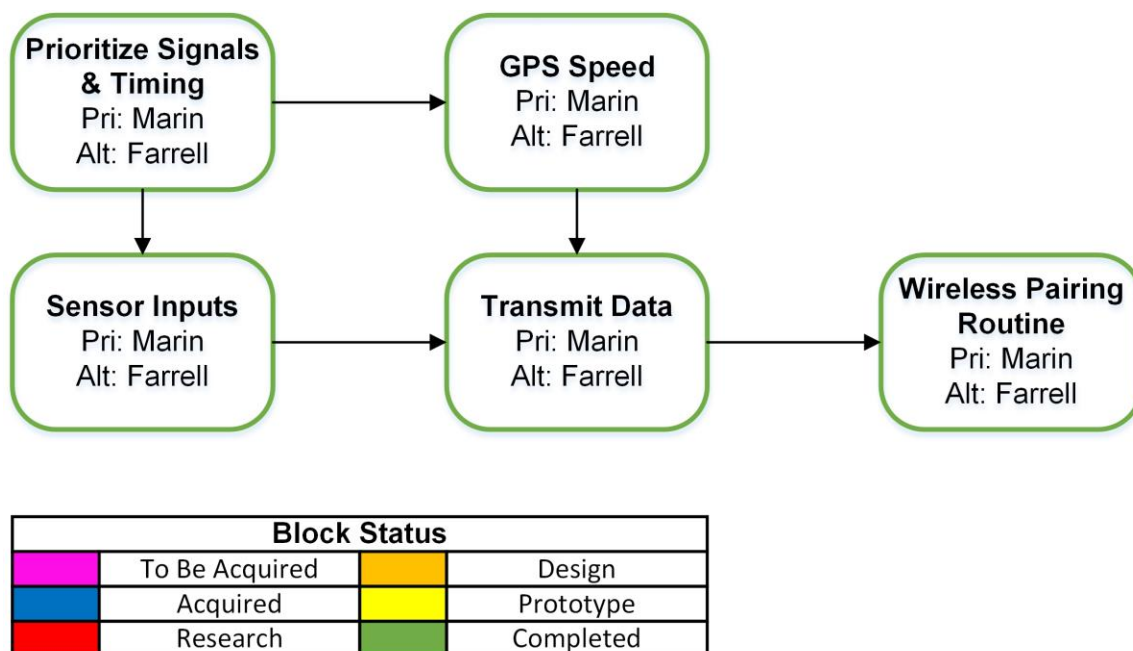


Figure 30: Block Diagram of Motorcycle Module Software

5.0 Related Standards

When designing the system, it was critical to take into consideration relevant constraints that would impact the system. These constraints not only impact the goals, requirements, and specification of the project, but also determine what features of the design are not feasible. The major constraints that are focused on in this project are the constraints impacting the design of the helmet and road standards.

5.1 Department of Transportation Helmet Safety Standards

Because half of the system will be placed on the motorcycle helmet, it is critical that it does not go against any standards for helmet design. There are two main groups who develop standards for motorcycle helmet design. The first of these organizations is the Department of Transportation. Specifically, the standard in consideration is the Federal Motor Vehicle Safety Standard No. 218 (49 CFR Sec. 571.218). In S5.4, it is explained that the rider must have a 105° field of view on either side of the mid-sagittal plane. As shown in Figure 31, this plane, which is also called the longitudinal plane, is located in the center of the helmet. This standard will impact the placement of the LCD display.

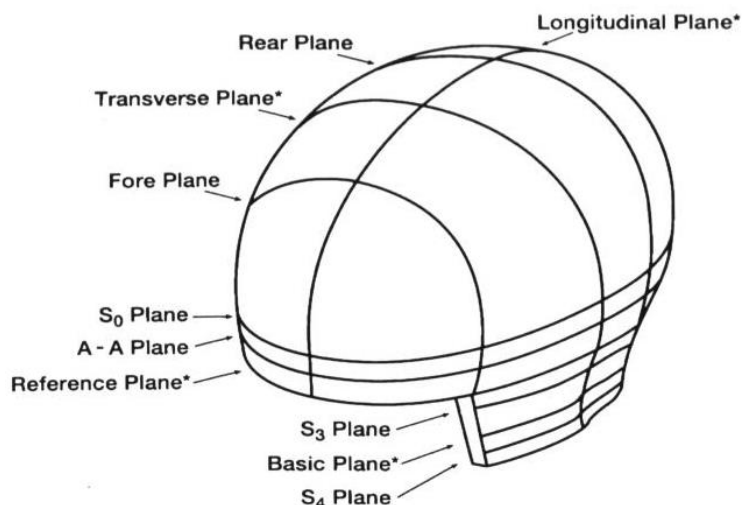


Figure 31: Motorcycle Helmet Layout
Reprinted with Permission from The Snell Memorial Foundation

Additionally, Standard No. 218 section 5.5 describes the standards for projections inside and outside of the helmet. The PCB board and its attached modules can be considered as a projection. This standard explains that if the motorcycle helmet includes a projection on the outside, it must be a portion of an accessory that is necessary. In this case, the Head On system is the accessory, and the PCB board on the helmet is a portion of the system that is absolutely necessary. Without this PCB board, the entire Head On system is redundant as it is the MCU on this board that processes all of the data and causes the results to be displayed on the screen. This PCB board must also not protrude more than 5mm from the helmet in order to follow this standard. Furthermore, the solar panels must also be flexible enough to mold to the helmet as flat as possible so that they meet the 5mm requirement.

5.2 Snell Memorial Foundation Helmet Safety Standards

The second organization that creates motorcycle helmet standards is the Snell Memorial Foundation. According to the M2015 Helmet Standard developed by the Snell Memorial Foundation, if anything is added to the helmet and it is greater than 7 mm, it must be removable. In the case for this project, the PCB and modules that are going to be attached to the helmet must be removable, as well as the display that is placed in front of the helmet. The solar panels on the other hand, will be less than 7mm so they will not have to be removable. However, the standard states that any addition to the outside of the helmet that is less than 7mm must fit the helmet smoothly in order to reduce the amount of friction it produces. Therefore, it is imperative that the solar panels are extremely flexible so that they can mold to the curvature of the helmet. Additionally, the Snell Memorial Foundation also has helmet standards regarding the peripheral vision of the rider. The rider must have the ability to see 210° horizontally, 7° up, and

30° downward. This particular standard will impact the placement and size of the display.

5.3 AASHTO Standard Road Widths

The American Association of State Highway and Transportation Officials determines the minimum width for traffic lanes in the US. This standard is relevant to this project because in order to be successful, the system must be able to detect vehicles that are in adjacent lanes. Different types of roads have different standard widths; therefore, for the purpose of this project the maximum road width will be taken into consideration. Single lane ramps, whose width is significantly larger than other roadways, will not be taken into consideration since there will not be other vehicles adjacent to the rider; for all other roadways, the maximum width is twelve feet. Therefore, when choosing the proximity sensor, this maximum value will be taken into account.

6.0 Design Constraints

When designing Head On, it was important to take into considerations the constraints that would impact the project. Time, funding, and resources were three of the major constraints for this project. In addition, standards, such as helmet safety standards also impacted the design. These constraints impacted what would and would not be feasible. After identifying and analyzing them, certain features from the initial design were discarded entirely from the design, while others became stretch goals.

6.1 Economic Constraints

When designing the Head On system, the costs of the parts and manufacturing had to be taken into consideration. An estimated budget for the prototype and final product was determined. Once it was determined what funding the project would receive, the budget was re-analyzed in order to ensure that the project remains in budget. This constraint resulted in some of the parts being removed and others changed. Many similar products that are already out in the market are quite expensive. As a result, it is important that Head On is more economical. Consequently, a balance had to be found between cost and accuracy of parts.

6.2 Time Constraints

Since Head On must be completed in only two semesters, time was a major constraint of this project. Numerous features could be added to this project if time were not an issue. However, a working prototype must be built and programmed in only two semesters; as a result, the list of features to be included had to be narrowed down to the most important ones. Those features that did not make the cut then became stretch goals that would be implemented if sufficient time

remains at the end of Senior Design II. It is imperative that adequate time is allocated after the final prototype is created, in order to allow for testing of the system. Based on the results of the system, some problems with the design may be discovered and changes may have to be made.

6.3 Health and Safety Constraints

One of the goals of Head On is to increase the safety of the rider. As a result, it is imperative that no part of the system poses any safety concerns for the rider. One area of concern is the field of view of the user. Because the display of the system will be mounted outside of the helmet, it must be positioned in such a way that it does not become an obstruction. The size of the screen must also be limited in order to ensure that it does not block the user's view. There are several standards that dictate how motorcycle helmets must be designed. This includes specifications on attachments to the helmet. It was important to design the helmet with these constraints in mind. Additionally, the power system was an area of concern, especially the portions of the system that are on the helmet. Batteries have the potential to become volatile, catch fire, or explode; therefore, it is imperative that the battery chosen has the lowest possible chance of injuring the rider in these or any other ways.

6.4 Manufacturability Constraints

When creating the system, the design had to be feasible. This includes the creation of the components, such as the PCB, as well as the assembling of the final prototype. The design of the PCB must be realistic so that it can be printed. In addition, because the resources that are available to this group are limited, the prototype must not require equipment that the group does not have at their disposal.

6.5 Sustainability Constraints

Because the parts of the Head On system components will be exposed, environmental factors play a major role in the sustainability of the system. All of the components of the system must be able to function in a variety of weather conditions including rain, snow, and wind. For example, in the case of rain and snow, the modules themselves must either be waterproof or must be put into a waterproof casing in order to ensure that they remain functional. In addition, the components must not extend too far from the motorcycle and helmet or else the force from the wind could damage them. Finally, the lifespan of all of the components must be similar in order to ensure that the device does not fail due to one part. Ideally, the parts should have a lifespan equal to that of a typical motorcycle helmet, five years.

6.6 Environmental Constraints

For this project, one of the major focuses is the use of renewable energy in the form of solar panels. Therefore, the success of this system is partially impacted by the availability of sunlight. Solar panels must be placed on the helmet in locations that will optimize their efficiency and exposure to light. In the chance that sun is unavailable, an alternative energy source must be used. While the functionality of Head On is impacted by the environment, its creation and use does not directly impact the environment in any significant way.

6.7 Social Constraints

The Head On system must be designed in a way that it can be used on a variety of helmet and motorcycle sizes so that it can be available to all motorcycle riders. For example, the display must have the ability to attach to any motorcycle helmet.

6.8 Political Constraints

There were no political constraints that impacted the design of the Head On system.

6.9 Ethical Constraints

The motivation for creating Head On is to benefit riders who use it. Therefore, it is important to consider the health and safety of those who use the system. Additionally, no components of the system must use patented designs without appropriate permission. This includes both the hardware and software components.

6.10 Legality Constraints

Head On does not have any legality constraints.

7.0 Project Designs

Upon completion of the research phase of this project, the design phase began. This phase consisted of two parts: software design and hardware design. Because the hardware and software aspects rely heavily on each other and due to time constraints, these two parts were completed simultaneously. The hardware design was completed using schematic creation software. On the other hand, the software design was done by writing programs on the Arduino IDE and testing them using an Arduino UNO.

7.1 Hardware Design

In order to make the system less cumbersome it was designed as two separate units that are connected via Bluetooth. One module was positioned on the motorcycle; in order to take advantage of the ample space and power available on, this module housed the major functions of the system. Consequently, the other module, which is mounted on the helmet, was restricted to the bare necessities including a self-contained power supply.

7.1.1 Helmet Module

The helmet module consists of four solar cells, power supply, battery, real time clock, microcontroller, Bluetooth module, and an LCD display. All the components except the solar cells and the LCD screen were integrated onto a single board mounted in a housing module at the lower rear of the helmet. The module has a power switch and two buttons for setting the clock time. The solar cells were affixed in an array at the top of the helmet. The screen was mounted to the helmet using commercially available camera mount designed for use on motorcycle helmets.

7.1.1.1 Power System

The power supply of the system, displayed in Figure 32, is integral for the functionality of the Head On system. This system is fed by four MPT4.8-75 solar panels located on the top of the helmet. In order to minimize power fluctuations common in solar powered systems a filter network was used between the solar panel output and the input of the boost charger. Energy harvested from these solar panels is used to recharge the integrated lithium polymer battery, thus extending the operation time of the system. The onboard power is managed by Texas Instruments' BQ25505 Ultra Low-Power Boost Charger With Battery Management and Autonomous Power Multiplexer for Primary Battery in Energy Harvester Applications chip and the TPS62737 Programmable Output Voltage Ultra-Low Power Buck Converter With Up to 50 mA / 200 mA Output Current chip. These devices handle solar power regulation, smart battery charging, and output power regulation. The output voltage and battery charging range are set by three interconnected voltage divider networks. The battery charging output does not require external filtering. The output supply voltage however used a simple inductor and capacitor network to smooth any ripple remaining on the output. Only one control line was connected to pin 6 of the Atmega328 for the battery status indicator. All the functions and outputs were hardwired to provide the required 3.3V supply voltage.

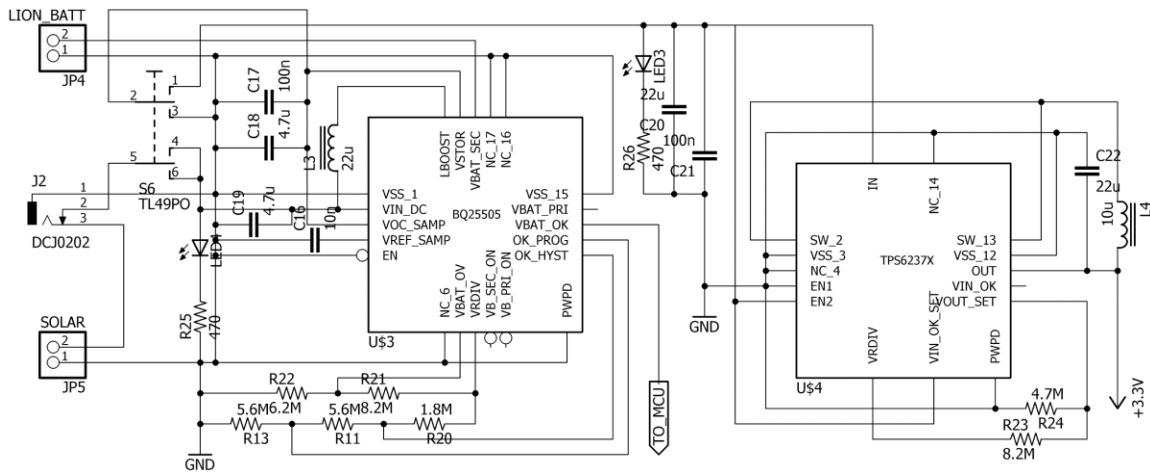


Figure 32: Helmet Module Power Supply Schematic

Due to the current requirements of the different modules going into the system, 100mA, .2mA, and 40mA for the screen, microcontroller, and Bluetooth module respectively, four panels were deemed necessary. The 200mA provided by the four panels will sufficiently cover the requirements of the modules. In order to ensure a maximum output from the solar panels will be achieved, they were placed at the apex of the helmet as shown in Figure 33 and Figure 34. This location will allow the sunlight can hit them more directly. Additionally, it is important to note due to the flexibility of the panels chosen, they were able to mold the curves of the helmet so that they follow the standards for motorcycle helmets.

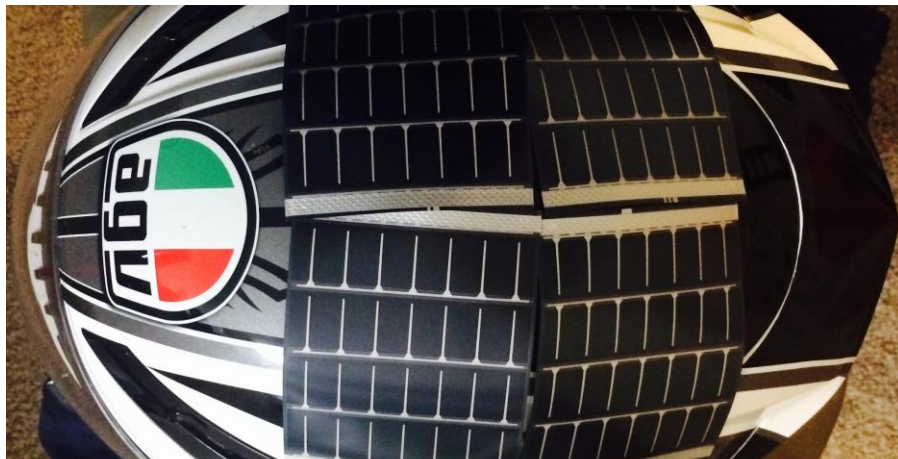


Figure 33: Solar Panel Placement Top View



Figure 34: Solar Panel Placement Side View

7.1.1.2 Control System

The helmet system is controlled by an Atmega328 microcontroller as seen in Figure 35. Its timing is supplied by the 32kHz output from a battery backup real time clock module. The RTC also maintains the display clock time when the system is powered off through the use of a CR2032 watch battery. The controller receives data from the motorcycle module via a HC-05 Bluetooth module connected to a software simulated serial port on pins 12 and 13 of the MCU. This was done to maintain consistency of the wiring and programing between the helmet and motorcycle modules. While the MCU's physical serial port, pins 2 and 3, was available for use on the helmet module, that connection was reserved for the GPS unit on the motorcycle module. The data from the motorcycle module is processed by the MCU and delivered to the screen over a ribbon cable along the outside of the helmet.

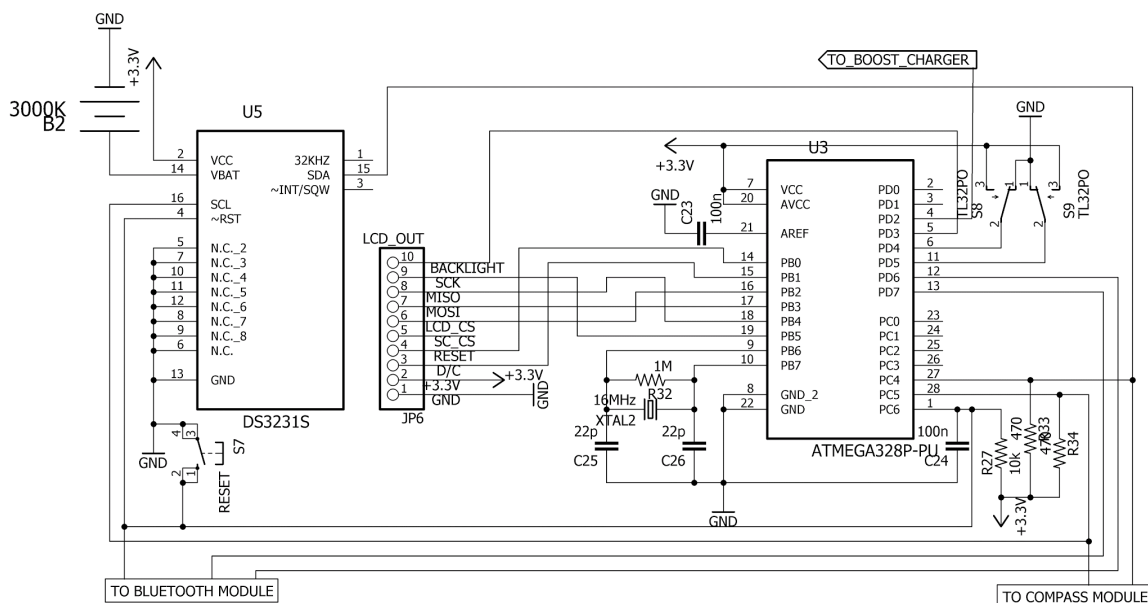


Figure 35: Helmet Module Control System Schematic

7.1.1.3 LCD Screen

The Adafruit 2.2 TFT LCD is mounted outside of the face shield using a modified GoPro helmet mount and connected to the control system via a ribbon cable. The original design mounted the screen inside the helmet however this proved to be problematic for several reasons. The first concern was the minimum focal distance of the user. The internal mounting of the screen would have placed it too close for the user's eyes to focus properly. This would have made the system a burden to use and would have hindered rather than enhanced the user's riding experience. Another concern with placing the screen inside of the helmet was finding a location with sufficient room. There is limited space inside the helmet, which would restrict where the screen could be mounted. The screen also could not obstruct the user's field of view, thus eliminating the majority of the area located directly in front of the user's face. The other major concern was due to the necessity for actual road testing. While the screen could be secured for normal motion, the safety of the rider could not be assured under all conditions. Consequently, it was decided that the best option is to mount the screen outside the helmet. Doing so will increase the focal distance to the screen and allow the safety features of the helmet to protect the user should he or she encounter unforeseen circumstances. There are standards in place which dictate a minimum field of view necessary for helmets. Special care was taken to ensure that these constraints were met. Additionally, this position also allows the reader to easily read the information on the screen.

7.1.1.4 Electronic Compass

The electronic compass module mounts directly to the printed circuit board on the helmet unit. This placement results in a near vertical position of the sensor

7.1.2.1 Power System

Unlike the helmet system, the bike system will not be powered by solar panels. The entire system will be powered by the existing 12V battery on the bike and the power will be managed by the TPS5492 1.5-A/2.5-A Dual, Fully-Synchronous Buck Converter with Integrated MOSFET by Texas Instruments. The input to the TPS5492 will be the 12V from the battery on the bike and in turn it will provide 3.3V to the system. A 5V supply is also built into the design but due to component changes the entire system operated at 3.3V. The 5V supply is not utilized at this time but since it was already designed into the system it was kept as a contingency. In addition during assembly and testing it was discovered the TPS5492 does not operate correctly unless both sides of the converter are populated and powered. The configuration can be further explored by looking at Figure 37.

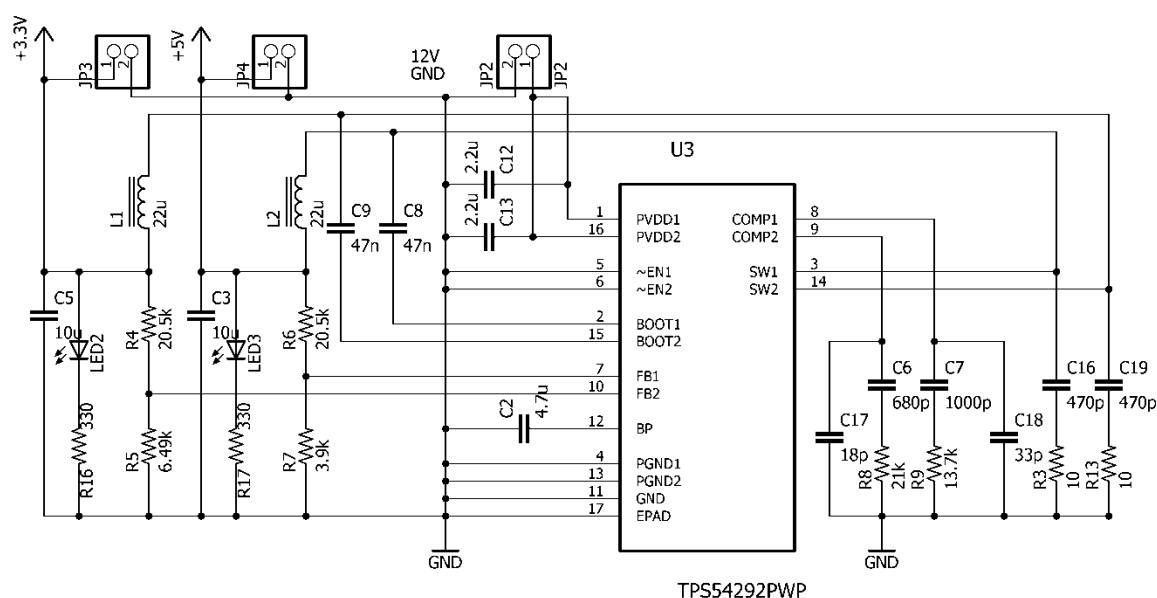


Figure 37: Bike Module Power Supply Schematic

7.1.2.2 Control System

Much like the helmet system, the bike system will be controlled by an Atmega328 microcontroller using a 16MHz crystal oscillator as shown in Figure [insert number here]. The microcontroller will receive data from the three sensors, process it, and then send it to the Bluetooth module for transmitting to the helmet system. The system was designed to make both the analog and pulse width sensor data available to the MCU to allow the data source to be chosen by the programming based on which provided better results during testing. In the end the analog data proved easier to filter to provide stable readings to the MCU. Since the helmet system has a limited power supply and the screen to contend with, it was decided that the microcontroller on the bike would be better suited to interpret the data from the sensors. The microcontroller was connected to the

analog outputs of the sensors via pins 23 through 25 and the pulse width output of the sensors via pins 14 through 19. The trigger for both configurations was sent to pin 26. The GPS was connected to pins 2 and 3; the Bluetooth module via pins 4 and 5. This configuration can be further examined in Figure 38 shown below.

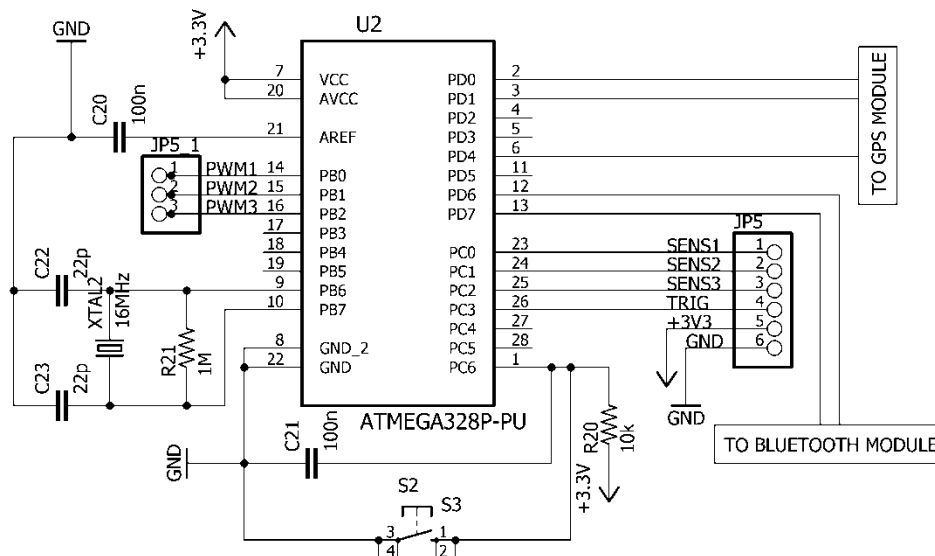


Figure 38: Helmet Module Control System Schematic

7.1.2.3 Global Positioning System

The Global positioning module was incorporated as an autonomous method for the system to provide accurate speed information to the user. The module performs all the necessary GPS functions internally so it requires very few connections to the rest of the system. It provides access to all the collected data via an UART serial interface which was connected to the physical serial port at pins 2 and 3 of the MCU through a dampening resistor on each line. To minimize EMI additional filtering of the input power was provided by a ferrite bead on the input line and two capacitors in parallel to ground minimize EMI.

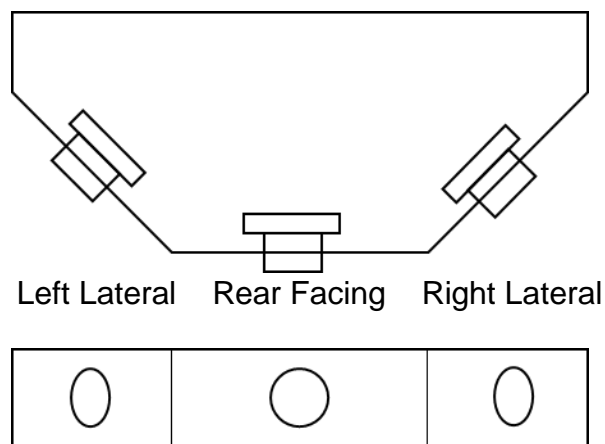


Figure 40: Sensor Placement Representation

7.1.3 Module Housings

The Head On system was designed for use in an outdoor environment which is subject to the elements, temperature extremes, and rough handling. While the prototype housings were not designed to be water resistant, every effort was taken to minimize the impacts of heat and rough handling. The primary focus was to prevent damage and ensure proper operation through the testing and presentation phases of development. Improvements to the modules' housings in order to allow it to survive long term field conditions would need be addressed during design refinement. Clear covers were used in order to allow internal components to be reviewed by project evaluators.

7.1.3.1 Helmet Module Housings

The main circuit board of the helmet module was housed in a generic, rectangular, ABS plastic case. In order to keep the footprint small, the battery was secured under the circuit board using neoprene padding to prevent movement. The case was attached to the back of the helmet with an adhesive to avoid compromising the helmet. The power input from the solar panels was run down the back side of the helmet between the module and the helmet, and fed in through a stress relief grommet at the bottom of the case. A toggle switch and DC power jack were placed through the case on the right side for system power. On the opposite side, two push button switches were installed for setting the clock time and display brightness. No external access to the MCU reset or Bluetooth pairing buttons was provided. The output cable was fed through a stress relief grommet at the bottom side of the case and secured along the lower edge of the helmet. The cable was wrapped around the arm of the GoPro mount to prevent getting caught on the user's hand and to reduce movement during testing. The cable then runs the length of the screen where it was looped back on itself before connecting to the screen to minimize stress on the solder joints due to movement of the screen. This cable was sandwiched carefully between the

screen and its cover. A fabricated cover was used to on the back side of the screen to provide a mounting connection and to protect the cable and connections. A clear acrylic cover was fit over the screen to shield it from damage. A generic case was not used because the size required to fit the screen would have significantly increased the display size, thus reducing the user's visibility. A full custom fit enclosure would have been preferred but the time was not available for design and printing.

7.1.3.2 Bike Module Housing

The unique layout of the sensor units in the bike module prevented the use of a generic case. A custom case designed to accommodate the sensors and the main circuit board was designed and molded from a clear acrylic sheet. An octagonal design was chosen to provide the correct mounting angle for the sensors as well as a symmetrical, aesthetically pleasing design. The acrylic was cut into thin strip. Three evenly spaced holes were then ground for the ultrasonic sensors. Finally the strip was heated and formed around an octagonal wooden fixture and allowed to cool. Flat panels were cut to fit as the cover and base for the module. To avoid the need to use adhesives on the test vehicle, suction cup mounts were designed into the bottom of the housing. No user interface is necessary with this module as it is powered on and off by the motorcycle ignition switch. The only external connection on the case was the two wire power supply lead. The positive lead was to be run to an accessory power receptacle on the fuse box and the negative lead to an appropriate ground.

7.2 Software Design

When designing the software for Head On, the agile method will be used. This method will allow for changes to be made more easily to the design. Because Head On must be created in only two semesters, it is imperative that any changes can be made quickly and easily. As demonstrated in the Figure 41 below, the design of the product can be changed if the testing, coding, or analysis stages make it necessary. Additionally, the code itself can also be changed easily if the results of testing or analysis of requirements determine that there is a need to.

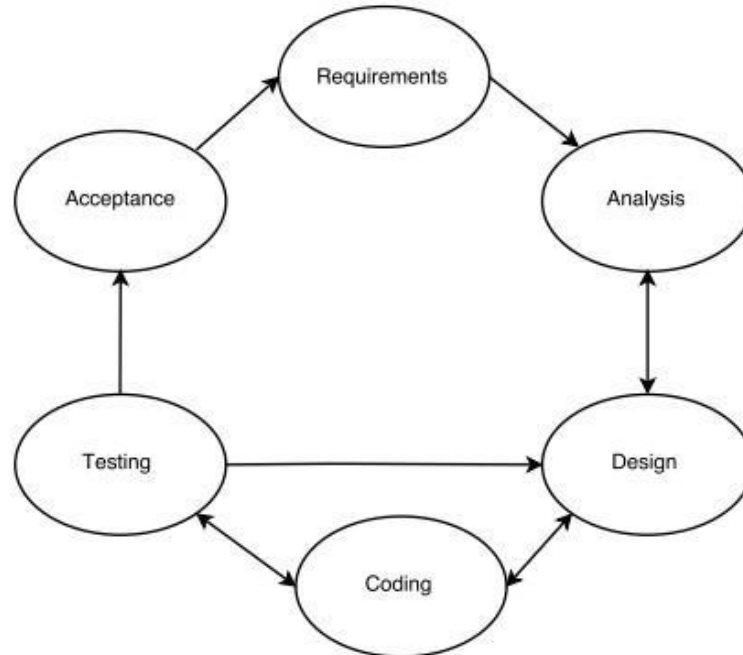


Figure 41: Agile Methodology

The following sections provide both a general and detailed overview of the operation of this system and the interactions of its components.

7.2.1 Helmet System

The modules communicating to the microcontroller in the helmet system include the display, the real time clock, the compass module, and the wireless communication module. While the helmet system does have modules from which it gets data from, the main focus of this system is the analysis of data and the calculation of what changes must occur in the display based on this data. Therefore, since this includes data from the motorcycle and helmet modules, all of these modules will be discussed in the following section.

7.2.1.1 UML Diagrams/Flowcharts

To begin, the MCU on the helmet module must process the sensor data that was transmitted from the MCU on the motorcycle. While the motorcycle unit also transmits the speed gathered from the GPS module, the following flowchart focuses solely on the proximity sensors. Figure 42 gives an overview of the process for updating the proximity indicators on the display based on data received from the sensors. First the data is received from the motorcycle unit in the form of strings. It is parsed in order to determine what sensors the data belongs to. Unlike the other modules whose numerical values are displayed on the screen, the proximity sensor indicators do not actually display a numerical value. Rather, the data from each sensor is compared two two threshold levels in

order to determine what color the indicator bar should be. If the sensor detects an object within 400cm, the object is considered a danger to the user and the corresponding indicator displayed is red. If the object is between 400 and 600 cm, the object is still hazardous to the rider, but does not pose a big of a threat. As a result the indicator displayed will be yellow. Finally, if the object is further than 600cm away, then a white indicator is drawn. This value was chosen because testing revealed that the sensor readings start to become more unreliable after 600 cm.

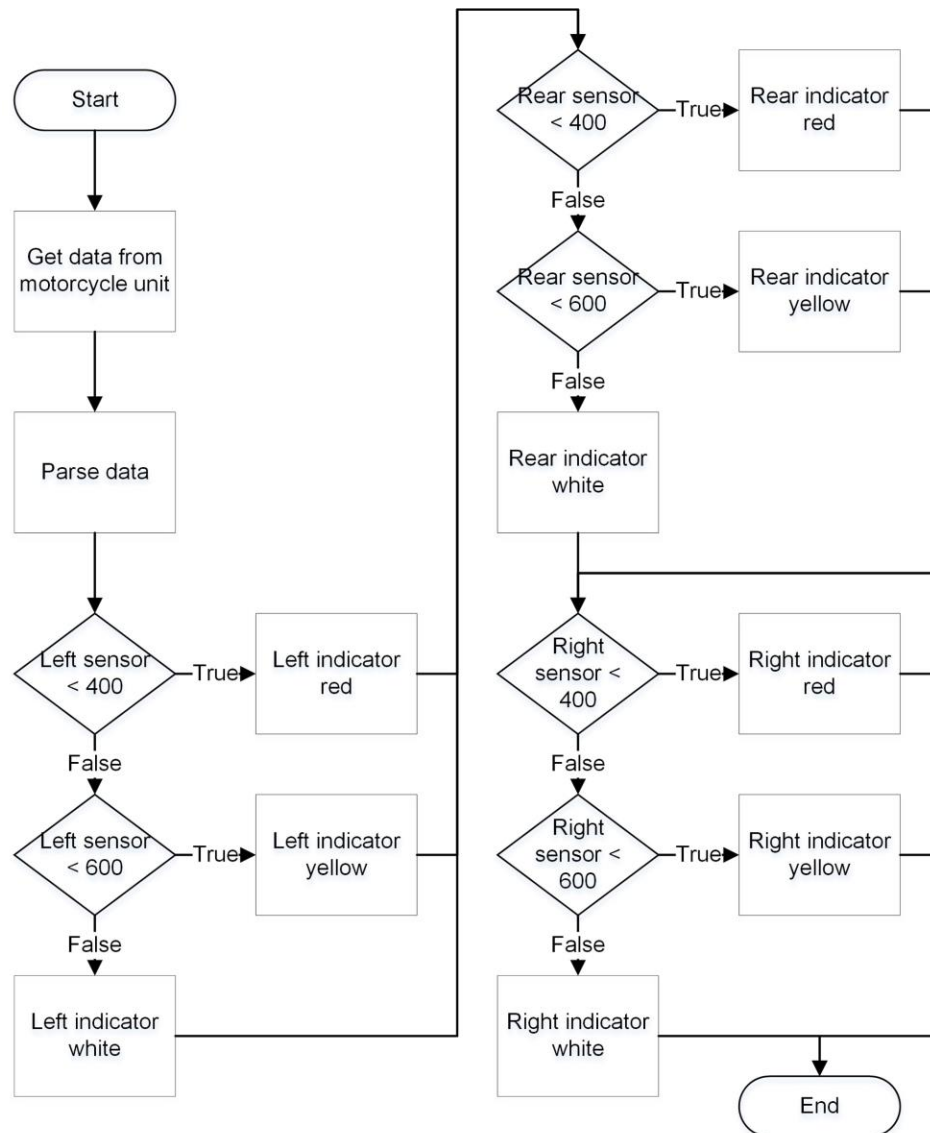


Figure 42: Sensor Analysis Phase

The process for updating the speed indicator, explained in Figure 43, is significantly simpler than the other indicators because it contains only one value and a comparison to a threshold does not need to be made first. The speed will be calculated using the GPS module on the motorcycle system. Once the new speed value is sent to the helmet module, this string is parsed by the helmet unit.

The value is then converted to miles per hour and displayed on the screen. Regardless of whether or not the value changes, the unit portion of the indicator will always remain constant.

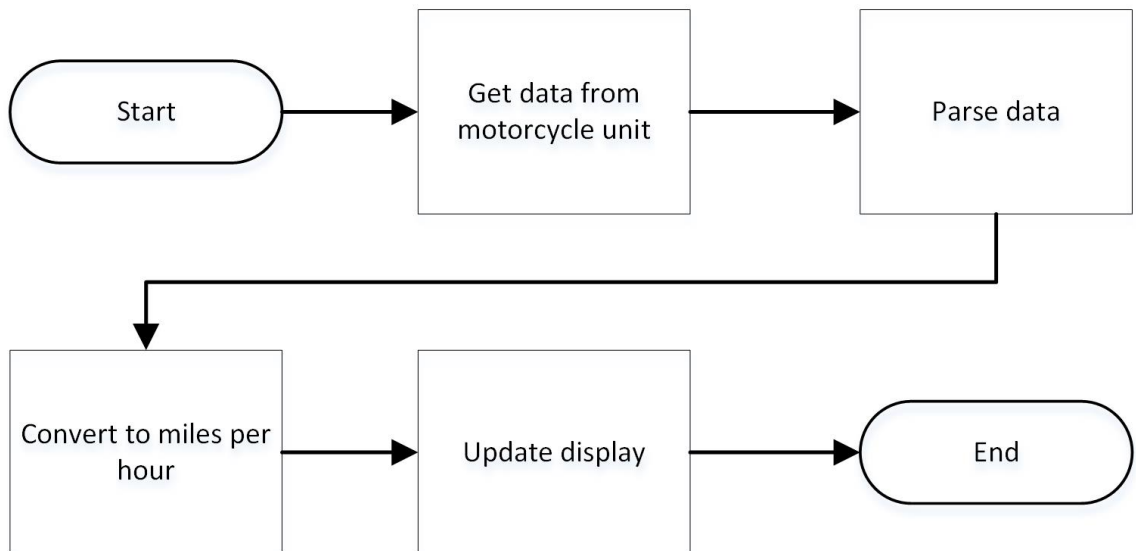


Figure 43: Speed Program

The next software aspect to consider is the compass module, which is located on the helmet unit. One thing to note is that because it is located on the helmet system, the resulting direction will be the direction the rider's head is facing rather than the direction the bike is facing. The compass module was chosen to calculate this data rather than the GPS module because, unlike the GPS module, it can determine the direction even if the user is not moving. As shown in Figure 44, a measurement will be taken by the compass module in order to determine the direction the rider is facing. The Equation 1 below is used to calculate the heading. Because the module is vertical rather than horizontal, the magnetic readings must be taken in the y and z direction, rather than the x and y. Additionally, the results must be converted from radians into degrees.

$$(1) \quad heading = (atan2(event.magnetic.y, -event.magnetic.z) * 180) / Pi$$

Once this calculation is complete, the resulting value must be normalized so that it is between 0 and 360 degrees. A series of comparisons are made in order to determine what range this value falls into. Based on this range, the direction is determined. North the symbol and the text value will then be updated to the display to reflect the changes to the user.

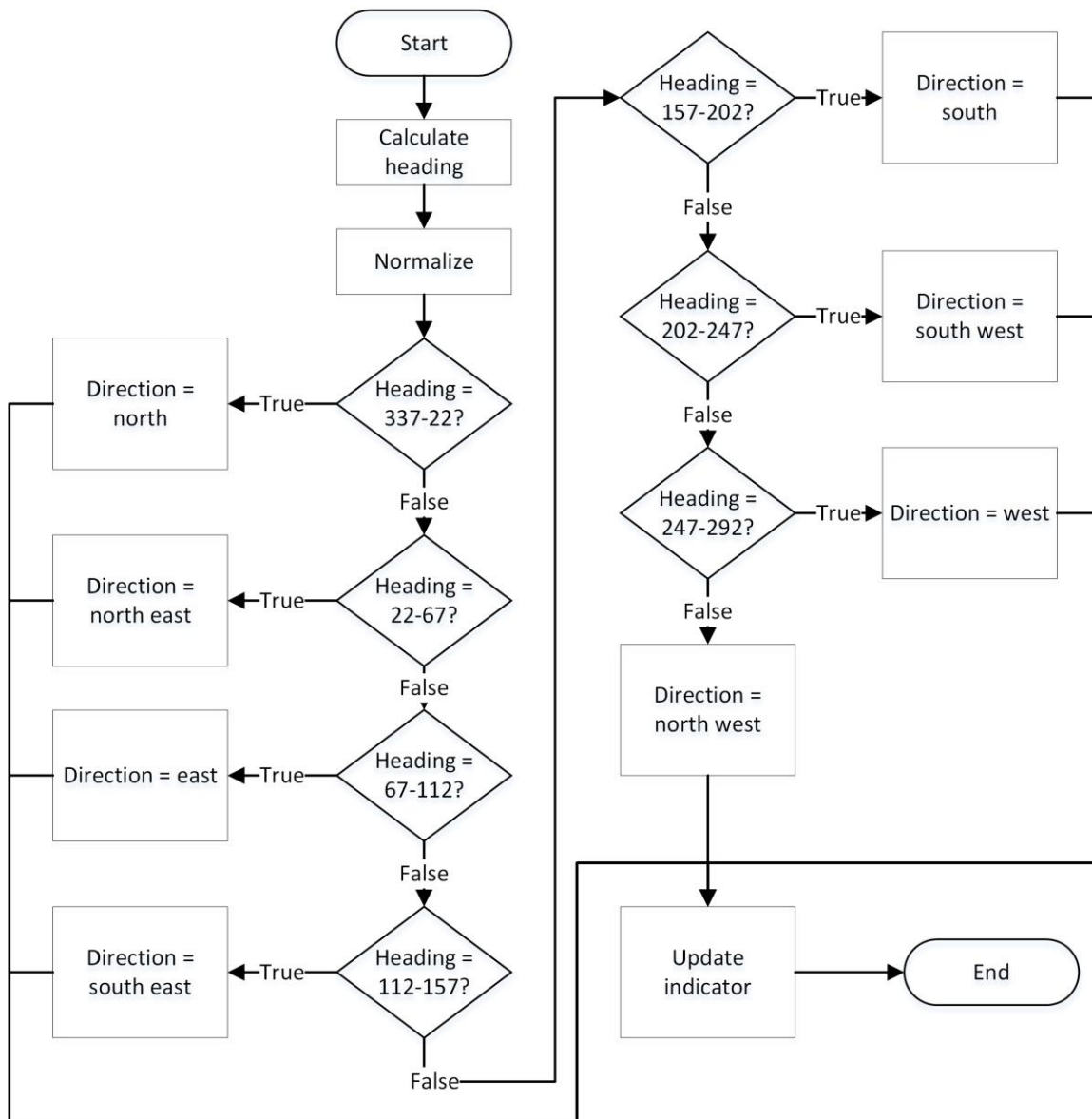


Figure 44: Update GPS Indicator

Finally the last component of the display is the clock. The software process for processing the data from the real time clock module and updating the display is shown below in Figure 45. First the hour and the minute will be retrieved from the real time clock module. The hour is in 24 hour format. As a result, it can be determined if the period is AM or PM. Next, if the hour is greater than 12, it is normalized by subtracting 12. Now the hour value displayed will always be between 1 and 12. Finally, the new time is updated on the screen in the following format: HH:MM AM/PM.

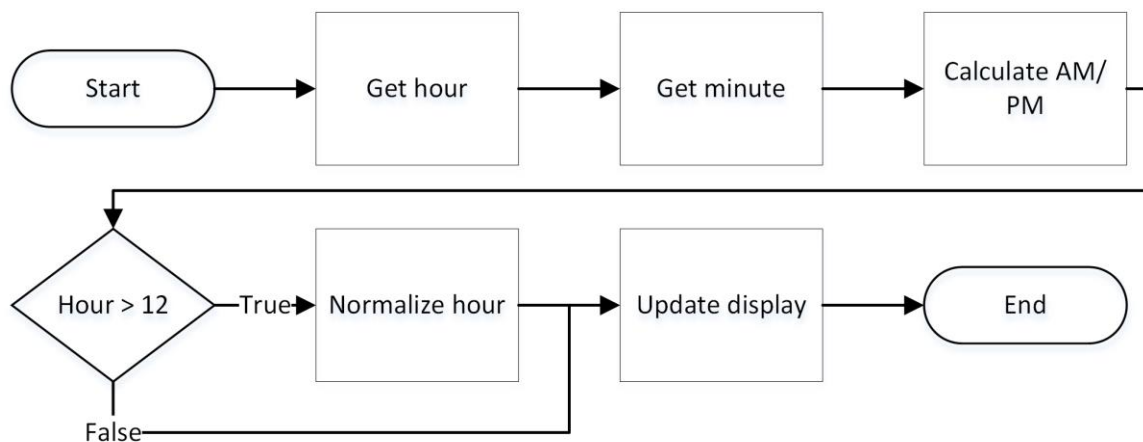


Figure 45: Update Time Indicator

7.2.1.2 GUI Design

When designing the graphical user interface, it was imperative to consider the user experience. The two computer engineering students in this group have taken a course called Human and Technology Interaction. In this class the proper way to design a user interface were analyzed. This design process includes applying the “Eight Golden Rules of Interface Design” as described by Ben Shneiderman and Catherine Plaisant. Figure 46 illustrates the layout of the user interface that was designed after applying each of these rules.

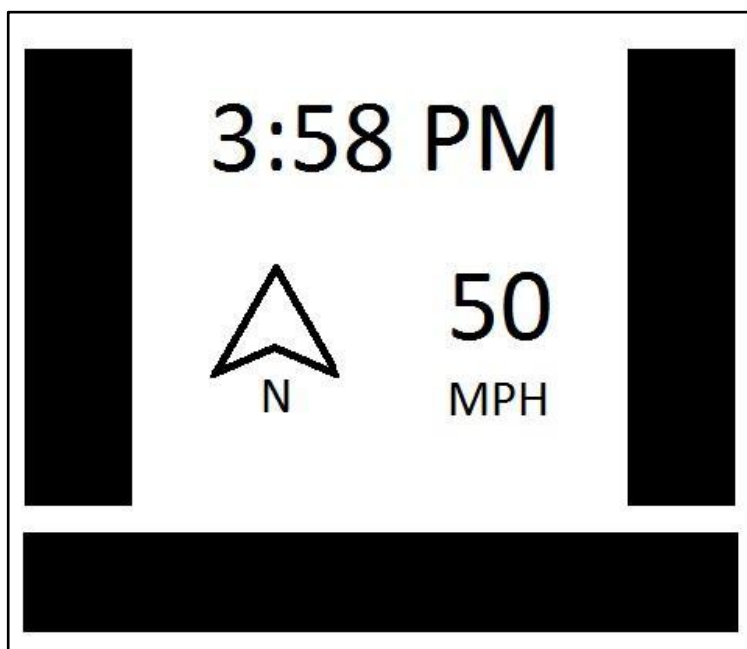


Figure 46: GUI Design

The first rule considered when designing the interface was to strive for consistency. Overall, the user interface is kept consistent by keeping the color

scheme uniform. All symbols and text are displayed in black and the background is kept white. Each time the screen refreshes to display the new values, this color scheme remains the same. Additionally, the font type used is kept the same throughout. Finally, the size is one of two sizes. All components of the time indicator and the numerical portion of the speed indicator are written in a larger font. On the other hand, the units of the speed indicator and the text portion of the cardinal direction indicator are both written in a slightly smaller font.

Next, the user interface must cater to universal usability. This means that the system must be designed in such a way that users with varying skill levels are capable of using it. In order to achieve this, the symbols and layout must be easy to understand and interpret. For the time indicator, the 12-hour clock is used as opposed to the 24-hour clock format because, in general, people are more familiar with this format. Similarly, the speed indicator is displayed in miles per hour because this is the common unit of speed when driving in the United States. The cardinal direction value was chosen to match the values typically used on a compass rose. Additionally, the cardinal direction symbol is designed to look like a simplified compass needle. Finally, since there is no standard symbol for proximity indicators, a simple black rectangle will be used. Three were created in order to correspond to the three sensors on the motorcycle.

The next “Golden Rule” to consider is that the system must offer informative feedback to the user. Aside from turning the system on and off, the user does not directly interact with the system. Therefore, when this rule was applied, more focus was put on giving the user feedback based on the data the system gathers rather than actions of the user. When new data is collected from the modules, the updated information will be displayed on the screen for the user in the form of the proximity, time, cardinal direction, and speed indicators. The sensors and modules on the motorcycle and helmet system will be continuously gathering this data, so the screen will also be continuously refreshing to show the user these changes.

As mentioned previously, the current design for the Head On system does not involve options for user interaction with the user interface. Therefore, the next rule of interface design, designing dialogs to yield closure, is not a concern. The user’s interactions with the screen will be very passive. He or she will merely observe the screen as it updates the values.

Additionally, error handling based on interactions from the user is also unnecessary. One of the original ideas for the Head On system was to incorporate more user interaction through the use of buttons or touch screens. However, this increased user interaction could result in errors. Therefore, by restricting the ways the user can directly interact with the system, errors are prevented.

One of the few ways the user can interact with the system is through the power button. The user can shut off the display along with the rest of the system by

pressing this button. This system and display can easily be turned back on by pressing the power button again. In a similar fashion, the system can also easily reverse actions. The data that is currently displayed on the screen can be removed when new data is gathered by redrawing the appropriate symbols and values. This ability to update the screen is pivotal to the success of the system because new values are constantly being received from the modules, and the associated indicators on the screen must reflect changes.

When designing the system, it was important to ensure that it supports the user's internal locus of control. Once again, the user is not initiating the actions so instead the focus shifted to ensuring that the user does not feel overwhelmed by the system. Data gathered from the modules should be made easily available to the user. In essence, this is the entire purpose of the head on system, and specifically, the display module. Unlike seven segment displays, the LCD screen chosen for this project allows the layout to be more free-flowing. Consequently, all of the data can fit on the display. When designing the interface, all of the modules were shifted around until an appropriate layout was discovered. The user can be assured that all of the information from the modules is being displayed on the screen.

Finally, and possibly most importantly, the system must be easy to use in order to reduce short-term memory load. The indicator symbols that were chosen were fairly simplistic and self-explanatory. The proximity indicators are solid bars that are located on the left, bottom, and right of the screen in order to correspond with the left, rear, and right of the user. Both time and speed are written in using numbers. This format can easily be understood by any user. The cardinal direction is written in both text form and symbolic form, using the compass symbol. The user may not be as accustomed to directions as he or she is with time and speed. Therefore, both of these methods of displaying the value were incorporated. Overall, the simplicity of the system will reduce short term memory load of the user because there are no complex symbols that the user will have to learn to interpret.

7.2.1.3 Sensor Analysis and Processing

Using the wireless communication module, the microcontroller on the motorcycle will transmit the readings from the sensors to the helmet system. Once this data is received by the microcontroller on the helmet, it will be processed. The new values will be compared to the old values. If a change is indicated, this change will then be reflected to the user via the display. The microcontroller will send the necessary commands to the display in order to update the screen.

7.2.1.4 Libraries

A critical portion of the design process is picking out libraries that will be necessary for the program to work correctly. This must be done for each module

that the helmet and motorcycle system interacts with. The major point of focus in the helmet system is the display. All of the information is displayed to the user must be done so through this display. Without the help of libraries, programming this system would be a daunting task.

7.2.1.4.1 Display Libraries

The first library that will be utilized in the system is Adafruit_ILI9340.h. This library is specifically designed for the Adafruit 2.2" LCD display that has been chosen for this project. This library already has basic colors defined in it. In addition, it provides several functions that will make the process of drawing the user interface much simpler. This includes functions that can be used to draw lines, fill the screen, and draw pixels.

The next library that will be used is the Adafruit_GFX.h. This library offers even more functions that can be used in the drawing process. Specifically, it contains functions that allow you to draw and fill basic shapes such as circles, triangles, and rectangles. For this project, fillRect function can be used to draw the proximity sensor indicators that will be placed on the left, right, and bottom of the screen. This function also allows the color of the proximity indicator to be specified. This will come in handy for the user interface because the indicators should be able to change between three colors based on if there is an object present, and if so, how close it is to the rider. In addition, the fillTriangle function can be used to create the compass symbol portion of the cardinal direction indicator. This compass symbol can be created by drawing a black triangle, and then overlapping a white triangle on top in order to create the compass needle shape. Another benefit of this function is that it allows the coordinates of the three vertices of the triangle to be specified. This is useful for creating the various orientations of the compass symbol. Furthermore, this library also features functions that can be used to display text on the screen. The color, size, and position of the text can all be altered easily using the setText color and setTextSize functions respectively. This will make displaying the time, speed, and cardinal direction much easier.

7.2.1.4.2 Real Time Clock Libraries

Two libraries will be used to interact with the real time clock. The first of these libraries is Time.h. This library is specific for Arduino and has the functions hour() and minute() that can retrieve the current hour and minute respectively. The hour is returned in the 24 hour format, so it would have to be converted to the twelve hour format and the time period (i.e. AM/PM) would have to be calculated. The other library that could be used is DS3231RTC.h. This library open source adds additional functionality to the time library, and it is designed specifically for the DS3231RTC real time clock module that is being used in this project. The read() function can be used to obtain the second, minute, hour, weekday, day, month, and year. Not all of these values are needed for the program; however, this

would reduce the number of functions that must be called in order to obtain the data. Additionally, the `setTime` function can be used to set the time in the RTC. This is important when initializing the system. Additionally, with the incorporation of the two buttons so that the user can interact with the system, this function can be used to set the time based on user input.

7.2.1.4.3 Communication Libraries

In order to communicate with the real time module, appropriate libraries must be included. Arduino has the `Wire` library that can be used to facilitate communication with I²C devices. `Begin()` can be used to set the master and slave when initializing the modules. The `beginTransmission()` and `endTransmission()` allow for data to be transmitted across the I²C bus.

In order to allow the display to communicate with the microcontroller, the `SPI.h` library for Arduino will also be used. The `begin()`, `beginTransaction()`, `end()`, and `endTransaction()` functions will allow the SPI bus to be initialized and disabled. Once the bus is initialized, data can be transferred from the microcontroller on the helmet system to the display using `transfer()`. Should it be necessary, the SPI library also allows for interrupts to occur with the function `usingInterrupt()`.

7.2.1.4.4 Compass Libraries

In order to determine the direction that the rider is traveling, the magnetic readings must be taken from the compass module. The `Adafruit_LSM303_U.h` library greatly simplifies this task. `Event.magnetic.y` and `event.magnetic.z` can be used to get the y and z magnetic readings respectively.

7.2.2 Bike System

The main software aspect of the motorcycle system is receiving the data from the three ultrasonic sensors and GPS module and transmitting them using wireless communication to the helmet system. The main focus of the motorcycle system is retrieving data from the modules and transmitting it to the helmet system.

7.2.2.1 UML Diagrams/Flowcharts

Figure 47 explains the logic behind the code that is controlling the sensors. While there are other modules communicating with the microcontroller, as well as other participants, such as the user and the objects being detected, this flowchart does not include them; rather this diagram provides a more in depth look at the interactions between the three sensors and the microcontroller on the motorcycle. As previously mentioned in this paper, the Maxsonar-EZ 1010 has several methods of being connected and triggered. In this system, the chaining method is being used. The first sensor is triggered and the data is read. The first

sensor then triggers the second sensor. This sensor then takes a reading. Next the second sensor triggers the third in the chain and the data is read. The process of triggering the sensor and reading the data takes approximately 50ms per sensor. The data gathered from all three sensors is then prepared by converting the values to centimeters. Once this is complete, this data is then placed in a string and sent using Bluetooth to the helmet unit.

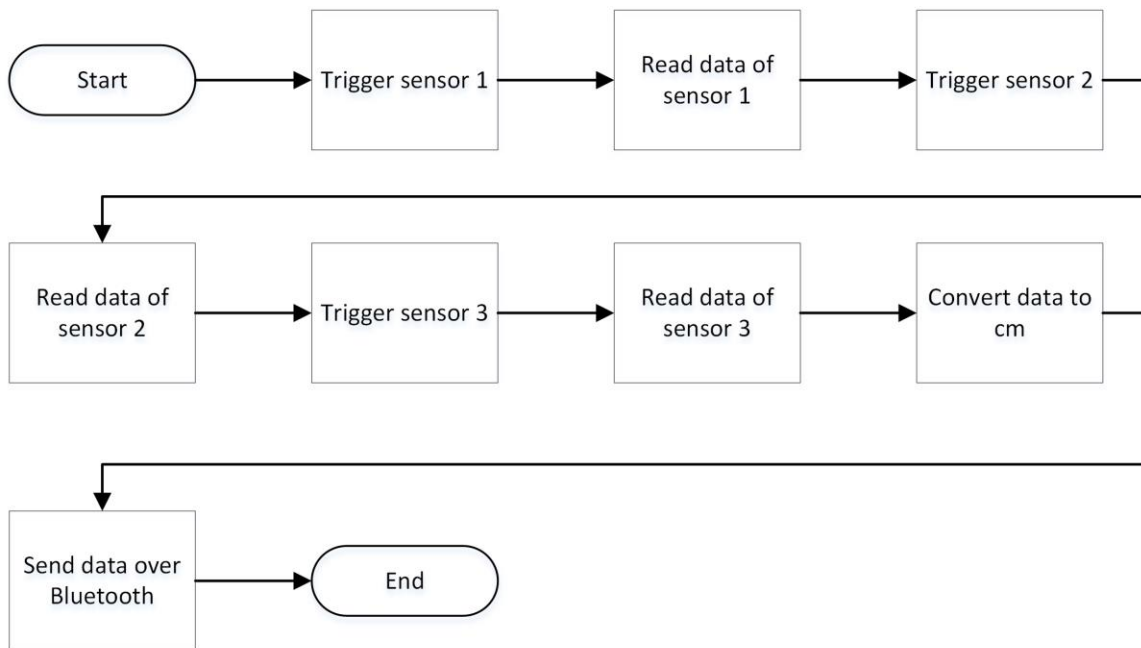


Figure 47: Sensor Program

Now that the in depth process occurring between the microcontroller and sensors has been analyzed, the other external “actors” in the system can be analyzed. The sequence diagram in Figure 48 takes into account not only the microcontroller on the motorcycle and the three sensors, but also the rider, the microcontroller on the helmet, the display, and the surroundings. The first actor to consider is the user; after turning the system on, which will only occur once, the user’s only interaction with the system is viewing the data displayed on the screen. The rest of the interactions in this object detection process are between the components of the system and the environment that it is being used in. As explained in detail in the previous diagram, the majority of the actions in this process occur between the microcontroller on the motorcycle and the sensors. For each sensor, a trigger signal is sent and the sensor then sends a pulse to determine if an object is present and if so how close it is. For the first sensor this signal is generated by the MCU on the motorcycle, and for the other two sensors the signal comes from the sensor that is before it in the chain. For each sensor, If an obstacle is present in its range, the signal that is sent out into the surroundings will bounce off the object back to the sensor. Regardless of the results obtained, the data is always sent back to the motorcycle module, and is then transmitted to the helmet module. Upon arrival in the helmet module, the

data will be analyzed and the display will be updated accordingly. At this point, the user will come back into play, and he or she will be able to see any changes in the display. Though this process does appear lengthy, the interactions between the sensors and the microcontroller occur in a few milliseconds. Therefore, from the point of view of the user, the updates displayed on the screen occur in real time.

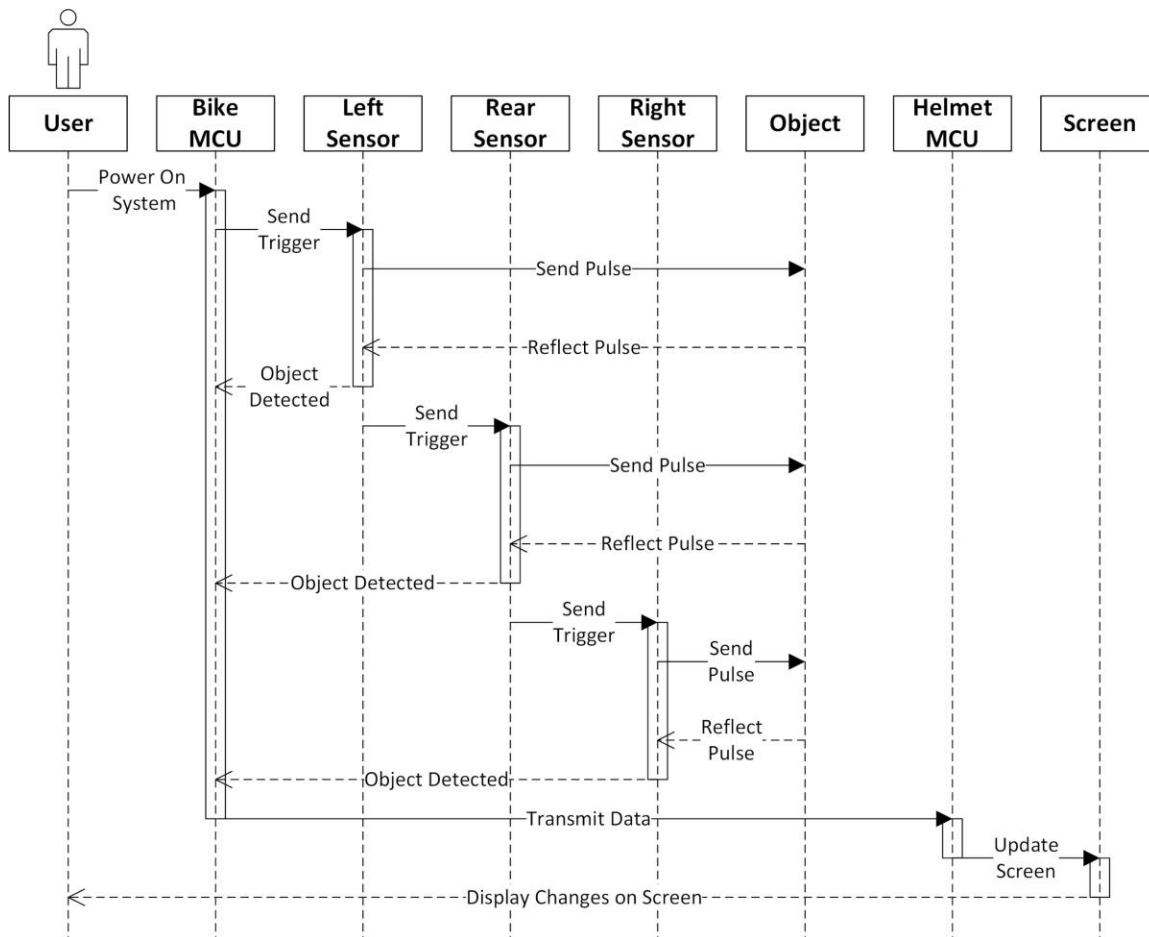


Figure 48: Sensor Sequence Diagram

The other module that the MCU on the motorcycle must communicate with is the GPS module. As outlined below in the sequence diagram in Figure 49, the GPS module is used to obtain the speed of the rider. This process is extremely simple. The microcontroller on the motorcycle begins by calling the appropriate function from the Adafruit GPS library to request the speed. The GPS module then responds by returning this speed value. Finally, this value is transmitted wirelessly to the microcontroller on the helmet system.

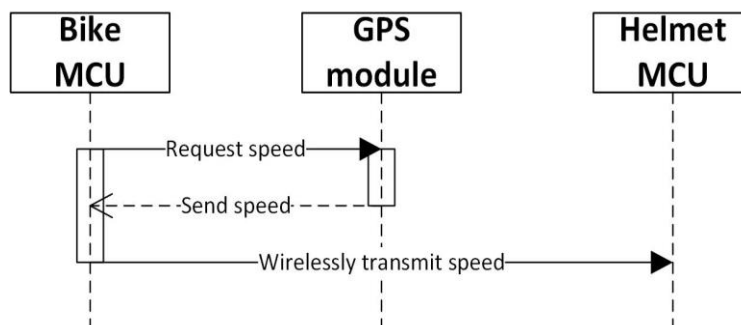


Figure 49: GPS Sequence Diagram

7.2.2.2 Algorithms

The main algorithm of the motorcycle helmet system is used to detect calculate the distance of an object. The distance of the object is not automatically calculated by the sensor; rather, the value returned is the amount of time, in microseconds, that occurred between the sending of the signal and the return of the echo. This value can then calculate the distance to the object in either centimeters or inches using Equation 2 and Equation 3 respectively:

$$\text{Distance (cm)} = \text{time}/58 \quad (2)$$

$$\text{Distance (in)} = \text{time}/148 \quad (3)$$

For the purposes of testing, the distance was calculated in centimeters. Because centimeters are smaller than inches, it made testing the accuracy of the sensors more accurate. For each sensor, the MCU on the motorcycle will convert the value it receives from the sensor into cm then send it to the helmet system.

7.2.2.3 Sensor Analysis and Processing

The code for the sensors will consist of two main parts: taking the measurement and analyzing the readings. When taking the measurement, each sensor must take its measurement individually. The microcontroller must send a trigger signal to the first ultrasonic sensor in order to indicate that the sensor should produce an ultrasonic signal. At this point, the program will tell the sensor to read the echo pin to determine if the signal was returned. If the echo pin reads high then there is an object within range; if not, there is no object. This sensor will then trigger the next sensor in the chain. This cycle will be executed continuously for all three sensors.

7.2.2.4 Libraries

The motorcycle will use some of the same libraries as the helmet system; however it will also have to have some libraries that were not included in the

helmet system. Specifically, certain modules, such as the GPS module, will require special libraries in order to simplify the programming process.

7.2.2.4.1 GPS Libraries

For the GPS module that was chosen for this project, Adafruit has provided the `Adafruit_GPS.h` library. The function in this library that is the most pivotal for this project is the `parse` function; it takes in the data from the GPS module and uses parsing to convert it into a more understandable and usable form. For this project, the only data required from the GPS is the speed, therefore, the corresponding speed parsing function will be called.

7.2.3 Overall System

Because the helmet and motorcycle systems work together, it is also important to view the system as a whole. This includes how the two systems communicate with each other, as well as how the overall system works.

7.2.3.1 UML Diagrams/Flowcharts

The following sequence diagram in Figure 50 gives a broad overview of how the various modules will transmit data to the microcontrollers and display this data to the user. The microcontroller on the motorcycle system will receive information from the ultrasonic sensors and GPS module. Simultaneously, the microcontroller on the helmet system will be receiving the data from the real time clock module and electronic compass modules. It is important to note that the helmet system will finish retrieving data before the motorcycle system does. As a result, there will be no conflict when the motorcycle module transmits its data to the helmet system using the wireless communication modules. Additionally, this method will reduce the wait time for the screen to update and the amount of time the microcontroller is not in use. When all the data has been received, the microcontroller on the helmet will send the necessary changes to the display, and these changes will be updated for the user to see.

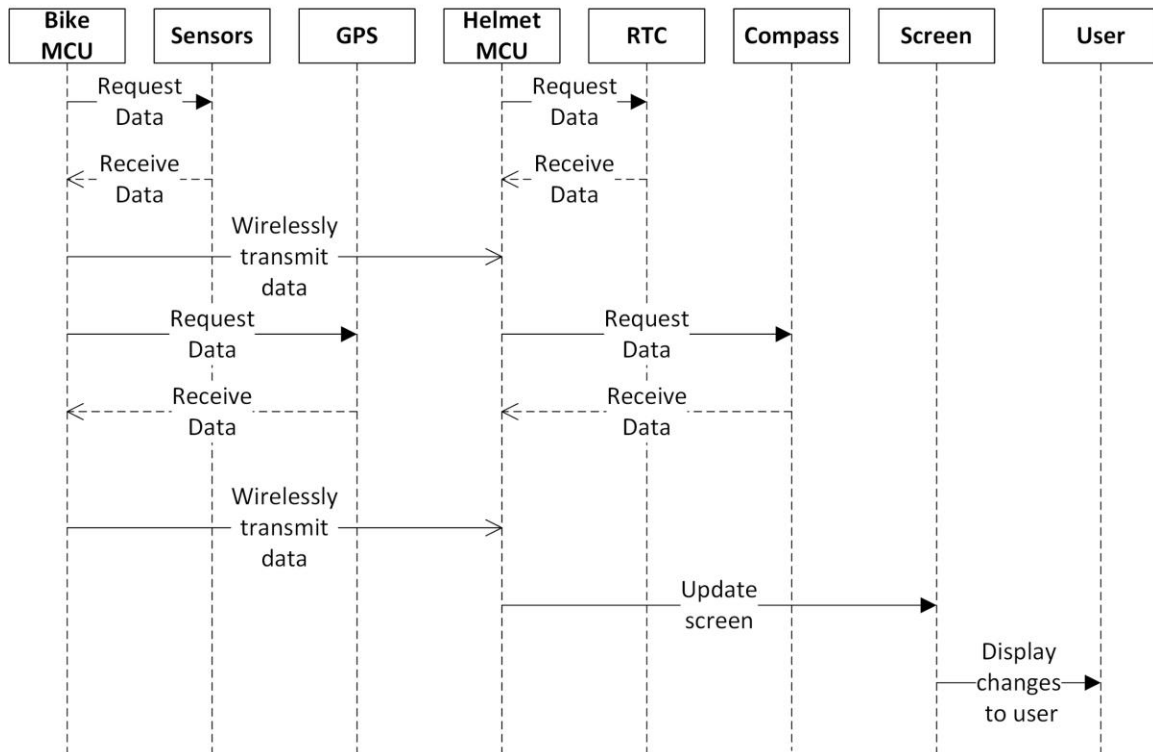


Figure 50: Head On System Sequence Diagram

8.0 Prototype Construction and Coding

The Arduino Uno will be used initially when creating the prototype because it contains the same microcontroller as the Head On system. This will allow the software to be created and tested without having to wait for the printed circuit board to be completed. Modules will be connected to the development board using a breadboard, jumper wires, and if necessary header pins. The code for these modules will then be written and tested. Once the accuracy of the code has been determined, it will then be uploaded into the helmet and motorcycle modules. These modules will consist of the PCB boards and the same modules tested on the development boards.

Simultaneously, the printed circuit boards will also be created. PCB diagrams and schematics will be created for the helmet and motorcycle systems. These diagrams will then be sent to OSH Park. Once the complete circuit boards arrive, the prototype will be built. All equipment used will come from UCF facilities such as the Texas Instruments Innovation Lab and the Senior Design Lab. All the necessary modules will be placed on the circuit boards using the surface mount soldering system and reflow oven in the Senior Design Lab. Housing units will be 3D printed using equipment from the Texas Instruments Innovation Lab. Each circuit board will then be placed inside of their unique housing units in order to protect them from the environment. The Bluetooth connection will be set between the two units so that they can communicate with each other. Finally the power

system will be set up. The solar panels will be placed at optimal positions on top of the motorcycle helmet. These solar panels will be connected in order to produce the necessary power for the battery which is also on the helmet system. On the other hand, the motorcycle system will be powered by the motorcycle battery itself.

8.1 Master Parts List

After considering a variety of parts for each part of the project, a list of final parts was determined. These selected modules are displayed in Table 12. These parts will be incorporated into the final prototype of Head On.

Table 12: Master Parts List

Type	Module Chosen
Sensor	LV-MaxSonar-Ez 1010
Screen	Adafruit 2.2" 18-bit color TFT LCD display
Microcontroller	ATmega328
Wireless Communication	HC-05
Lithium Polymer Battery	585460
Energy Harvesting System	BQ25570
Solar Panel	MPT4.8-75
Boost Converter	TPS54292
Real Time Clock	DS3231
Electronic compass	LSM303D
Global Positioning System	PA6C LadyBird-3

8.2 Facilities and Equipment

The majority of specialized facilities and equipment utilized was owned and provided by team members. Surface mount soldering of several critical components was performed by Quality Manufacturing Services, Lake Mary, Florida. Electronic test equipment provided by the University of Central Florida College of Engineering and Computer Science in the Senior Design Lab, CECS Smart Lab and, Texas Instruments Innovation Lab were used for electrical testing and troubleshooting. No other specialized equipment or facilities were used in designing Head On.

8.3 PCB Vendor and Assembly

When considering which PCB vendor to send our design to there were several factors that needed to be taken into consideration. To begin with, the time it would take to get the printed circuit boards back. Since this design is time sensitive, it is important to allow plenty of time for the board to be made and sent out, for the design team to test it, and for any potential problems to be addressed. Furthermore, the price needed to be taken into account. More than one PCB will be ordered in case one of them is faulty. This will allow the design team to pinpoint whether any potential faults are due to the design or the actual printed circuit board. Hence, it is important for the boards to be cost effective since more than one will be ordered.

Highly recommended by other students, the first vendor considered was OSH Park. For starters, the file submission type for OSH Park is Eagle CAD. Since that is the same software being used to design the printed circuit board for this project it would make for an easy transition. Furthermore, OSH Park's most basic order includes three copies of the design sent in. As mentioned above, more than one board will be ordered, so OSH Park's policy of sending three copies with every order would fit right in with that idea. However, it should also be noted that OSH Park requires that every single order sent in is for quantities in multiples of three. Meaning, more boards need to be ordered than it would have to be six total and so on. For the standard two layer order OSH Park's price is five dollars per square inch. Since this design already has size constraints, the total for the circuit board would not be overly expensive.

Another vendor considered was Advanced Circuits. They are the third largest PCB manufacturers in North America, which lends credibility to their products. One of the features they have is a special program for engineering students who wish to order from them. They provide free PCB layout software called "PCB Artist" and give discounts to students on the pricing. There is no minimum number of boards that need to be ordered and no restrictions on how many should be ordered at a time. However, the price for each two layer printed circuit board is thirty- three dollars. Despite the fact that the boards would probably be of better quality, since more than one board would be ordered, Advanced Circuits would likely be too far outside the budget.

The last vendor considered for the printed circuit boards was Bay Area Circuits. Known for printing boards at a fairly inexpensive price, they are well known amongst students and hobbyists alike. Much like Advanced Circuits they have a special student rate that can be accessed by registering with a university email. The deal for students is thirty dollars for a two layer printed circuit board. Although this is still pretty expensive, it is important to note that the turn time is five days. Should a circuit board be needed in an extremely timely manner, Bay Area Circuits would likely be the best choice.

Although not recommended, a final option would be to create a printed circuit board and simply do away with vendors all together. However, this would increase the possibilities errors due to the intricate detail required for some of the surface mounted components. Based on the above reasoning, the best choice for procuring the printed circuit boards for the project is to choose OSH Park as the vendor. They are by far the most inexpensive and their policy of sending three copies at once would be useful for testing purposes. However, since the board design was delayed a quick turnaround was required. The options were reviewed at the time of ordering and an additional manufacturer, Pentalogix, was found to offer faster processing at a better price. They offer all the same features as Advanced Circuits but at a 40% lower cost for fabrication and shipping. Since their reputation was unknown to the team, a backup order was also place with OSH Park.

8.4 Final Coding Plan

Two sets of code will be created: one for the helmet system and the other for the motorcycle system. Once the codes have been tested using the Arduino Uno and it is confirmed that they work properly, they will then be uploaded into the microcontrollers on the two systems. The code for the motorcycle system will focus on retrieving data from the three ultrasonic sensors and GPS module; additionally, it will also include code to transmit this data to the helmet system using the wireless communication module. The code for the helmet system will focus on taking this data received, as well as the data it gathers from the real time clock module and compass module, and making decisions as to how the display must be updated. This process includes parsing the data received from the motorcycle unit, comparing values to various threshold levels, and selecting and displaying the appropriate indicator signals.

9.0 Project Operation

The following sections acts as a user manual for the basic operations of the Head On system. This includes explanations on how to change between power modes, how to charge the system using either charging method, and how to understand the user interface.

9.1 On Mode and Off Mode

This system has three two power modes. The first of these is on mode. This mode is activated when the switch on the helmet unit is moved up. During this mode, the system is transmitting and receiving data. The sensors, GPS, and other modules are all actively taking measurements and the microcontrollers are receiving them. The second mode is sleep mode. This mode occurs when the switch is in the center position. In this mode, the system turns off completely. When the system is not in use the user should put the system into off mode in

order to conserve battery power. Originally, a third mode, charging mode, was considered. This mode would have been entered when the switch was placed in the down position. However, due to the failure of some of the charging components, this option had to be removed from the design.

9.2 Charging

There are two methods for the user to charge this system. The first is through the removable battery in the helmet system. In order to charge this battery there will be a barrel jack for the user to connect to. Much like with older cell phones, the user simply has to plug in a charger with a barrel connector to a regular wall plug and connect it to the system. The second method requires no actions from the user. The helmet system will automatically charge when the solar panels are in the presence of sunlight. Similar to the battery charging method, the system does not have to be powered on in order to charge using the solar panels. The charging rate using the solar panels will vary depending on how much sunlight is available.

9.3 User Interface

When the system is first turned on, the user will see the welcome screen. This welcome screen, show in Figure 51 displays the message “Welcome to Head On”. At the bottom of the screen there is a loading bar. As the modules on both systems initialize, this loading bar becomes longer. Additionally, above the loading bar, messages will be displayed about what systems are currently being initiated.

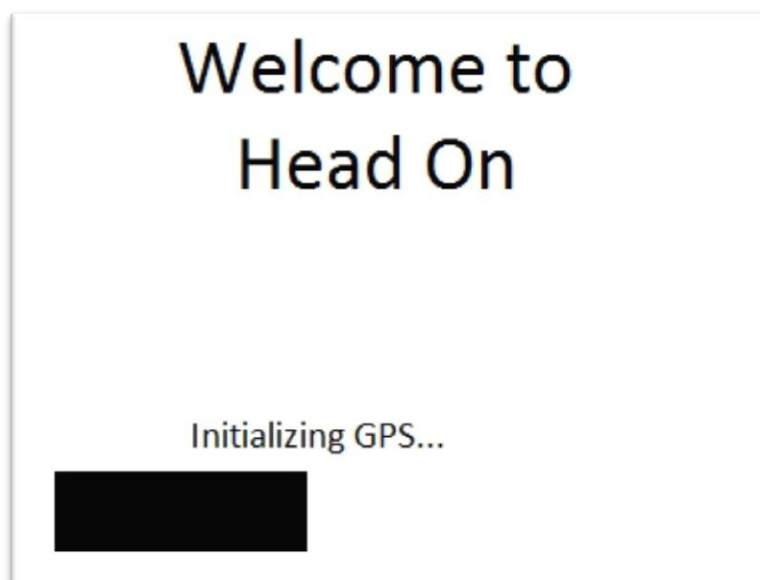


Figure 51: Welcome Screen

When designing the user interface, the top priority was ease of use. Efforts were focused on making sure the rider would be able to glance at the display at any moment in time and quickly decipher all the data gather at the moment. Furthermore, the symbol designs must be easy to understand and the display must not be too cluttered. The placement, size, and design of the symbols were chosen with the user experience in mind. Figure 52 shows the final layout for the user interface in Head On.

In the center, information on the rider is contained. To be specific, the center of the display contains the current time, cardinal direction, and speed in miles per hour. All the information in the center is displayed in large font for improved clarity and readability. Additionally, arrow designs are implemented into the cardinal direction to complement the cardinal value displayed.

On the sides and lower edge of the display, proximity bars are added. Each of the proximity bars' placement on the screen corresponds with the placement on the motorcycle such as left, right, and rear facing. These proximity bars are dependent on the information retrieved from the ultrasonic sensors. For example, at all times that the rider is at a far enough distance from any object according to the logic used for the sensor, the corresponding bar will not be displayed. In contrast, when as an object approaches into the sensor's operating range, the bars will dynamically increase according to the distance it detects.

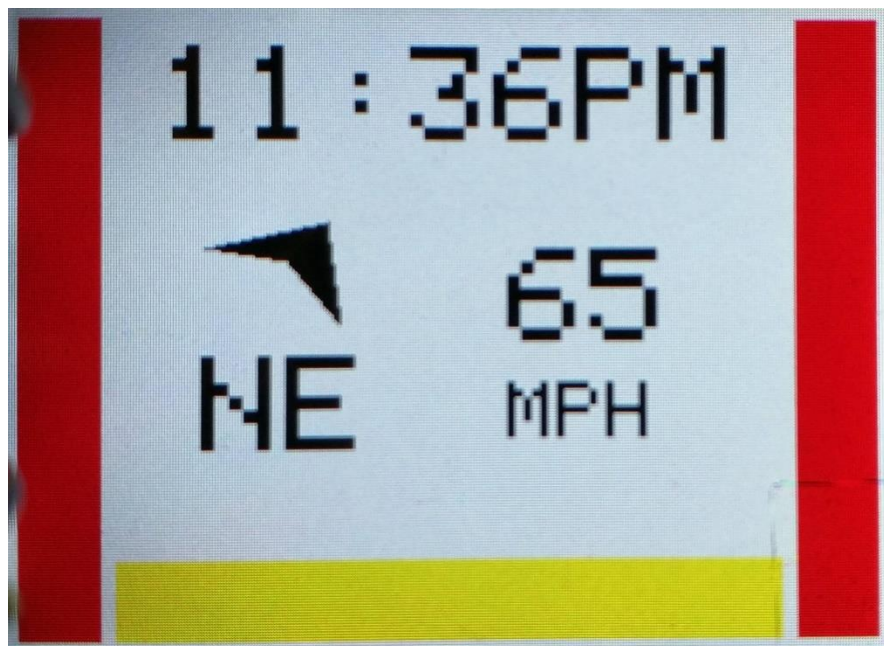


Figure 52: User Interface Layout

Overall, efforts are placed into making the Head On display easy for the user to use while providing useful and possibly lifesaving, information during use. Users should be able to glance at the display to see the time, their cardinal direction,

speed, and any possible dangers entering his or her vicinity without distracting the rider.









9.3.1 Speed Indicators

The speed of the user can be found in the center of the screen, below the time and to the right of the direction indicator. This indicator consists of two parts. The first is the numerical value of the speed, and the second is the units that the speed is being measured in. The displayed speed value is the value retrieved every fraction of a second from the GPS module on the motorcycle.

9.3.2 Cardinal Direction Indicator

The cardinal direction indicator is also located in the center of the screen. It also consists of two components. The first is the compass symbol that will indicate the direction. Next is the value of the direction represented by N, E, S, W, NE, NW, SE, and SW corresponding to the four cardinal and four intermediate compass directions. Table 13 summarizes the directions and their corresponding symbol. Similar to the speed indicator, this value will be measured by the GPS module found on the motorcycle. However, the electronic compass module will also be used for when the rider is not moving.

Table 13: Cardinal Direction Values

Direction	Letter Representation	Symbol
North	N	
East	E	
South	S	
West	W	
Northeast	NE	
Northwest	NW	
Southeast	SE	
Southwest	SW	

9.3.3 Time Indicator

The time indicator on the display is located on the top of the screen. The time is displayed in standard 12-hour clock form with the hour and minute, followed by the period, either AM or PM. Because of the real time clock module utilized in the design, the time displayed on the screen will have an accuracy of +/- 2 minutes/year.

9.3.4 Proximity Sensor Indicator

The proximity sensor indicators are displayed as solid black rectangles, and can be found on the left, right, and bottom of the screen. These bars indicate the location of potential hazard. The left, right, and bottom indicators correspond to the left, right, and rear sensors respectively. These bars are only displayed on the screen when a hazard is present. In the event that more than one sensor detects a hazard, the appropriate combination of indicators will be displayed.

9.4 Adjusting Brightness

As previously mentioned in this paper, there are two buttons incorporated into the helmet unit. These buttons allow the user to interact with the system in various ways. The first of these ways is adjusting the brightness of the display. If the user holds the top button, the brightness of the display will increase. Similarly, if the user holds the bottom button, the brightness of the screen will decrease. The screen automatically dims between the hours of 8PM and 7AM.

9.5 Setting the Time

The next way the user can use these buttons to interact with the system is by setting the time. If the user presses both buttons simultaneously, the system will enter time setting mode. During this mode none of the other modules are sending or receiving data. First, the hours location on the time indicator will be underlined. If the user holds the bottom button, it will cycle through the values one through twelve, since the 12-hour time is used. Once the desired number has been reached, the user must release the bottom button then press the top button. Once he or she releases the top button, the minutes will not be underlined. Similarly, the user can hold the bottom button to cycle through the values zero to fifty nine. Once the appropriate value is chosen, the user must release the bottom button again then press the top button. Once the top button is released, the user will be able to set the AM/PM value. As with the hour and minute, this value can be toggled using the bottom button. Finally, to exit the time setting mode, the user must simply press the top button. The time indicator will now reflect the changes the user made in the time setting mode.

10.0 Prototype Testing

In order to confirm that Head On does not have any software or hardware problems, a series of tests will be run on each component. In order to ensure that the testing is thorough, a wide variety of scenarios will be implemented. After testing, the results will be analyzed and any areas of concern will be addressed. If necessary, changes will be made to the design. This process of testing will then be repeated until the results are satisfactory and all of the desired goals, requirements, and product specifications developed for this project have been met.

This process is made possible by the use of the agile method. During any stage of this process, if the need arises to make changes to the design of the product, they can easily be implemented without having to start from scratch. Therefore, when the prototype is tested the issues that are discovered can be dealt with in a more timely fashion.

10.1 Testing Environment

Head On will be tested in two types of environments. First it will be tested in a lab setting in order to ensure that the software is error free. Once it is confirmed that the software errors have been resolved, the prototype will then be tested on the road. This will allow real life scenarios to be encountered and troubleshot. The following real life scenarios will be tested:

- a. Daylight
- b. Night
- c. Low traffic
- d. High traffic
- e. Low speeds
- f. High speeds

10.1.1 Software Testing Environment

The Arduino UNO uses the ATmega328 microcontroller. Since this is the same microcontroller as the prototype, this development board will be used to test code that is running the helmet and motorcycle module. Rather than testing the software on the prototype, it will be tested on the development board first. This will help isolate any errors in the software, rather than trying to determine problems with the software and hardware simultaneously.

10.1.2 Hardware Testing Environment

Once the software has been tested, the hardware components of the prototype can then be tested. First the components will be individually placed on a breadboard and connected to the microcontroller to ensure that the components

are getting the necessary ranges. This testing will be done as soon as the parts are purchased so that time is not wasted building a prototype with insufficient parts.

After the success of the components is verified, the prototype will be developed and the system will be tested in a real life environment. The helmet and motorcycle module will be used by a rider when driving a motorcycle in various scenarios.

The first two testing scenarios will focus on the ability of the user to use the system with or without light. This will ensure that the rider can use the system both during the day and at night. The primary component that will be focused on will be the screen since that is how the user receives information from the system. The first scenario that will be tested is the use of the system in daylight. The main purpose of testing in this environment is to ensure that glare from the sun will not impact the user's ability to read the screen. Next the system will be tested at night. This is to ensure that the backlight of the LCD screen is sufficient enough to allow the screen to be visible when there is very little light.

The next two testing scenarios will focus on the how well the sensors can detect and process objects. Initially the system will be tested in low traffic. Because there will be less hazards around the rider, the sensors will be triggered less often. This will allow us to ensure that the system is not getting false positives. Once it is determined that the system works properly in low traffic, it will then be tested in high traffic. These test results will be used to confirm that the system is capable of detecting several objects at once and communicating this to the screen.

The final two scenarios under consideration will focus on testing the features of the device that rely on the GPS module; this includes the cardinal direction and speed. To start, the system will be first tested at low speeds. This will ensure that the cardinal direction and speed are accurate. Then once the results for this environment are satisfactory, the system will be tested at high speeds. This will test how quickly the system will react. When accelerating to a higher speed, the speed indicator on the screen should also be changing. In addition, if the rider changes direction at high speeds, the cardinal direction indicator should also change accordingly.

10.2 Testing Procedure

In order to determine that the final prototype is fully functional, both the hardware and software must be tested for each component of the system as well as the overall functionality of the system. Any errors discovered during the testing phase will result in hardware and software analysis as well as possible design modifications.

10.2.1 Unit Testing

Each component must be tested individually to ensure that it is working properly. This will allow errors to be pinpointed to a particular module or portion of the program. This testing will occur in both the lab setting and the real life scenarios described previously.

10.2.1.1 Wireless Communication Testing

Successful wireless communication is critical to this application as it is the linking factor between the helmet and motorcycle unit. As with all other components of Head On, the Bluetooth modules had to be reviewed for failure in hardware or data loss during communication. As a part of the testing procedure of the wireless communication, an Arduino Uno was used as it incorporates the ATmega 328 microcontroller.

To begin, one of the HC-05 Bluetooth modules was installed on the Arduino Uno, which was powered by an external 5 V power supply. The wiring from the Arduino Uno to the HC-05 is illustrated in Figure 53. Once the wiring was done, testing was done through a loopback test. By definition, a loopback test is a test in which a signal is sent from a communications device and sent back (loopback) to determine device functionality. For loopback testing on the HC-05, an additional wire was needed. Specifically, a wire was needed to short circuit the Rx and Tx pins in such a way the receiver and sender are connected directly. From here, the terminal was used to verify proper functionality of data transfer.

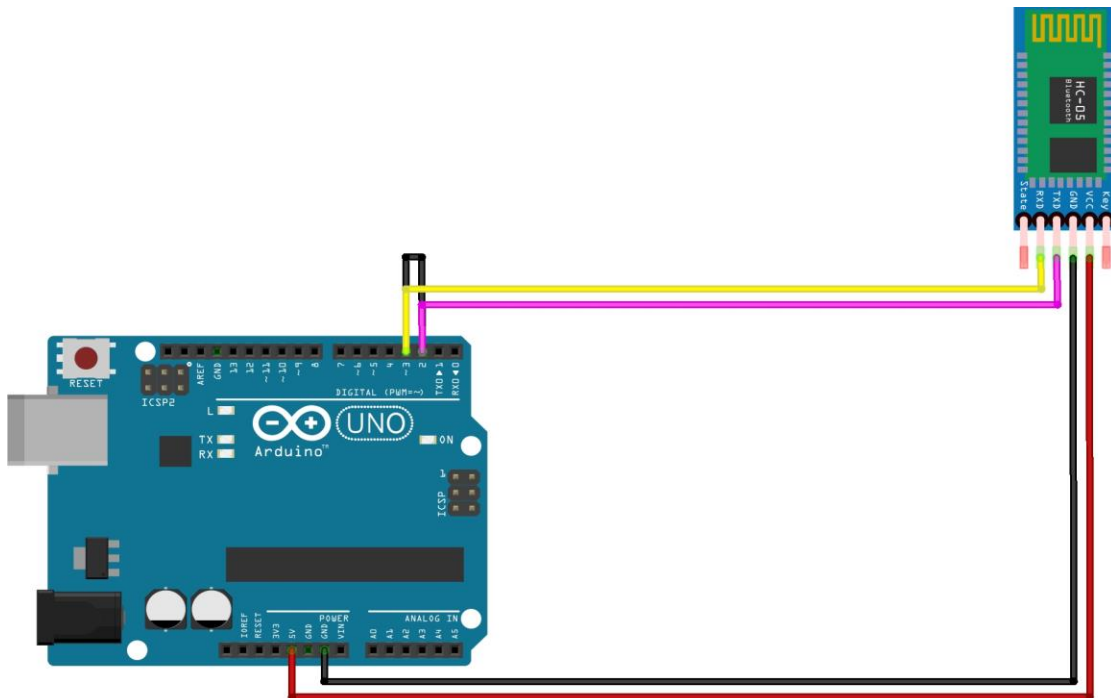


Figure 53: Wireless Communication Testing Layout

Next, the Arduino Uno was connected to a PC through USB and a new terminal instance was used to verify input and output. Before testing the Uno with HC-05, a new sketch or program was uploaded with the intent of sending a signal and receiving the same signal in return. In specific, the sketch was designed to incorporate a while loop that would transmit an arbitrary message every 2 seconds. For testing purposes, the message transmitted was “This is a test.” Assuming the HC-05 is working properly in the loopback test, the expected output would be a stream of “This is a test” messages displayed across the terminal until the program is terminated. After the first HC-05 Bluetooth module was tested for functionality the same steps were repeated on the remaining HC-05 module.

Additionally, the wireless communication module will be tested when it is integrated in the prototype. If the motorcycle successfully transmits the data it receives from the modules to the helmet system, then the wireless communication module and software will be considered successful. This will be verified through the LCD display. If the values are updating then the communication is successful.

10.2.1.2 Screen/GUI Testing

Each indicator on the screen will be tested individually to ensure that it is and is not displaying when appropriate. In addition, the size, shape, and location of the indicators will also be verified. When an object is detected by one or more of the sensors, the appropriate proximity warnings must be displayed on the screen. This includes all possible combinations of sensors detecting objects. The sensor indicator should only be displayed when an object is detected; therefore, when the object is no longer there, the indicator should no longer be displayed. It must also be tested that the time displayed on the screen is accurate. The time should match other clocks that are known to be correct. In addition, it should display in the twelve hour format with AM or PM depending on the time of day. In addition, the speed will be tested. When accelerating the speed on the indicator should also be increasing, and the opposite should occur when decelerating. If the user is at a standstill the display should indicate that the current speed is 0 miles per hour. At all times, the speed on the screen should match the speed that is on the rider’s motorcycle. Finally, the cardinal direction will be tested. When the user makes a turn, the cardinal direction indicator should also change accordingly.

First the screen will be placed on a breadboard using break away headers. It will then be connected to the Arduino UNO using jumper wires. The other modules will be connected to the breadboard. A program will be created in the Arduino IDE to call certain draw functions for the screen in response to the inputs from the modules. All of the modules will be tested with the screen in order to verify that the indicators are being drawn correctly. These values will also be sent to the serial terminal so that it can be verified that the values displayed are correct.

This screen testing should occur after the individual testing of the other modules is done in order to ensure that the modules themselves are working properly.

Finally, once the prototype is built the prototype will be tested in the various environments and scenarios described in the sections above. At all times during this test, the values on the screen should be updating. Additionally, the layout of the screen should remain consistent. If any of the indicators are displaying incorrectly or the values are not updating when they should be, the hardware and software components of the screen will be analyzed again in the lab setting in order to determine what the source of the error is. Ideally, the format of the screen should resemble the user interface layout depicted in Figure 52 earlier in the document. The prototype will be tested in various lightings. Currently, the only lighting source for the display is the backlight. This backlight is adjustable, so the ideal setting must be determined for the various times of day. The rider should be able to use the system whenever he or she wants, so the screen must be easily readable.

10.2.1.3 Solar Panel Testing

Although there are two forms for charging the battery on the helmet system, the main form of charging is via the solar panels adhered to the motorcycle helmet itself. Therefore it is important to make sure that the panels are providing the desired voltage and current output. Since the panels are to be molded to the shape of the helmet, some panels will be slightly angled and, therefore, not receive direct sunlight. Furthermore, the panels will be subject to varying levels of sunlight due to weather and the location of the rider.

Given the above mentioned challenges, the solar panels will have to be tested in order to account for both. To start off, the panels will be placed on the helmet in the configuration that best exposes all of them to direct sunlight. Using a multimeter the voltage and current will be measured from the combined panels. Then the panels will be connected to the BQ25570 and the lithium polymer battery in order to ensure that the battery can be properly charged in a timely manner using the solar panels.

In order to correctly gauge the output levels of the panels they have to be tested in different light levels. With the panels in the configuration that best allows them to be hit by direct sunlight, they will be placed in varying levels of light. This can be achieved by placing the helmet outside during sunrise, mid-morning, noon, mid-afternoon, and sunset. To further test how the system will perform in different light levels, the helmet will be placed in the shade during the aforementioned times of day and tested again. Finally, the same testing will be done on a cloudy day.

The testing outlined above should give a comprehensive analysis of how the panels will perform on the Head On system. However, it is important to note that

the current configuration of the panels allows for room for an extra panel should the tests prove that the required output is not being reached.

10.2.1.4 Speed Testing

One of the features of Head On is to allow the user to digitally visualize their current travel speed in miles per hour, thus reducing the need to look down at the gauges. To allow this feature to be useful to the rider, it needed to be accurate to prevent the user from conflicting with speed limits. The testing for this component is not as simple as looking down at the gauges and comparing it to the digital output of Head On. The reasoning for this is that a stock motorcycle with no changes to gearing will have inaccuracies from the factory on the speedometer. This variation on speedometer is generally around 10% above the true speed for a majority of motorcycle manufacturers and is further affected by gearing changes and different or worn out tires. Therefore, an alternative method for testing must be created. To test this portion, a little creativity was used using a car, laptop, Android phone, Arduino Uno, and GPS module.

To begin, the Arduino Uno was wired to the GPS module per the data sheet. The Arduino Uno was then connected to a laptop through USB for both power supply and data transfer. Then a new sketch was uploaded to the Arduino Uno with the intent of displaying the GPS modules tracked speed. Specifically, a similar testing program was used as seen in the wireless communication testing with a while loop that displays a message every two seconds; however, instead of “This is a test”, the program would display the GPS speed as parsed by the Adafruit GPS library function `speed()`. The next part of the testing configuration involved the Android phone which will use its internal GPS feature to display speed. The Android phone in this case is the control as it can be trusted to display accurate location and speed. Furthermore, a speed tracking application needed to be installed on the phone as the preinstalled Google Maps application did not provide speed functionality. Thankfully the Google Play Store has an abundant number of free GPS based speedometer apps.

Finally, with all portions of the testing environment set, a moving vehicle was used with the laptop, Arduino Uno, and Android phone operating within it. On the PC side, a new instance of the terminal was then initialized and the Arduino sketch was run. On the Android side, SpeedView was initialized with high accuracy location mode enabled, which uses a mix of GPS, Wi-Fi, Bluetooth, and cellular networks for information. As the vehicle approached constant speeds, the values displayed on the terminal from the GPS module were validated by comparing them to the output of SpeedView.

10.2.1.5 Clock Testing

The clock testing for the system will be much less complicated than the other modules. The real time clock module will be connected placed on a breadboard

and connected to the Arduino Uno using jumper wires. A new program will be created in which the minute, hour, and period are continuously retrieved from the module. Every time the value of the time changes, it will be displayed on the serial monitor. These values will be compared to an online clock to verify accuracy. In this case, time.gov will be used as it provides the time as provided by three time agencies of the United States: a Department of Commerce agency, the National Institute of Standards and Technology (NIST), and the U. S. Naval Observatory (USNO). This process will be done for several minutes in order to ensure that the clock is changing at the proper time. Additionally, testing will be done several times to confirm there are no significant deviations in timekeeping with continuous use of the real time clock module.

10.2.1.6 Sensor Testing

The sensors will first be tested in the lab setting. This testing method will serve two purposes. First, it will allow the maximum range of the sensors to be verified. This is imperative because the sensors must be able to sense far enough that it can determine if an object is present in one of the blind spots. If the sensors do not provide the necessary range needed for this project, another sensor will be chosen. The second purpose for this testing is to ensure that the sensors are cycling through correctly. When testing the sensors in this setting, the three sensors will be placed on a breadboard and connected to the Arduino Uno using jumper wires. The grounds of the three ultrasonic sensors will all be connected to the ground on the Arduino UNO. Similarly, the VCC of the sensors will all be connected to the +5V on the Arduino. Finally, the trigger and echo pins for each sensor must be connected to their own pins on the development board. The exact testing program created will vary depending on what pins the echo and trigger pins are connected to. A program will be created in the Arduino IDE in which, one by one, the sensors receive the appropriate trigger and echo signal to detect an object. This value will be converted to centimeters and store in a variable. Once this is completed for all three sensors, the values will be displayed on the serial monitor. Objects of varying shapes and sizes will be placed at varying distances in front of different sensors in order to verify the range of the sensors. Once a desirable range is found, actual software that will be used by the prototype will be tested. Slight modifications will have to be made in order to have the values display on the serial monitor, however, the majority of the program will remain the same. This test will verify that all three sensors are detecting objects at the proper time and confirm that the sensors are not interfering with each other.

Once the prototype is built, the sensors will be tested in the various real life scenarios. Various traffic patterns and speeds will be tested. Since the serial monitor cannot be used in this scenario, the display mounted to the front of the helmet must be used instead. Therefore, it is imperative that before testing the sensors on the prototype, the display must have successfully tested in the lab setting. The both the low and the high traffic patterns will help verify that the

sensors are only updating when there is a change in their environment. Testing the sensors while driving at various speeds will help confirm that the sensors are quickly updating based on changes in the objects around the user. For example, if the rider is driving on the highway, and he or she passes a car, the sensors should be able to quickly sense that vehicle and change the indicator on the screen. Once that vehicle is no longer present, the sensor should then detect this and remove the indicator from the screen. In order to be effective the sensors and the display updates must be extremely quick.

10.2.1.7 Cardinal Direction Testing

In order to test the cardinal direction in the lab setting, the compass module will be attached to the breadboard using breakaway header pins. Once the module is secured, jumper wires must be used to connect these headers to the Arduino Uno. After completing the setup, a program will be created in the Arduino IDE which continuously retrieves the cardinal direction from the module and displays the value on the serial monitor. The module and breadboard will be randomly pointed in all four cardinal directions and all four intermediate directions in order to ensure that the compass module is correct. The accuracy of the measured directions will be checked against the values displayed by the stock Apple iOS compass app.

Additionally, because the compass module will be oriented at a different angle when on the motorcycle helmet, once the prototype is built the compass module will be tested again. This will ensure that the program interacting with the compass module is interpreting the results correctly. Similar to the lab testing procedure, the rider will turn in different directions in order to verify all the cardinal and intermediate directions. The result will be displayed on the LCD screen on the front of the helmet.

11.0 Administrative Content

One of the keys to the success of this project was proper administration. This included creating milestones to keep the group on track, keeping track of budgets and financing, and distributing the work between all four team members based on his or her skills.

11.1 Milestone Discussion

In order to successfully complete Senior Design I and II, a series of milestones was created. This aided in keeping the project on track so that all deadlines could be met. Table 14 and Table 15 illustrate the milestones that were set for Senior Design I and II, as well as the deadline associated with each one. Not all of these deadlines are set in stone and they may be changed if necessary.

In Senior Design I, the primary focus is researching and designing the hardware and software components of the project. This includes researching similar products, determining possible ways to implement the Head On features, and investigating specific modules that could be used. Once sufficient research was performed, the prototype design process began. All of this research and design decisions were incorporated into the Senior Design I paper. At the end of the semester, this Senior Design I documentation is the sole method of evaluating the success of the project up to that point. A working prototype will not be necessary until the end of Senior Design II.

Table 14: Senior Design I Milestones

Milestone	Deadline
Research possible project ideas	August 28, 2015
Choose project topic	August 31, 2015
Perform market analysis of similar products	September 9, 2015
Develop list of possible features	September 9, 2015
Research ways to implement the agreed upon features	September 11, 2015
Submit project proposal document	September 15, 2015
Propose idea to local companies for funding	September 22, 2015
Research chips and compatible modules	September 30, 2015
Design PCB for motorcycle and helmet system	October 31, 2015
Design UML diagrams for software	October 31, 2015
Begin programming microcontroller to test sensors	November 15, 2015
Finish writing Senior Design I paper	November 30, 2015
Proofread Senior Design I paper	December 8, 2015
Submit Senior Design I paper	December 10, 2015

In Senior Design II, the primary focus is the building and testing of the prototype. This builds upon all of the research and design that was performed in Senior Design I. By the conclusion of Senior Design II, the Head On prototype must be fully functional in order to complete the class.

Table 15: Senior Design II Milestones

Milestone	Deadline
Acquire parts for prototype	January 30, 2016
Obtain PCB for motorcycle and helmet system	January 30, 2016
Perform unit testing for each module	February 10, 2016
Develop prototype with all modules transmitting and receiving data	February 15, 2016
Test prototype for accuracy and determine changes that need to be made	February 17, 2016
Finalize design of hardware and GUI	February 20, 2016
Build and program final product	February 29, 2016
Troubleshoot problems	March 15, 2016
Test for accuracy and make necessary modifications	March 31, 2016
Finish final documentation	April 15, 2016
Demonstration	TBD
Ensure all requirements set in senior design are met	April 29, 2016

Overall, there are three main phases to this project: research, design, and testing. Each of these phases contributed to the overall completion of the project. Because the agile method is being used for this project, it is impossible to give an exact date for when each phase will end. Depending on the information gathered at each stage, the project may move on to the next stage or may return to the previous stage in order to make modifications.

In the first phase, which extended through the majority of Senior Design 1, a project was chosen and the goals, requirements, and specifications were determined. After this, the research into relevant technologies and possible modules to use with this system was determined. After much research, all the modules were chosen. However, along the way goals and features of the system were modified, added, and removed as a more realistic idea of what would be feasible was developed. Thanks to the fluidity associated with the agile method, these changes could be easily made without having to restart the project from scratch.

At this point phase two, the design phase, began. Phase two started in Senior Design 1 and would extend into Senior Design 2. This phase mainly consists

designing and creating the hardware and software of the system. This included designing the PCB, creating schematics, designing the user interface, and beginning to program the microcontrollers. Because the design phases for the software and hardware components are occurring simultaneously, all of the programming was done on a development board; this alleviated the need for the two computer engineering students to have to wait until the prototype was built to start testing. Once all of the parts were acquired, the process of creating prototypes began. This process allowed the design to be actualized.

Once a prototype is created, the testing phase will ensue. This will occur only in Senior Design 2. During the testing phase, each component of the system will be tested for accuracy. A variety of tests will be run in multiple environments in order to ensure that the goals, requirements, goals, and specifications are met. This includes testing the components in a lab environment using the development board as well as testing the actual prototype while on the road. If it is determined that one of the requirements set for the project has not been met, the project will return to the design phase in order to make necessary modification. This includes both software and hardware modifications. In some cases, if it is determined that the component itself is the problem and not the way it is integrated into the design, the project may return to the research phase in order to resolve the problem. Once again, this fluid movement between phases is made possible by the implementation of the agile method. This process of testing and making modifications based on results will be repeated until all tests in phase three result in success.

11.2 Sponsors

At the start of Senior Design I, the group applied for funding from Boeing and Leidos. A funding proposal was created detailing the project description, estimated budget, and plan for moving forward. After reviewing the proposal that was submitted, Boeing/Leidos generously agreed to donate \$532.48 for this project.

11.3 Budget and Financing

Throughout the creation of this project a budget had to be maintained. This budget was calculated based off of estimated costs for parts, the funding received from sponsors, and the amount each group member was willing to contribute.

11.3.1 Estimated Budget

A critical part of the design process was determining a budget for the project. In order to determine the budget of the project, the parts that would have to be acquired for the prototype and final product had to be ascertained as well as what equipment and services would be needed to build them. In addition, an

estimate of the amount of funding that would be received also had to be taken into consideration since the remainder of the funding would have to be provided by the team members. Table 16 displays the estimated cost of parts that was determined at the start of Senior Design I.

Table 16: Budget

Part	Quantity	Unit Price	Total Price
Motorcycle for testing	1	Acquired	\$0.00
Motorcycle helmet	1	\$50.00	\$50.00
Printed circuit board	10	\$5.00	\$50.00
Microcontroller	2	\$10.00	\$20.00
GPS module	1	\$50.00	\$50.00
LCD display	1	\$15.00	\$15.00
Solar panel	8	\$15.00	\$120.00
Battery	1	\$40.00	\$40.00
Sensor	3	\$10.00	\$30.00
Wireless module	4	\$9.00	\$36.00
Power regulator	4	\$15.00	\$60.00
USB TTL board	1	\$6.00	\$6.00
Breadboard	1	\$3.00	\$3.00
Jumper cables	1	\$3.00	\$3.00
Development board	2	\$25.00	\$50.00
GPS module	1	\$50.00	\$50.00
Real time clock	1	\$2.00	\$2.00
Electronic compass	1	\$14.00	\$14.00
Energy harvesting system	1	\$8.00	\$8.00
Break away headers	1	\$3.00	\$3.00
Total:			\$610.00

In an effort to further analyze the budget, the pie chart below breaks down the estimated costs spent on each item as a percentage of the total. The majority of the spending for this project will be on power related components, specifically the solar panels and power regulator. Though solar panels are by no means the most expensive component of this project, several of them are needed for the prototype as well as for testing purposes. Similarly, an individual power regulator is not expensive; however, several are needed for the system. The majority of the modules fall in the midrange of spending. Though some of these, such as the GPS, are in fact the most expensive per unit, only one will be needed for the system. Most of the testing equipment used for the development of the software is on the low end of the spending spectrum. Several of these components are so inexpensive, only a couple of dollars, that their cost is almost negligible when considering the entire spending budget.

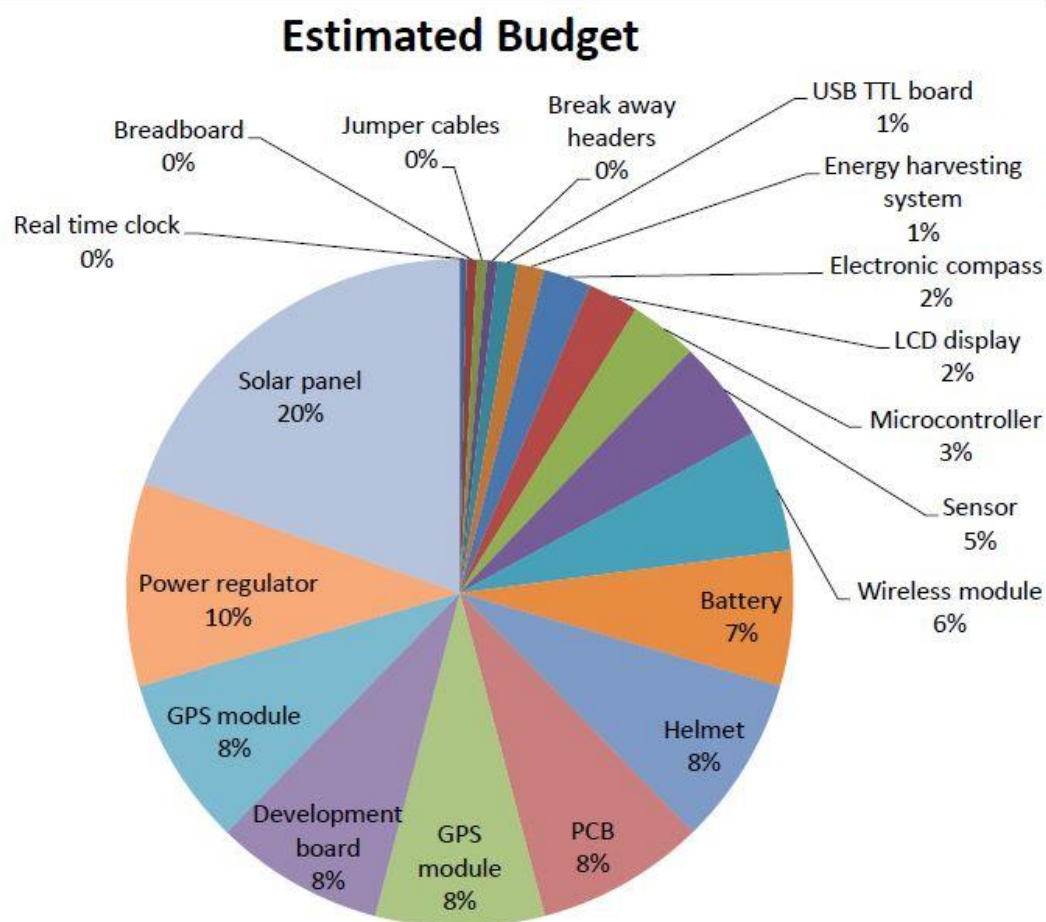


Figure 54: Budget Percentages

11.3.2 Financing

Once an estimated budget was determined, the group then began looking into possible sources of funding. A funding proposal was created outlining the project and how any funding received would be used. After submitting necessary

documentation, Boeing/Leidos agreed to sponsor this group by generously donating \$532.48. It was agreed by all member of the group that if this project exceeds this amount, then the difference will be split evenly between all four members. Fortunately, the cost of producing the prototype was lowered due to the resources available to UCF students. This included the use of tools in the Texas Instruments Innovation Lab as well as the Senior Design Lab. As a result, a larger portion of the funds could be dedicated to the purchasing of the components for the system. Furthermore, some of the group members already had equipment that was used for testing, such as development boards, breadboard, etc., as well as a motorcycle and motorcycle helmet. Finally, because similar products were available from different distributors, lower prices were able to be found.

11.3.3 Bill of Materials

The following table contains the complete list of parts purchased or already acquired that were used in the prototype and final product of Head On.

Table 17: Bill of Materials

Supplier	Part #	Nomenclature	Total
Mouser	A2235-H	GPS Modules SiRFStarIV GPS receiver SMT ROM mod	\$28.84
Mouser	LSM303DLHC	Accelerometers E-compass 3D accel & 3D magnetometer mod.	\$11.60
Mouser		Surface mount components, locking toggle switch, SMD Inductor 10uH, Battery Holder	\$89.13
Texas Instruments	TPS54292PWPR	Dual, Fully-Synchronous Buck Converter With Integrated MOSFET	\$31.50
Texas Instruments	BQ25570RR	Ultra Low Power Harvester Power Management IC with Boost Charger	\$27.00
Texas Instruments	TPS62737RGYR	Programmable Output Voltage Ultra-Low Power Buck Converter with 200 mA Output Current	\$10.00
Adafruit	1480	2.2" 18-bit color TFT LCD display with microSD card breakout	\$24.95
Adafruit	790	Ultimate GPS Module - 66 channel w/10 Hz updates	\$29.95

Adafruit	1120	Triple-axis Accelerometer+Magnetometer (Compass) Board	\$14.95
Adafruit	746	Ultimate GPS Breakout - 66 channel w/10 Hz updates	\$39.95
Adafruit	601	Adafruit AVR ATmegaXX8 Pinout Sticker - 10 pcs	\$2.95
Adafruit	1207	SMT Breakout PCB for SOIC-16 or TSSOP-16 - 3 Pack	\$3.95
Adafruit	1212	SMT Breakout PCB for SOIC-8, MSOP-8 or TSSOP-8 - 6 Pack	\$2.95
Adafruit	1480	2.2" 18-bit color TFT LCD display with microSD card breakout	\$24.95
Sparkfun		Polymer Lithium Ion Battery - 2000mAh, Break Away Headers	\$14.45
Maxim Integrated	DS3231MZ/V+	±5ppm, I2C Real-Time Clock	\$0.00
Amazon	HC-05	Sunkee 30ft Wireless Bluetooth RF Transceiver Module serial RS232 TTL HC-05 for arduino	\$25.53
Amazon	MB-102 830	Frentaly Point Prototype PCB Breadboard, DIP-20 SMT Adapter, DIP-14 SMT Adapter	\$22.06
Amazon	MB-1010	Ultrasonic Distance Sensor	\$119.80
Amazon	HC-SR04	5PCS Ultrasonic Module HC-SR04 Distance Sensor for Arduino UNO MEGA R3 Mega2560	\$8.59
Amazon	Atmega328P-PU	3-pack NEW Atmega328p-pu Chip w/ Arduino UNO Bootloader	\$13.49
Amazon		50 Value Resistor & 32 Value Capacitor Assortment Kit & Assorted Clear LED Light Emitting Diodes 5 Colors Pack of 300	\$26.98

Amazon		Hilitchi 515 Pcs 40 Pin 2.54mm Pitch Single Row Dupont Connector Kit	\$19.99
Amazon		Mounting Accessories & Battery Tender Ring Terminal Harness with Black Fused 2-Pin Quick Disconnect Plug	\$25.29
PentaLogix		QuickTurn Prototype PCB	\$237.60
OSH Park		Helmet Module 3 boards & Bike Module 3 boards at \$33.45 per batch of three	\$61.25
		Shipping & Expedited Services	\$358.25
		Total	\$1,275.95
		Funding	\$532.48
		Budget	\$592.00

Figure 55 below shows the final percentage breakdown of the budget as contributed to by each part. Contrary to what was initially predicted the biggest contributor to the budget was the overall cost of shipping and expedited services.

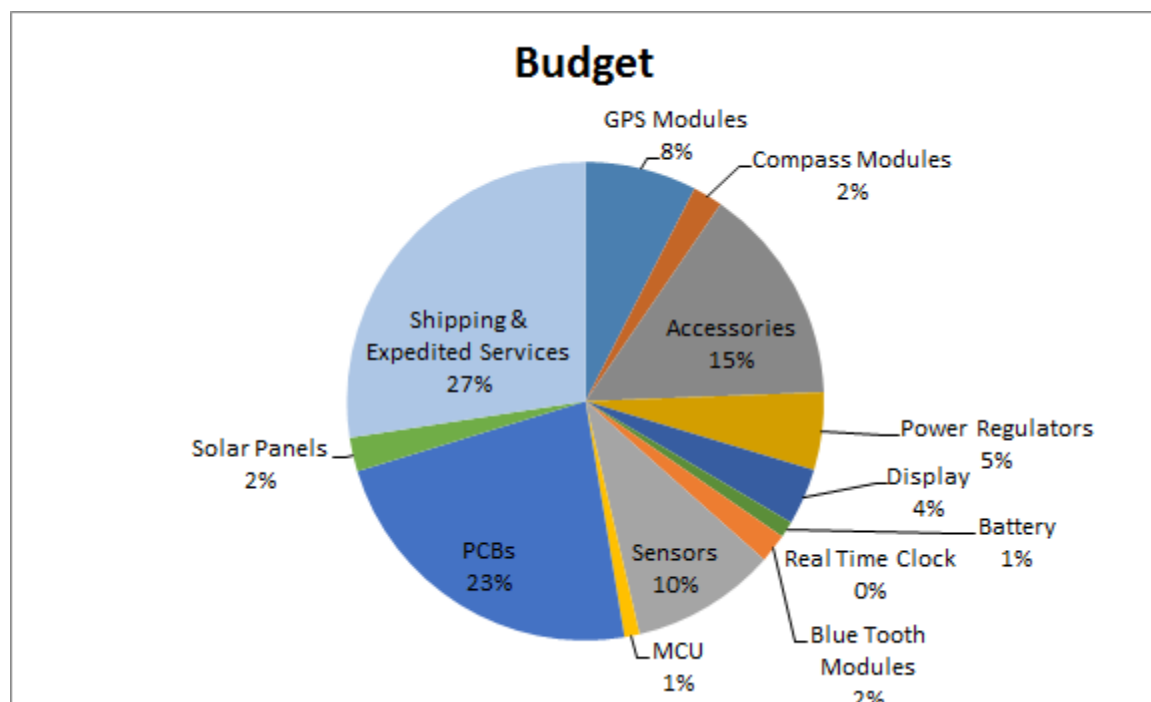


Figure 55: Final Budget Percentages

11.3.4 Financing Issues

Originally, this group planned on entering the TI Innovation Challenge North America Design Contest. Groups who entered this contest received a \$100 coupon to use on Texas Instruments products for their project. In order to be eligible for this contest, the group must use at least two TI analog integrated circuits and a TI processor in the project. However, after analyzing a variety of modules from other vendors, it was determined that the other products would be more suitable for this project. Unfortunately, this choice resulted in the loss of this possible source of funding.

11.4 Team Organization

The Head On project team consists of two electrical engineering and two computer engineering seniors at the University of Central Florida. Because this project consists of both a hardware and software component, the work was divided among the two subgroups accordingly. The two computer engineering students were tasked with all software aspects of the project. During the research phase of the project, the computer engineering students focused on finding sensors, microcontrollers, and screens since they would be the ones that would program them. Once the modules were chosen, these two students then began programming the microcontrollers in the helmet and motorcycle modules, as well as the user interface of the display. On the other hand, during the research phase, the two electrical engineers were responsible for all aspects related to power. This included but was not limited to, the solar power cells, the battery, and power regulators. Once the research phase was complete, these two students then focused on designing and creating the printed circuit boards for the helmet and software modules as well as determining how to best utilize and distribute adequate power to all components.

During the research phase of this project, weekly meetings were held in order to compare findings. The success of the project relied heavily on the communication between group members since the modules being chosen by each group must work together. Appropriate changes to the modules chosen were made when necessary. During these team meetings, each group member also discussed his or her progress, as well as what aspects of the project still needed to be completed. This allowed the group to gain a realistic idea of how much work remained. At the conclusion of each meeting, a goal was set for what each member should complete before the next meeting. In addition to these full group meetings, smaller meetings were also held in the computer and electrical subgroups. Each subgroup would meet to discuss their components of the project. Similarly, work would be divided within the subgroup members.

12.0 Conclusion

In conclusion, when approaching this project a great deal of planning and research had to take place. Goals, requirements and specifications had to be determined. Next research was performed on what modules to incorporate into the system. Once the final choices of modules were determined, the process of designing the hardware and software components began. PCB diagrams, flowcharts, UML diagrams, and schematics were created. During this process, many features were edited and others were removed completely. Once these diagrams and schematics were created, the prototype was built and tested. The design of the Head On system was then modified as necessary based off of the test results.

The goal of this project was to incorporate some of the technologies available for automobiles into an easy to use system which a motorcycle rider can use while on the go. The team was successful in this regard. The first and arguably the most important feature to be incorporated into the system is the hazard detection. Proximity sensing of vehicles and other hazards in the motorcycle's blind spots is accurately displayed on the screen using indicators. Additionally, in order to further enhance the rider's experience, the cardinal direction, time and, speed are also accurately displayed.

Head On does have possible features that could be added to it in the future in order to improve the user's experience even further. One feature includes a forward facing sensor. However, in order for this to be done, a sensor would have to be found that can detect objects much farther than the sensors used for the left, right, and rear. Two possible solutions to extend the detection range are RADAR and LIDAR systems which have ranges have ranges from 50 ft to over 300 ft. The rider will must have adequate time to react to the detection of the object. Improving the efficiency of the software would not sufficiently increase the amount of time the user has to react, so it is the sensor that must provide this needed time.

Another additional feature that could be added to the system is an indication of how close the hazards are to the rider using a colored indicator system. The color of the corresponding indicator on the screen could change color depending on the proximity of the object. For example, an orange indicator could indicate that the object is 15 feet away, while a red indicator could indicate that the object is 5 feet away. Ideally, this indicator could also take into account the rider's speed. For example, at higher speeds an object may be considered more highly hazardous at a further distance.

Furthermore, in the future this project could be improved by allowing more customization from the user. This could include allowing the user to choose a color scheme for the user interface or change the layout of the display by adding or removing features. Additionally, the indicators themselves could be changed. For example, the user could choose to display the time in the 24-hour format or

the speed in kilometers per hour. However, in order to implement this, the user would have to have some sort of way to interact with the system such as buttons or touch screen capabilities.

Finally, one of the concepts that was originally considered but later removed in the design process was the emergency notification system. Similar systems have been integrated in cars and in some of the helmet systems discussed in the beginning of this report. While the main focus of this system is to help the rider stay safe, this added feature would be incredibly beneficial to the user if he or she should get into an accident.

Overall, it is the goal of the Head On system to assist the user in becoming a safer driver through the use of hazard detection and dashboard integration with the display. Because of time constraints of this project, many features had to be removed from the system. However, these features could be added to the system in the future in order to further improve Head On.

13.0 Appendices

13.1 Appendix A: Permissions to Use



Cristhian Marin

4:38 PM

PERMISSION TO USE

To: pr@microchip.com

I am a computer engineering student at the University of Central Florida. I am requesting permission to use an image of the RN42 Bluetooth module from the product brochure in my senior design paper as a reference to available wireless communication hardware available for use in our helmet design.

Thank you for your time.

Cristhian Marin

University of Central Florida '16

Computer Engineering

cristhian@knights.ucf.edu | [321.750.6069](tel:321.750.6069)



Michael MARKOWITZ

12/7/2015 4:46 PM

RE: Permission to use

To: Cristhian Marin

Permission granted, Christian.

I hope you chose to use this MCU!



Michael Markowitz | Tel: [+1 781 591 0354](tel:+17815910354)

Corporate External Communications | Director Technical Media Relations

STMicroelectronics

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From: Cristhian Marin [mailto:cristhian@knights.ucf.edu]

Sent: Monday, December 07, 2015 4:19 PM

To: Michael MARKOWITZ

Subject: Permission to use

Dear Mr. Markowitz,


I am a computer engineering student at the University of Central Florida. I am requesting permission to use the pinout diagram for the STM32F405VG in my senior design paper in reference to the available choices for microcontrollers to implement in my team's helmet design.

Thank you for your time.

Cristhian Marin

University of Central Florida '16

Computer Engineering

 Chugh, Paramjyot
12/7/2015 4:59 PM

RE: PERMISSION TO USE IMAGE

To: Cristhian Marin

Christhian,

Thanks for checking with us on the use of Atmel materials. Kind of usage that you have described below would be considered fair use, so you are authorized to use this material provided you provide acknowledgment in your material about the source of these images.

Regards,
Paramjyot
[\(408\) 487-2706](tel:4084872706)

From: Cristhian Marin [<mailto:cristhian@knights.ucf.edu>]

Sent: Monday, December 07, 2015 12:46 PM


To: DL-Atmel-US-PR

Subject: PERMISSION TO USE IMAGE

I am a computer engineering student at the University of Central Florida. I am requesting permission to use the images for the ATmega 328 and ATmega 1280 pinout diagrams in my senior design paper in reference to choices for microcontrollers available to implement in our helmet design.

Thank you for your time.

Cristhian Marin
University of Central Florida '16
Computer Engineering
cristhian@knights.ucf.edu

 Stephanie Newsted
5:25 PM

RE: LSR Marketing Department
To: Cristhian Marin

Hi Cristian,

Yes, you may go ahead and use our SaBLE-x image. Please let me know if you need anything additional.

Best,
STEPHANIE NEWSTED | MKTG + COMM ASSOCIATE
P: [262.228.6906](tel:262.228.6906) | snewsted@lsr.com

From: Cristhian Marin [mailto:cristhian@knights.ucf.edu]
Sent: Monday, December 7, 2015 4:19 PM
To: Stephanie Newsted
Subject: Re: LSR Marketing Department

Hi Ms. Newsted,


We will be using the image solely in internal documentation; however, I would like to note the paper will be made available in PDF format for our peers and future students to view.

Regards,
Cristhian Marin

On Dec 7, 2015 5:12 PM, Stephanie Newsted <snewsted@lsr.com> wrote:
Hi Cristian,

Thank you for emailing us in regards to photo rights. Will you be posting this on a website at all or will this only be used in internal documentation?

STEPHANIE NEWSTED | MKTG + COMM ASSOCIATE

 Cristhian Marin
12:25 PM

PERMISSION TO USE IMAGE
To: support@innogear.net

I am computer engineering student attending the University of Central Florida. I am requesting permission to use the image of the HC-05 Bluetooth module as a reference in my senior design paper to discuss on available wireless communication devices .

Thank you for your time.

Cristhian Marin
University of Central Florida '16
Computer Engineering

SJ Steve Johnson <sdj@smf.org>
To: Amber Farrell; ↕

👍 ⚙️ Reply all | ▾
Tue 12/8/2015 11:34 AM

Inbox

Dear Amber,

You are welcome to use Figure 1, ISO Head form for you senior design project.

Sincerely,

Stephen Johnson
Administrative Director
Laboratory Manager



Snell Memorial Foundation, Inc.
3628 Madison Ave., Suite 11
North Highlands, CA 95660
916-331-5073 tel. 916-331-0359 fax
888-SNELL99 toll free
sdj@smf.org
smf.org

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AF Amber Farrell
To: info@smf.org; ↕

👍 ⚙️ Reply all | ▾
Mon 12/7/2015 6:26 PM

From: Amber Farrell

Sent: Mon 12/7/2015 6:26 PM

To: info@smf.org;

Permission

I am a computer engineering student and I am currently working on my senior design project at the University of Central Florida. I am requesting permission to include Figure 1, found in the link below, as part of our research paper.

<http://www.smf.org/standards/k98/k98std>

Thank you.

Amber Farrell
Computer Engineering
University of Central Florida
farrell.amber@knights.ucf.edu

Permission



Fri 11/6/2015 4:58 PM

From: Amber Farrell
 Sent: Fri 11/6/2015 4:58 PM
 To: info@iteadstudio.com;

Permission

Hello my name is Amber Farrell and I am working on my senior design project at the University of Central Florida. As part of our project I would like to include the sequence chart for the HC-SR04 ultrasonic ranging module found in the link below:

<http://www.electroschematics.com/wp-content/uploads/2013/07/HC-SR04-datasheet-version-2.pdf>

Thank you.

Amber Farrell
 Computer Engineering Student
 University of Central Florida
 farrell.amber@knights.ucf.edu

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Mon 12/7/2015 10:22 PM

Larry Herman

Permission to use images

To 'mpja@mpja.com'

To whom it may concern,

I am a student at the University of Central Florida's College of Engineering and Computer Science. I am writing on behalf of my senior design project team. We are required to produce a design document as part of our final design project. The document is for educational purposes only and we would like to include the following images from your *HC-SR04 User Guide* with your permission.

Section 3 - Product Views: Front and Back
Section 7 - Module Timing: HC-SR04 Ultrasonic Module

Please let us know if we can use some or all of this images. Thank you in advance for your support of our project.

Sincerely,
Larry Herman

From: [MPJA.com](mailto:mpja.com)
To: [Larry Herman](mailto:Larry.Herman)
Subject: RE: Permission to use images
Date: Thursday, January 14, 2016 2:40:23 PM

Yes, you may use our images.

Marlin L Jones VP



Mon 12/7/2015 10:45 PM

Larry Herman

Permission to use images

To 'info@maxbotix.com'

To whom it may concern,

I am a student at the University of Central Florida's College of Engineering and Computer Science. I am writing on behalf of my senior design project team. We are required to produce a design document as part of our final design project. The document is for educational purposes only and we would like to include the following images from your *LV-MaxSonar-EZ* datasheet with your permission.

Product Image
Timing Diagram
MB1000 Beam Pattern

Please let us know if we can use some or all of this images. Thank you in advance for your support of our project.

Sincerely,
Larry Herman

From: [Mark Bjornstad](#)
To: [Larry Heman](#)
Subject: Response To Your Email
Date: Thursday, January 14, 2016 4:13:28 PM

Hi Larry,

Thank you for your inquiry. You have permission to use our images for your educational project provided you adhere to naming, capitalization and punctuation conventions.

Have a great day!

--

Best regards,

Mark Bjornstad
Sales
MaxBotix Inc.
Phone: (218) 454-0766
Direct (218) 454-7327
Fax: (218) 454-0768

Email: mibjornstad@maxbotix.com

Web: www.maxbotix.com

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Technical support and sales are subject to the terms and conditions listed on our website at http://maxbotix.com/documents/MaxBotix_Inc_Terms_and_Conditions_.pdf



Mon 12/7/2015 11:10 PM

Larry Herman

Permission to use images

To 'gsisco@linear.com'

To whom it may concern,

I am a student at the University of Central Florida's College of Engineering and Computer Science. I am writing on behalf of my senior design project team. We are required to produce a design document as part of our final design project. The document is for educational purposes only and we would like to include the following images from your *LT3652* datasheet with your permission.

Typical Application - 2A Solar Pane With 7.2V LiFePO₄ Battery and 17V Peak Power Tracking
Pin Configuration – DD Package

Please let us know if we can use some or all of this images. Thank you in advance for your support of our project.

Sincerely,
Larry Herman

From: [Greg Sisco](#)
To: [Larry Herman](#)
Subject: Re: Permission to use images
Date: Tuesday, December 8, 2015 5:37:04 AM

Hello Larry,

Permission granted to use all images.

Greg Sisco
Field Sales Engineer
Linear Technology Corporation
Office: (407) 688-7616
Cell: (407) 620-9624
Fax: (407) 393-5541

email: gsisco@linear.com

web page: www.linear.com

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Mon 12/7/2015 11:27 PM

Larry Herman

Permission to use image

To 'Ferda.Millan@maximintegrated.com'

Dear Ferda Millan,

I am a student at the University of Central Florida's College of Engineering and Computer Science. I am writing on behalf of my senior design project team. We are required to produce a design document as part of our final design project. The document is for educational purposes only and we would like to include the Block Diagram image from your *DS3231* datasheet with your permission.

Please let us know if we may use this image. Thank you in advance for your support of our project.

Sincerely,
Larry Herman

From: [Ferda Millan](#)
To: [Larry Herman](#)
Cc: [Edward Lee](#)
Subject: RE: Permission to use image
Date: Thursday, January 14, 2016 3:22:59 PM
Attachments: [Maxim Herman License Letter.docx.pdf](#)

Hi Larry,

Appreciate your interest in Maxim Integrated, and thanks for your patience with this request.

Attached please find a signed license letter which grants you permission to use the block diagram (it is the diagram labeled DS3231 in the datasheet, per your request).

Please read the letter (which includes an image of the block diagram) and let us know if you have any questions.

Regards,
Ferda

Ferda Millan
Sr. PR Manager, Corporate Communications
160 Rio Robles | San Jose, CA 95134 | USA
Office: +1 (408) 601-5429 | Mobile: +1 (408) 373-1854
[Maxim Integrated](#) | www.maximintegrated.com



Maxim Integrated Products, Inc.
160 Rio Robles, MS A1-2
San Jose, CA 95134
USA
+1 408 601 1000

www.maximintegrated.com

Via email lherman@knights.ucf.edu

Date: December 14, 2015

Larry Herman
Electrical Engineering Student
University of Central Florida
P.O. Box 160000
Orlando, FL 32816

Re: Permission to use Materials of Maxim Integrated Products, Inc.

Dear Mr. Herman,

I write in regards to your request to use certain materials owned by Maxim Integrated Products, Inc. ("Maxim Integrated") in your senior design project report (the "Publication").

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Sincerely,

DocuSigned by:
Ed Medlin
5764B08A13FB4AC...

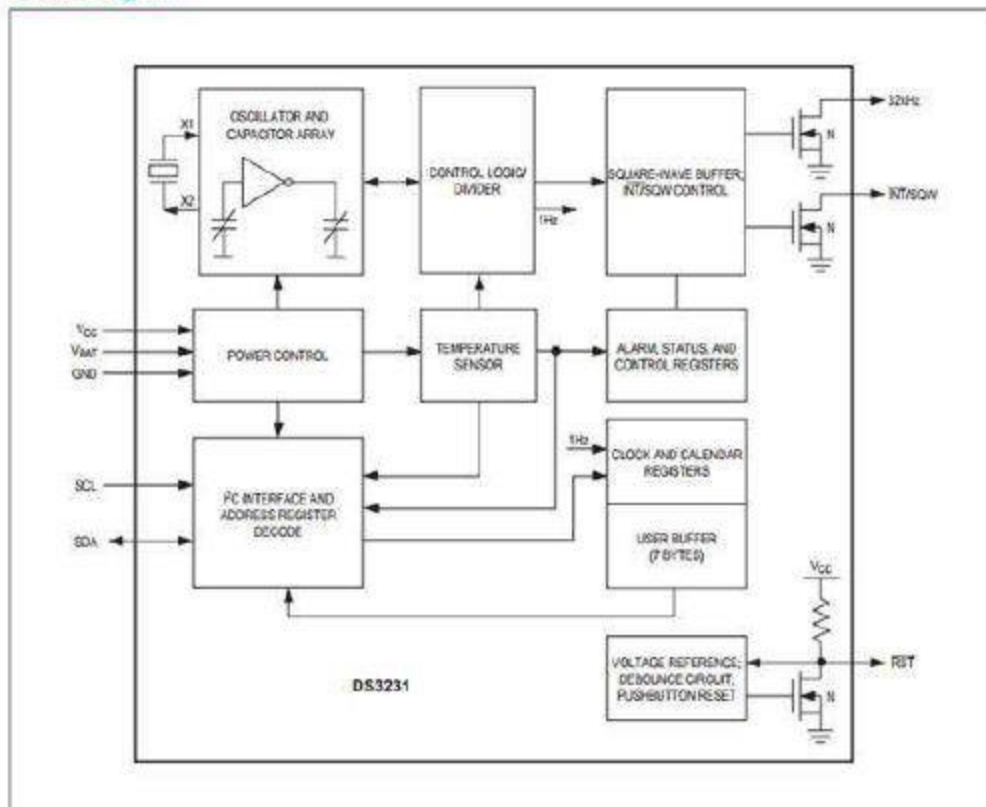
Ed Medlin
Senior Vice President, General Counsel
Maxim Integrated Products, Inc.

EXHIBIT A
MATERIALS

DS3231

Extremely Accurate I²C-Integrated
RTC/TCXO/Crystal

Block Diagram





Mon 12/7/2015 11:36 PM

Larry Herman

Permission to use image

To 'AME_BO_West_Inquiries@list.st.com'

To whom it may concern,

I am a student at the University of Central Florida's College of Engineering and Computer Science. I am writing on behalf of my senior design project team. We are required to produce a design document as part of our final design project. The document is for educational purposes only and we would like to include Figure 2. Pin connections from your *LSM303D* datasheet with your permission.

Please let us know if we may use this image. Thank you in advance for your support of our project.

Sincerely,
Larry Herman

The following was submitted on December 8, 2015 at 8:48 am US Central.

area of interest: Custom/OEM
title: Requesting Permission To Use Images for Student Project
first name: Aurora
last name: Reinefeld
company: (none)
email: aureinefeld@knights.ucf.edu
phone: 305-323-6025
city: Orlando
state: Florida
country: United States
zip: 32826

questionscomments: To who it may concern, I am student at the University of Central Florida's College of Engineering and Computer Science. I am writing on behalf of my senior design project team. We are required to produce a design document as part of our final design project. The document is for educational purposes only and we would like to include the following images from your website with your permission. Image of the MPT6-75 from the OEM series. Image of the MPT4.8-150 from the OEM series. Image of the MPT4.8-75 from the OEM series. Please let us know if we can use some or all of these images. Thank you in advance for your support of our project. Sincerely, Aurora Reinefeld

powerfilm should respond using: Email
email communication: (none)




Julia Stone <jstone@powerfilmsolar.com>

12/9/2015

aureinefeld@powerfilmsolar.com 



Reply all | 

Inbox

Aurora

Thank you for contacting PowerFilm. Yes, you are able to use images, thank you for asking. I have included Ben Ellefson from marketing in this email if you need additional ones he may have something. Just let him know.

Thanks
Julia

13.2 Appendix B: Bibliography

Shneiderman, B. & Plaisant, C. (2010). *Designing the User Interface*. Fifth edition. Boston, MA: Pearson Higher Education.

Snell Memorial Foundation. "Snell Foundation - M2015 Helmet Standard." *M2015 Helmet Standard*. Snell Memorial Foundation, 2015. Web. 07 Dec. 2015.

United States. U.S. Department of Transportation. Federal Highway Administration. *Mitigation Strategies For Design Exceptions*. By Federal Highway Administration. Federal Highway Administration, 15 Oct. 2014. Web. 7 Dec. 2015.

United States. National Highway Traffic Safety Administration. Department of Transportation. *49 CFR 571.218 - Standard No. 218; Motorcycle Helmets*. By Department of Transportation. Department of Transportation, 1 Oct. 2011. Web. 7 Dec. 2015.

13.3 Appendix C: Figure References

- [1] http://www.mpja.com/download/hc-sr04_ultrasonic_module_user_guidejohn.pdf
- [2] http://www.mpja.com/download/hc-sr04_ultrasonic_module_user_guidejohn.pdf
- [3] http://www.maxbotix.com/documents/LV-MaxSonar-EZ_Datasheet.pdf
- [4] http://www.maxbotix.com/documents/LV-MaxSonar-EZ_Datasheet.pdf
- [5] http://www.maxbotix.com/documents/LV-MaxSonar-EZ_Datasheet.pdf
- [6] Original work
- [7] Original work
- [8] Original work
- [9] Original work
- [10] <http://www.ti.com.cn/cn/lit/ug/slau318g/slau318g.pdf>
- [11] http://www.atmel.com/images/Atmel-8271-8-bit-AVR-Microcontroller-ATmega48A-48PA-88A-88PA-168A-168PA-328-328P_datasheet_Complete.pdf
- [12] http://www.atmel.com/images/atmel-2549-8-bit-avr-microcontroller-atmega640-1280-1281-2560-2561_datasheet.pdf
- [13] <http://www.st.com/st-web-ui/static/active/en/resource/technical/document/datasheet/DM00037051.pdf>
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- [15] <https://www.lsr.com/embedded-wireless-modules/bluetooth-module/sable-x-ble-module>
- [16] <http://www.ti.com/lstds/ti/power-management/energy-harvesting-and-solar-charging-overview.page>
- [17] <http://cds.linear.com/docs/en/datasheet/3652fd.pdf>
- [18] <http://cds.linear.com/docs/en/datasheet/3652fd.pdf>
- [19] <http://www.ti.com/lit/ds/symlink/bq25570.pdf>
- [20] <http://www.ti.com/lit/ds/symlink/bq25570.pdf>
- [21]
- [22]
- [23] <http://www.powerfilmsolar.com/products/?mpt675&show=product&productID=271541>
- [24] <http://www.powerfilmsolar.com/products/?mpt48150&show=product&productID=271540>
- [25] <http://www.powerfilmsolar.com/products/?mpt4875&show=product&productID=271539>
- [26] <https://www.maximintegrated.com/en/products/digital/real-time-clocks/DS3231.html#popuppdf>
- [27] Original Work

- [28] Original Work
- [29] Original Work
- [30] Original Work
- [31] <http://www.smf.org/standards/k98/k98std>
- [32] Original Work
- [33] Original Work
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